

Automation PC 910

User's Manual

Version: **1.00 (November 2012)**
Model no.: **MAAPC900-ENG**

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Chapter 1 • General information

1 Manual history

Version	Date	Change
0.10 Preliminary	12-Jun-12	<ul style="list-style-type: none"> • First version
1.00	26-Nov-12	<ul style="list-style-type: none"> • Chapter "Software" on page 93 added. • Chapter "Maintenance / Service" on page 138 added. • "Appendix A" on page 154 was added. • Section "Organization of safety notices" on page 11 revised - description text for "Caution" and "Warning" rewritten. • Terminology changes in German edition. • The following sections were added to the chapter "Technical data": "Temperature specifications" on page 19, "Block diagram" on page 27, "Humidity specifications" on page 23. • The following sections were added to the chapter "Commissioning": "Mounting orientation" on page 89, "Spacing for air circulation" on page 90, "Grounding concept" on page 92. • The CPU boards 5PC900.TS77-00, 5PC900.TS77-01, 5PC900.TS77-05, 5PC900.TS77-06, 5PC900.TS77-07 and 5PC900.TS77-08 were added to the chapter "QM77 CPU boards" on page 56 and "HM76 CPU boards" on page 58. • The following drives were added: "5AC901.CSSD-00" on page 67, "5AC901.CSSD-01" on page 69, "5AC901.CSSD-02" on page 71, "5AC901.CCFA-00" on page 73. • The following interface options were added: "5AC901.ICAN-00" on page 78, "5AC901.IHDA-00" on page 80, "5AC901.ISRM-00" on page 82. • Section "Monitor / panel options" on page 83 added. • The heat sink 5AC901.HS01-00 was added, "5AC901.HS0x-00" on page 62. • The section "System components / configuration" on page 16 was changed. • The bus units 5AC901.BX01-01 and 5AC901.BX02-01 were updated, see "Bus units" on page 61. • "CFast cards" on page 108 added. • USB Media Drive "5MD900.USB2-02" on page 113 added.

2 Safety guidelines

2.1 Intended use

Programmable logic controllers (PLCs), operating/monitoring devices (industrial PCs, Power Panels, Mobile Panels, etc.), and B&R uninterruptible power supplies have been designed, developed, and manufactured for conventional use in industrial environments. They were not designed, developed and manufactured for any use involving serious risks or hazards that could lead to death, injury, serious physical damage or loss of any kind without the implementation of exceptionally stringent safety precautions. In particular, such risks and hazards include the use of these devices to monitor nuclear reactions in nuclear power plants, their use in flight control or flight safety systems as well as in the control of mass transportation systems, medical life support systems or weapons systems.

2.2 Protection against electrostatic discharge

Electrical components that can be damaged by electrostatic discharge (ESD) must be handled accordingly.

2.2.1 Packaging

- **Electrical components with a housing**
... do not require special ESD packaging but must be handled properly (see Section "Electrical components with housing").
- **Electrical components without a housing**
... must be protected by ESD-suitable packaging.

2.2.2 Guidelines for proper ESD handling

Electrical components with a housing

- Do not touch the connector contacts on connected cables.
- Do not touch the contact tips on circuit boards.

Electrical components without a housing

The following apply in addition to "Electrical components with housing":

- Any persons handling electrical components or devices with electrical components installed in them must be grounded.
- Components may only be touched on their narrow sides or front plate.
- Components should always be stored in a suitable medium (ESD packaging, conductive foam, etc.). Metallic surfaces are not suitable storage surfaces!
- Components should not be subjected to electrostatic discharge (e.g. through the use of charged plastics).
- Ensure a minimum distance of 10 cm from monitors and TV sets.
- Measurement devices and equipment must be grounded.
- Measurement probes on potential-free measurement devices must be discharged on sufficiently grounded surfaces before taking measurements.

Individual components

- ESD protective measures for individual components are thoroughly integrated at B&R (conductive floors, footwear, arm bands, etc.).
- These increased ESD protective measures for individual components are not necessary for customers handling B&R products.

2.3 Policies and procedures

Electronic devices are never completely failsafe. In the event of a failure on the programmable control system, operating/monitoring device or uninterruptible power supply, the user is responsible for ensuring that other devices that may be connected, e.g. motors, are brought to a safe state.

When using programmable logic controllers or operating/monitoring devices as control systems in conjunction with a Soft PLC (e.g. B&R Automation Runtime or comparable product) or slot PLC (e.g. B&R LS251 or comparable product), the safety precautions applying to industrial control systems (e.g. the provision of safety devices such as emergency stop circuits, etc.) must be observed in accordance with applicable national and international regulations. The same applies for all other devices connected to the system, such as drives.

All tasks such as installation, commissioning and maintenance are only permitted to be carried out by qualified personnel. Qualified personnel are those familiar with the transport, mounting, installation, commissioning and operation of the device who also have the appropriate qualifications (e.g. IEC 60364). National accident prevention regulations must be observed.

The safety notices, connection descriptions (type plate and documentation) and limit values listed in the technical data are to be read carefully before installation and commissioning and must be observed.

2.4 Transport and storage

During transport and storage, devices must be protected against undue stress (mechanical loads, temperature, humidity, aggressive atmospheres, etc.).

2.5 Mounting

- Installation must be performed according to this documentation using suitable equipment and tools.
- Devices may only be installed by qualified personnel without voltage applied. Before installation, voltage to the control cabinet must be switched off and prevented from being switched on again.
- General safety guidelines and national accident prevention regulations must be observed.
- Electrical installation must be carried out according to applicable guidelines (e.g. line cross-section, fuses, protective ground connections).

2.6 Operation

2.6.1 Protection against touching electrical parts

To operate programmable logic controllers, operating/monitoring devices or uninterruptible power supplies, certain components must carry dangerous voltage levels of over 42 VDC. Touching one of these parts can result in a life-threatening electric shock. This could lead to death, severe injury or damage to equipment.

Before turning on the programmable logic controller, operating/monitoring devices and the uninterruptible power supply, the housing must be properly grounded (PE rail). Ground connections must be established when testing operating/monitoring devices or the uninterruptible power supply even when operating them for only a short time!

Before turning the device on, all parts that carry voltage must be securely covered. During operation, all covers must remain closed.

2.6.2 Environmental conditions - Dust, humidity, aggressive gases

The use of operating/monitoring devices (e.g. industrial PCs, Power Panels, Mobile Panels, etc.) and uninterruptible power supplies in very dusty environments should be avoided. Dust collection on the devices can affect functionality and may prevent sufficient cooling, especially in systems with active cooling systems (fans).

The presence of aggressive gases can also lead to malfunctions. When combined with high temperature and humidity, aggressive gases – e.g. with sulfur, nitrogen and chlorine components – can induce chemical reactions that can damage electronic components very quickly. Signs of the presence of aggressive gases are blackened copper surfaces and cable ends on existing equipment.

For operation in dusty or humid conditions, correctly installed (cutout installation) operating/monitoring devices like the Automation Panel or Power Panel are protected on the front side. The rear side of all devices must be protected from dust and humidity and cleaned at suitable intervals.

2.6.3 Programs, viruses and dangerous programs

This system is subject to potential risk each time data is exchanged or software is installed from a data medium (e.g. diskette, CD-ROM, USB flash drive, etc.), a network connection or the Internet. The user is responsible for assessing these dangers, implementing preventive measures such as virus protection programs, firewalls, etc. and making sure that software is only obtained from trusted sources.

2.7 Environmentally friendly

All B&R programmable controllers, operating/monitoring devices and uninterruptible power supplies are designed to inflict as little harm as possible on the environment.

2.7.1 Separation of materials

It is necessary to separate different materials so the device can undergo an environmentally friendly recycling process.

Component	Disposal
Programmable logic controllers Operating/monitoring devices Uninterruptible power supply Batteries & rechargeable batteries Cables	Electronics recycling
Cardboard box / paper packaging	Paper / cardboard recycling
Plastic packaging	Plastic recycling

Table 1: Environmentally friendly separation of materials

Disposal must comply with applicable legal regulations.

3 Organization of safety notices

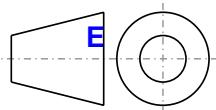
The safety notices in this manual are organized as follows:

Safety notice	Description
Danger!	Disregarding safety regulations and notices can be life-threatening.
Warning!	Disregarding safety regulations and notices can result in severe injury or substantial damage to equipment.
Caution!	Disregarding safety guidelines and notices can result in injury or damage to equipment.
Information:	Important information for preventing errors.

Table 2: Description of the safety notices used in this documentation

4 Guidelines

European dimension standards apply to all dimension diagrams in this document.



All dimensions are specified in mm.

Nominal measurement area	General tolerance according to DIN ISO 2768 medium
Up to 6 mm	± 0.1 mm
For 6 to 30 mm	± 0.2 mm
For 30 to 120 mm	± 0.3 mm
For 120 to 400 mm	± 0.5 mm
For 400 to 1000 mm	± 0.8 mm

Table 3: Nominal measurement areas

5 Overview

Product ID	Short description	on page
Batteries		
0AC201.91	Lithium batteries 4 pieces, 3 V / 950 mAh button cell Hereby we declare that the Lithium cells contained in this shipment qualify as „partly regulated“. Handle with care. If the package is damaged, inspect cells, repack intact cells and protect cells against short circuits. For emergency information, call RENATA SA at + 41 61 319 28 27	107
4A0006.00-000	Lithium battery, 3 V / 950 mAh, button cell	107
Bus units		
5AC901.BX01-00	APC910 bus, 1 PCI	61
5AC901.BX01-01	APC910 bus, 1 PCI Express (x4)	61
5AC901.BX02-00	APC910 bus, 2 PCI	61
5AC901.BX02-01	APC910 bus, 1 PCI, 1 PCI Express (x8)	61
CFast cards		
5CFAST.016G-00	CFast 16 GB	108
5CFAST.032G-00	CFast 32 GB	108
5CFAST.2048-00	CFast 2 GB	108
5CFAST.4096-00	CFast 4 GB	108
5CFAST.8192-00	CFast 8 GB	108
CPU boards		
5PC900.TS77-00	Intel Core i7 3615QE CPU board, 2.3 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	56
5PC900.TS77-01	Intel Core i7 3612QE CPU board, 2.1 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	56
5PC900.TS77-02	Intel Core i7 3555LE CPU board, 2.5 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	56
5PC900.TS77-03	Intel Core i7 3517UE CPU board, 1.7 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	56
5PC900.TS77-04	Intel Core i5 3610ME CPU board, 2.7 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	56
5PC900.TS77-05	Intel Core i3 3120ME CPU board, 2.4 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	56
5PC900.TS77-06	Intel Core i3 3217UE CPU board, 1.6 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	56
5PC900.TS77-07	Intel Celeron M 847E CPU board, 1.1 GHz, dual-core, 1 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	58
5PC900.TS77-08	Intel Celeron M 827E CPU board, 1.4 GHz, single-core, 1.5 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	58
DVI cable		
5CADVI.0018-00	DVI-D cable, 1.8 m.	119
5CADVI.0050-00	DVI-D cable, 5 m.	119
5CADVI.0100-00	DVI-D cable, 10 m.	119
Drives		
5AC901.CCFA-00	CFast adapter to operate a CFast card in a slide-in compact slot	73
5AC901.CHDD-00	250 GB SATA hard disk, Slide-in compact, 24/7 hard disk	65
5AC901.CSSD-00	32 GB SATA SSD (SLC), Slide-in compact	67
5AC901.CSSD-01	60 GB SATA SSD (MLC), Slide-in compact	69
5AC901.CSSD-02	180 GB SATA SSD (MLC), Slide-in compact	71
Fan kits		
5AC901.FA01-00	APC910 fan kit for system unit 5PC910.SX01-00	63
5AC901.FA02-00	APC910 fan kit for system unit 5PC910.SX02-00	64
Front cover		
5AC901.FF01-00	APC910 front cover, 1 slot, orange	87
5AC901.FF02-00	APC910 front cover 2 slot, orange	87
Heat sink		
5AC901.HS00-00	APC910 heat sink active	62
5AC901.HS01-00	APC910 heat sink passive	62
Interface options		
5AC901.I485-00	RS232/422/485 interface option; for APC910	74
5AC901.ICAN-00	CAN interface option; for APC910	78
5AC901.IHDA-00	Audio interface option, connection for 1x MIC, 1x Line IN, 1x Line OUT; for APC910	80
5AC901.ISRM-00	SRAM interface option, 2 MB; for APC910	82
Main memory		
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB	60
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB	60
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB	60
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB	60
Monitor / Panel options		
5AC901.LDPO-00	DisplayPort transmitter	83
5AC901.LSDL-00	Smart Display Link/DVI transmitter	85
RS232 cable		
9A0014.02	RS232 extension cable for remote operating of a display unit with touch screen, 1.8 m.	136
9A0014.05	RS232 extension cable for remote operating of a display unit with touch screen, 5 m.	136
9A0014.10	RS232 extension cable for remote operating of a display unit with touch screen, 10 m.	136
SDL cable - 45° connector		
5CASDL.0018-01	SDL cable; 45° connector, 1.8 m.	125

Product ID	Short description	on page
5CASDL.0050-01	SDL cable; 45° connector, 5 m.	125
5CASDL.0100-01	SDL cable; 45° connector, 10 m.	125
5CASDL.0150-01	SDL cable; 45° connector, 15 m.	125
SDL cables		
5CASDL.0018-00	SDL cable, 1.8 m.	122
5CASDL.0050-00	SDL cable, 5 m.	122
5CASDL.0100-00	SDL cable, 10 m.	122
5CASDL.0150-00	SDL cable, 15 m.	122
5CASDL.0200-00	SDL cable, 20 m.	122
5CASDL.0250-00	SDL cable, 25 m.	122
5CASDL.0300-00	SDL cable, 30 m.	122
SDL flex cable		
5CASDL.0018-03	SDL Cable flex, 1.8 m.	128
5CASDL.0050-03	SDL cable flex, 5 m.	128
5CASDL.0100-03	SDL cable flex, 10 m.	128
5CASDL.0150-03	SDL cable flex, 15 m.	128
5CASDL.0200-03	SDL cable flex, 20 m.	128
5CASDL.0250-03	SDL cable flex, 25 m.	128
5CASDL.0300-03	SDL cable flex, 30 m.	128
5CASDL.0300-13	SDL cable flex with extender, 30 m.	131
5CASDL.0400-13	SDL cable flex with extender, 40 m.	131
5CASDL.0430-13	SDL Cable flex with extender, 43 m.	131
System units		
5PC910.SX01-00	APC910 system unit, 1 slot (PCI Express / PCI, depending on bus), 1 slide-in compact slot; Smart Display Link/DVI/monitor, DisplayPort, 1x RS232, 5x USB, 2x ETH 10/100/1000, 1 CFast slot, 24 VDC	46
5PC910.SX02-00	APC910 system unit, 2 slots (PCI Express / PCI, depending on bus), 1 slot for monitor/panel option, 1 slide-in compact and 1 slide-in slot; Smart Display Link/DVI/Monitor, DisplayPort, 1x RS232, 5x USB, 2x ETH 10/100/1000, 1 CFast slot, 24 VDC	51
Terminal blocks		
0TB103.9	Connector, 24 VDC, 3-pin female, screw clamps 3.31 mm ² , protected against vibration by the screw flange	106
0TB103.91	Connector, 24 VDC, 3-pin female, cage clamps 3.31 mm ² , protected against vibration by the screw flange	106
USB accessories		
5A5003.03	Front cover, For Remote CD-ROM Drive 5A5003.02 and USB 2.0 drive combination 5MD900.USB2-00, 5MD900.USB2-01 and 5MD900.USB2-02.	117
5MD900.USB2-02	USB 2.0 Drives DVD-R/RW DVD+R/RW, CompactFlash slot (type II), USB connector (type A on front side, type B on back side); 24 VDC; (0TB103.9 screw clamp or 0TB103.91 cage clamp must be ordered separately).	113
5MMUSB.2048-01	USB 2.0 flash drive 2048 MB B&R	111
USB cable		
5CAUSB.0018-00	USB 2.0 connecting cable type A - type B, 1.8 m.	135
5CAUSB.0050-00	USB 2.0 connecting cable type A - type B, 5 m.	135
Windows 7		
5SWWI7.1100-ENG	Microsoft OEM Windows 7 Professional 32-bit, Service Pack 1, DVD, English. Only available with a new device.	93
5SWWI7.1100-GER	Microsoft OEM Windows 7 Professional 32-bit, Service Pack 1, DVD, German. Only available with a new device.	93
5SWWI7.1200-ENG	Microsoft OEM Windows 7 Professional 64-bit, Service Pack 1, DVD, English. Only available with a new device.	93
5SWWI7.1200-GER	Microsoft OEM Windows 7 Professional 64-bit, Service Pack 1, DVD, German. Only available with a new device.	93
5SWWI7.1300-MUL	Microsoft OEM Windows 7 Ultimate 32-bit, Service Pack 1, DVD, multilanguage. Only available with a new device.	93
5SWWI7.1400-MUL	Microsoft OEM Windows 7 Ultimate 64-bit, Service Pack 1, DVD, multilanguage. Only available with a new device.	93
Windows Embedded Standard 2009		
5SWWPXP.0740-ENG	Microsoft OEM Windows Embedded Standard 2009, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 2 GB).	98
Windows Embedded Standard 7		
5SWWI7.1540-ENG	Microsoft OEM Windows Embedded Standard 7 32-bit, Service Pack 1, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	95
5SWWI7.1640-ENG	Microsoft OEM Windows Embedded Standard 7 64-bit, Service Pack 1, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	95
5SWWI7.1740-MUL	Microsoft OEM Windows Embedded Standard 7 Premium 32-bit, Service Pack 1, multilanguage; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB without language packages).	95
5SWWI7.1840-MUL	Microsoft OEM Windows Embedded Standard 7 Premium 64-bit, Service Pack 1, multilanguage; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	95
Windows XP Professional		
5SWWPXP.0600-ENG	Microsoft OEM Windows XP Professional Service Pack 3, CD, English. Only available with a B&R device.	97
5SWWPXP.0600-GER	Microsoft OEM Windows XP Professional Service Pack 3, CD, German. Only available with a device.	97
5SWWPXP.0600-MUL	Microsoft OEM Windows XP Professional Service Pack 3, CD, multilanguage. Only available with a B&R device.	97

Chapter 2 • Technical data

1 Introduction

1.1 Intel® Core™ i-series processors for the most demanding tasks

The APC910 is based on the latest Intel® Core™ i-series technology and offers maximum performance for demanding tasks such as those that involve vision systems. The proven standard design of the Automation PCs has been retained while adding many new details to keep up with the advancements being made on the PC market. Robust design for use in industrial applications around the world and long-term series availability continue to define the Automation PC series, a trend now being continued by the APC910.



1.2 Maximum performance

The APC910 has the latest Intel® Core™ i-series technology at its heart. By further reducing the structural size of the chip and implementing a new microprocessor architecture that now integrates graphics directly into the CPU, Intel® has been able to improve performance by leaps and bounds over their first Core™ i-series generation and Core™2 Duo systems. The rest of the PC infrastructure has also been streamlined for maximum computing performance and optimal data throughput. The APC910 now has a serial ATA-based CFast card to replace the previously used CompactFlash. And just like the APC810, hard disks and solid state drives are connected to the PC system via the high-speed SATA interface. These devices are also well-equipped when it comes to interface options. Two gigabit Ethernet ports, USB ports and onboard as well as modular serial ports round off the extensive capabilities of the ACP910.

1.3 Availability and reliability for many productive years

Automation PCs are built for continuous operation over a period of many years. This starts with the robust welded housing that shields the electronics from the external environment, easily withstanding rough conditions. The industrial-grade paint can endure even the most aggressive environments so that even a well-seasoned Automation PC might be mistaken for new. Components have also been selected to provide many years of reliable service. These components have been designed specifically for use in industrial environments, can withstand high ambient temperatures and have guaranteed long-term availability. In addition, Automation PC generations are produced in excess of 10 years – quite the exception in the otherwise fast-paced PC sector and a significant advantage for the user. The third generation of Automation PCs, represented by the APC910, proves once again that innovation

and product continuity are not incompatible goals. From the ease of connecting cables to the ports on top of the device to the location of mounting holes, many details have stayed the same. For the many thousands of panels in the field – whether customized or in the standard design – there is always the proven SDL interface for easily connecting the PC to its display.

1.4 Features

- Latest processor technology - Intel® Core™ i-series (Generation 3 - Ivy Bridge)
- Up to 16 GB main memory (dual-channel memory support)
- 1 CFast slot¹⁾
- 1 or 2 card slots (for PCI / PCI Express (PCIe) cards)
- SATA drives (slide-in and slide-in compact slots)
- 4x USB 3.0, 1x USB 2.0
- 2x Ethernet 10/100/1000 Mbit interfaces
- 1x RS232 interface, modem compatible
- Connections for a wide range of display devices to the monitor/panel interface and display port
- 24 VDC supply voltage
- Fan-free operation²⁾
- BIOS (AMI)
- Real-time clock (RTC, battery-backed)
- Wide range of interface options
- Wide range of monitor/panel options

1) A CFast adapter allows multiple CFast cards to be used. This depends on the respective system unit.

2) Dependent on the device configuration and ambient temperature

1.5 System components / configuration

The APC910 system can be assembled to meet individual requirements and operating conditions. The following components are absolutely essential for operation:

- System unit
- Bus unit
- CPU board
- Heat sink
- Fan kit³⁾
- Main memory
- Drive (mass storage device such as CFast card or hard disk) for the operating system
- Software

1.5.1 Configuration - Base system

The system units can be operated with and without a fan kit. This depends on the various types of heat sink and main memory being used.

Using a fan kit allows for operation at higher ambient temperatures. More information can be found under "Maximum ambient temperature" on page 20.

Configuration with a fan kit

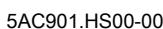
Configuration - Base system (with fan kit - active)		
System unit	Select one	
A system unit consists of a housing and main board.		
	5PC910.SX01-00	5PC910.SX02-00
Bus unit	Select one	
	5AC901.BX01-00 - 1 PCI 5AC901.BX01-01 - 1 PCIe	5AC901.BX02-00 - 2 PCI 5AC901.BX02-01 - 1 PCI, 1 PCIe
CPU board - Heat sink - Fan kit - Main memory		
CPU board	Select one	
	QM77 CPU boards 5PC900.TS77-00 5PC900.TS77-01 5PC900.TS77-02 5PC900.TS77-03	HM76 CPU boards 5PC900.TS77-04 5PC900.TS77-05 5PC900.TS77-06
Heat sink	Select one	
		
	5AC901.HS00-00	
Fan kit	Select one	
	5AC901.FA01-00	5AC901.FA02-00
Main memory	Select one or two	
	5MMDDR.1024-03 5MMDDR.2048-03	5MMDDR.4096-03 5MMDDR.8192-03

Figure 1: Configuration - Base system with fan kit

3) A fan kit is only mandatory when using the heat sink 5AC901.HS00-00.

Configuration without a fan kit

Configuration - Base system (without fan kit - passive)		
System unit	Select one	
A system unit consists of a housing and main board.		
	5PC910.SX01-00 5PC910.SX02-00	
Bus unit	Select one	
	5AC901.BX01-00 - 1 PCI 5AC901.BX01-01 - 1 PCIe	5AC901.BX02-00 - 2 PCI 5AC901.BX02-01 - 1 PCI, 1 PCIe
CPU board - Heat sink - Main memory		
CPU board	Select one	
	QM77 CPU boards 5PC900.TS77-01 5PC900.TS77-04 5PC900.TS77-02 5PC900.TS77-05 5PC900.TS77-03 5PC900.TS77-06	
Heat sink	Select one	
	5AC901.HS01-00	
Main memory	Select one or two	
	5MMDDR.1024-03 5MMDDR.4096-03 5MMDDR.2048-03 5MMDDR.8192-03	

Figure 2: Configuration - Base system without fan kit

1.5.2 Configuration - Accessories and software

Configuration - Accessories and software				
System unit	Select one			
A system unit consists of a housing and main board.		5PC910.SX01-00		5PC910.SX02-00
Front cover	Select one			
	5AC901.FF01-00	5AC901.FF02-00		
Compact slide-in drive	Select one			
	5AC901.CHDD-00 5AC901.CSSD-00 5AC901.CSSD-01	5AC901.CSSD-02 5AC901.CCFA-00		
IF options	Select max. 2 ¹⁾			
	5AC901.I485-00 5AC901.ICAN-00	5AC901.IHDA-00 5AC901.ISRM-00		
Monitor/Panel options		Select one		
		5AC901.LDPO-00 5AC901.LSDL-00		
CFast cards	Select one			
	5CFAST.2048-00 5CFAST.4096-00 5CFAST.8192-00	5CFAST.016G-00 5CFAST.032G-00		
USB accessories	Select one			
	5MMUSB.2048-01			
Terminal blocks	Select one			
	Power connectors 0TB103.9 0TB103.91			
Operating systems	Select one			
    	Windows 7 5SWWI7.1100-ENG 5SWWI7.1100-GER 5SWWI7.1300-MUL 5SWWI7.1200-ENG 5SWWI7.1200-GER 5SWWI7.1400-MUL Windows XP 5SWWXP.0600-ENG 5SWWXP.0600-GER 5SWWXP.0600-MUL	Windows Embedded Standard 7 5SWWI7.1540-ENG 5SWWI7.1640-ENG 5SWWI7.1740-MUL 5SWWI7.1840-MUL Windows Embedded Standard 2009 5SWWXP.0740-ENG	Automation Runtime 1A4600.10-5 1A4601.06-5	

1) Certain limitations must be taken into account when using IF options. For more information, please refer to "Chapter 2 Technical data", section "Device interfaces".

Figure 3: Configuration - Accessories and software

2 Complete device

2.1 Temperature specifications

CPU boards can be combined with various other components, such as drives, main memory, additional insert cards, etc. depending on the system unit and fan kit. The various configurations result in varying maximum possible ambient temperatures, which can be seen in the following tables.

Information:

The maximum specified ambient temperatures for operation with and without a fan kit were determined under worst-case conditions. Experience has shown that higher ambient temperatures can be reached under typical conditions, e.g. using Microsoft Windows. The testing and evaluation is to be done on-site by the user (temperatures can be read in BIOS or using the B&R Control Center).

Information regarding worst-case conditions

- Thermal Analysis Tool (TAT V4.3) from Intel for simulating a 100% processor load
- BurnInTest tool (BurnInTest V4.0 Pro from Passmark Software) for simulating a 100% load on the interface via loop back adapters (serial interfaces, slide-in drives, USB ports, audio outputs)
- Maximum system expansion and power consumption

2.1.1 Maximum ambient temperature

Operation with a fan kit

Information:

The heat sink 5AC901.HS00-00 must be used when operating the Automation PC 910 with a fan kit.

Operation with a fan kit										Temperature limits	Location of sensor(s)	
Maximum ambient temperature	55	55	55	55	55	55	55	55	55			
What can also be operated at the max. ambient temperature, or are there limits?												
System units	5PC900.SX01-00	✓	✓	✓	✓	✓	✓	✓	✓	-	Power supply	-
	5PC900.SX02-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
Main memory	5MMDDR.1024-03	✓	✓	✓	✓	✓	✓	✓	✓	-	Slide-in compact drive	-
	5MMDDR.2048-03	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5MMDDR.4096-03	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5MMDDR.8192-03	✓	✓	✓	✓	✓	✓	✓	✓	-		
Compact slide-in drive	5AC901.CHDD-00	✓	✓	✓	✓	✓	✓	✓	✓	-	Interface option	-
	5AC901.CSSD-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5AC901.CSSD-01	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5AC901.CSSD-02	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5AC901.CCFA-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
Interface options	5AC901.I485-00	✓	✓	✓	✓	✓	✓	✓	✓	-	Monitor/Panel option	-
	5AC901.ICAN-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5AC901.IHDA-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5AC901.ISRM-00	TBD	-									
Monitor/Panel options	5AC901.LDPO-00	TBD	-	CFast cards	-							
	5AC901.LSDL-00	TBD	-									
CFast cards	5CFAST.2048-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5CFAST.4096-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5CFAST.8192-00	✓	✓	✓	✓	✓	✓	✓	✓	-		
	5CFAST.016G-00	✓	✓	✓	✓	✓	✓	✓	✓	-	20	Automation PC 910 User's Manual V 1.00
	5CFAST.032G-00	✓	✓	✓	✓	✓	✓	✓	✓	-		

Table 4: Ambient temperature with a fan kit

Operation without a fan kit

Information:

The 5PC900.TS77-00 CPU board cannot be used when operating without a fan kit.

The heat sink 5AC901.HS01-00 must be used when operating the Automation PC 910 without a fan kit.

Operation without a fan kit										
		5PC900.TS77-00	5PC900.TS77-01	5PC900.TS77-02	5PC900.TS77-03	5PC900.TS77-04	5PC900.TS77-05	5PC900.TS77-06	5PC900.TS77-07	5PC900.TS77-08
Maximum ambient temperature		-	35	40	50	35	35	50	50	50
What can also be operated at the max. ambient temperature, or are there limits?										
System units	5PC910.SX01-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5PC910.SX02-00	-	✓	✓	✓	✓	✓	✓	✓	-
Main memory	5MMDDR.1024-03	-	✓	✓	✓	✓	✓	✓	✓	-
	5MMDDR.2048-03	-	✓	✓	✓	✓	✓	✓	✓	-
	5MMDDR.4096-03	-	✓	✓	✓	✓	✓	✓	✓	-
	5MMDDR.8192-03	-	✓	✓	✓	✓	✓	✓	✓	-
Compact slide-in drive	5AC901.CHDD-00	-	✓	✓	45	✓	✓	45	45	-
	5AC901.CSSD-00	-	✓	✓	45	✓	✓	45	45	-
	5AC901.CSSD-01	-	✓	✓	45	✓	✓	45	45	-
	5AC901.CSSD-02	-	✓	✓	45	✓	✓	45	45	-
	5AC901.CCFA-00	-	✓	✓	✓	✓	✓	✓	✓	-
Interface options	5AC901.I485-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5AC901.ICAN-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5AC901.IHDA-00	-	✓	✓	40	✓	✓	40	40	-
	5AC901.ISRM-00	-	TBD	-						
Monitor/Panel options	5AC901.LDPO-00	-	TBD	-						
	5AC901.LSDL-00	-	TBD	-						
CFast cards	5CFAST.2048-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5CFAST.4096-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5CFAST.8192-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5CFAST.016G-00	-	✓	✓	✓	✓	✓	✓	✓	-
	5CFAST.032G-00	-	✓	✓	✓	✓	✓	✓	✓	-

Table 5: Ambient temperature without a fan kit

How is the maximum ambient temperature determined?

- Selection of the CPU board (use with or without fan kit).
- The "Maximum ambient temperature" row shows the maximum ambient temperature for the system as a whole, including the respective CPU board.

Information:

Maximum temperature data is for operation at 500 meters. The maximum ambient temperature must typically be derated by 1°C per 1000 meters (starting at 500 meters above sea level).

- Incorporating additional drives, main memory, interface options, etc. can change the temperature limits of an APC910 system.

If there is a "✓" next to the component, it can be used at the maximum ambient temperature of the complete system without problems.

If there is a specific temperature, for example "45", next to the component, then the ambient temperature of the whole APC910 system cannot exceed this temperature.

2.1.2 Minimum ambient temperature

The minimum ambient temperature is 0°C.

2.1.3 Temperature monitoring

Sensors monitor temperature values in many different areas in the APC910. The locations of the temperature sensors can be seen in "Figure 4: Temperature sensor locations" on page 22. The values listed in "Table 6: Temperature sensor locations" on page 22 represent the defined maximum temperature⁴⁾ for the respective measurement point. An alarm is not triggered if this temperature is exceeded. These temperatures can be read in BIOS or in approved Microsoft Windows operating systems via the B&R Control Center.

Additionally, the hard disks for APC910 systems available from B&R are equipped with S.M.A.R.T., or Self Monitoring, Analysis, and Reporting Technology. This makes it possible to read various parameters, for example the temperature, using software (e.g. HDD thermometer - freeware) in approved Microsoft operating systems (except Windows CE).

2.1.4 Temperature sensor locations

Sensors indicate temperature values in many different areas in the APC910. The temperatures⁵⁾ can be read in BIOS (menu item Advanced - OEM Features - System Board Features / CPU Board Features - Temperature Values) or in Microsoft Windows operating systems via the B&R Control Center⁶⁾.

For applications that don't use Windows, the temperatures can be evaluated using the B&R implementation guide. In addition to the implementation guide, there are also MS-DOS sample programs available.

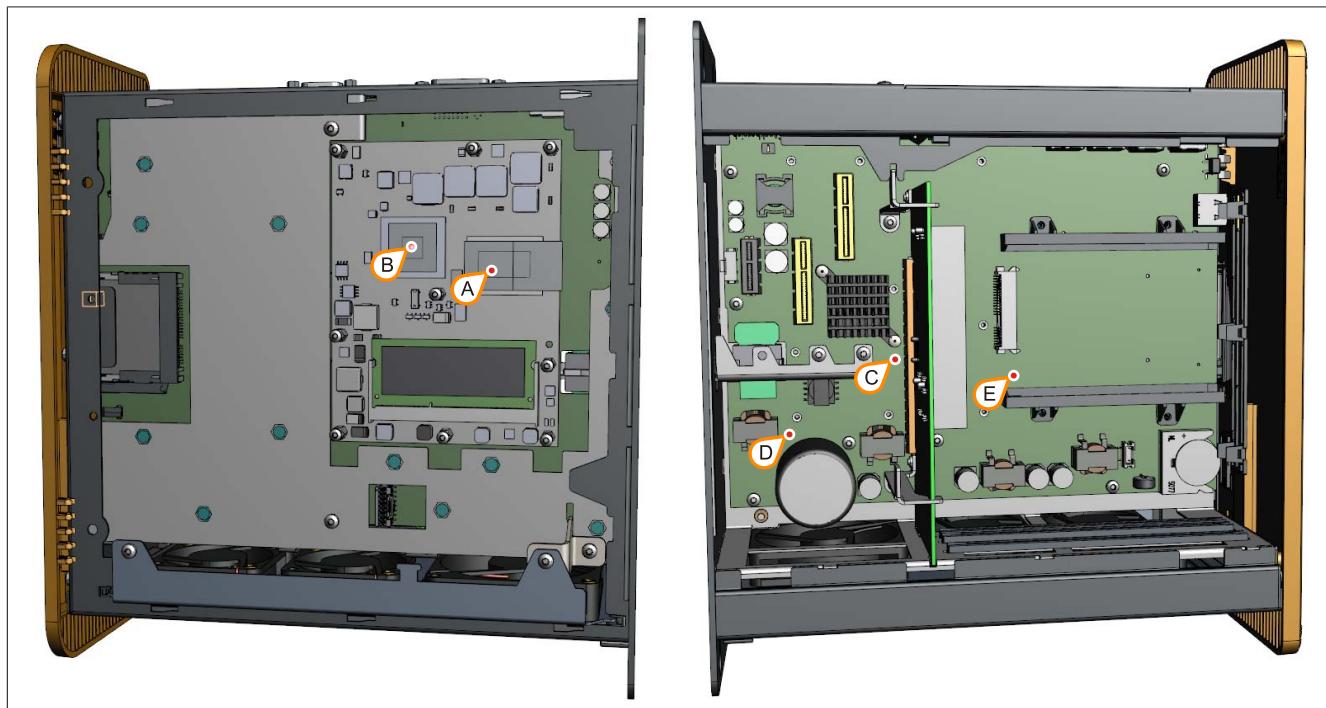


Figure 4: Temperature sensor locations

Position	Measurement point for	Measurement	Max. specified
A	CPU	Ambient temperature of the processor (sensor integrated in the processor)	95°C
B	Board Controller	Board Controller temperature (sensor integrated on the CPU board).	95°C
C	Main memory	Temperature around main memory (sensor integrated on the baseboard).	75°C
D	Board power supply	Board power supply temperature (sensor on the baseboard).	90°C
E	Slide-in compact	Temperature around slide-in compact drive (sensor on baseboard).	Drive-dependent
F	Slide-in drive 1	Temperature of a slide-in drive 1 (the sensor is integrated on the slide-in drive).	Drive-dependent
H	Interface option	Temperature of an interface option (sensor integrated on the interface option)	Depends on interface option
I	Monitor / Panel option	Temperature of a monitor / panel option (sensor integrated on the monitor / panel option)	Depends on monitor / panel option

Table 6: Temperature sensor locations

4) The temperature measured approximates the immediate ambient temperature but may also be influenced by neighboring components.

5) The measured temperature approximates the immediate ambient temperature, but can be influenced by neighboring components.

6) The ADI driver containing the B&R Control Center is available in the Downloads section of the B&R website (www.br-automation.com).

2.2 Humidity specifications

The following table displays the minimum and maximum relative humidity for the individual components that are relevant for the humidity limitations of the entire device. The lowest and highest common values are always used when establishing these limits.

Component		Operation	Storage / Transport
System units (all models)		5 to 90%	5 to 95%
QM77 / HM76 CPU boards		10 to 90%	5 to 95%
Main memory for CPU boards		10 to 90%	5 to 95%
Compact slide-in drive	5AC901.CHDD-00	5 to 95%	5 to 95%
	5AC901.CSSD-00	5 to 95%	5 to 95%
	5AC901.CSSD-01	5 to 95%	5 to 95%
	5AC901.CSSD-02	5 to 95%	5 to 95%
	5AC901.CCFA-00	5 to 90%	5 to 95%
Interface options	5AC901.I485-00	5 to 90%	5 to 95%
	5AC901.ICAN-00	5 to 90%	5 to 95%
	5AC901.IHDA-00	5 to 90%	5 to 95%
	5AC901.ISRM-00	5 to 90%	5 to 95%
Monitor / panel options	5AC901.LDPO-00	5 to 90%	5 to 95%
	5AC901.LSDL-00	5 to 90%	5 to 95%
Accessories	5MMUSB.2048-01 flash drive	10 to 90%	5 to 90%
	5CFAST.xxxx-00 CFast cards	Max. 85%	Max. 85%
	5MD900.USB2-02 USB Media Drive	20 to 80%	5 to 90% / 5 to 95%

Table 7: Overview of humidity specifications for individual components

The listed specifications correspond to the relative humidity at an ambient temperature of 30°C. More detailed information about the specific temperature-dependent humidity values can be found in the technical data for the individual components.

2.3 Power management

2.3.1 Block diagram - Supply voltage

The following block diagram presents the simplified structure of the APC910 supply voltage for system units.

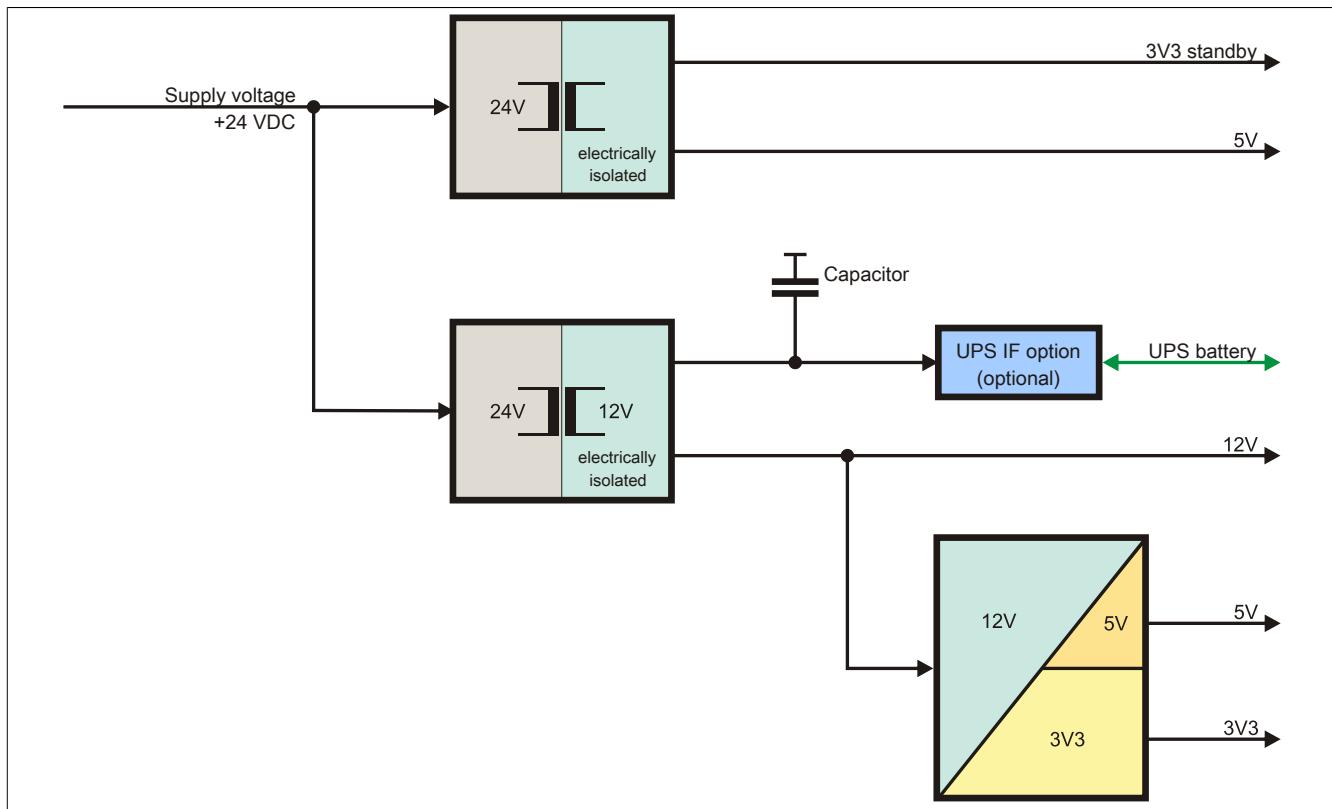


Figure 5: Supply voltage for system units

2.3.2 Power calculation with 5PC910.SX01-00

Information:

The power supply's maximum total power of 130 Watts must not be exceeded.

Information:	CPU board								Current system									
	SPC900.TS77-00	SPC900.TS77-01	SPC900.TS77-02	SPC900.TS77-03	SPC900.TS77-04	SPC900.TS77-05	SPC900.TS77-06	SPC900.TS77-07										
All values in Watts The values for the suppliers are maximum values. The values for the consumers are average maximum values, but not peak values.	Total power supply power (maximum)																	
	130																	
	Maximum possible																	
CPU board, permanent consumers	53	43	33	25	43	43	25	25	25									
1024 MB RAM, each 2 W, max. 2 pcs.																		
2048 MB RAM, each 2.5 W, max. 2 pcs.																		
4096 MB RAM, each 3 W, max. 2 pcs.																		
8192 MB RAM, each 3.5 W, max. 2 pcs.																		
Fan kit, optional	3	3	3	3	3	3	3	3	3									
External consumers, optional	10	10	10	10	10	10	10	10	10									
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 6 W with fan kit) ¹⁾																		
Power consumption of the PCIe x8 cards, optional (max. 3 W without fan kit, max. 20 W with fan kit) ¹⁾																		
Consumers Σ																		
	Maximum possible at +5V																	
Slide-in compact (HDD / SSD)	4	4	4	4	4	4	4	4	4									
5x USB peripherals, each max. 5 W																		
Interface option, optional ²⁾ max. 2 connections																		
External consumers, optional	5	5	5	5	5	5	5	5	5									
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 20 W with fan kit) ¹⁾																		
Maximum possible at -12V																		
-12 V	Power consumption of the PCI cards, optional (max. 1.2 W with and without fan kit) ¹⁾																	
Consumers -12 V Σ																		
Consumers +5 V Σ																		
Maximum possible at 3V3																		
30																		
System unit, permanent consumers	5	5	5	5	5	5	5	5	5									
CFast card	1	1	1	1	1	1	1	1	1									
Interface option, optional ²⁾																		
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 15 W with fan kit) ¹⁾																		
Power consumption of the PCIe x8 cards, optional (max. 3 W without fan kit, max. 10 W with fan kit) ¹⁾																		
Consumers 3V3 Σ																		
Total power supply, permanent consumers Σ																		

1) The total performance of one PCI/PCIe card per PCI slot (= sum of power consumptions for each voltage area) may not exceed the limits stated for operation with or without a fan kit.

2) Power ratings for the interface options can be found in the table below.

Table 8: Power calculation APC 1 slot

In order to accurately determine the total power of the entire device, the values in this table must be entered in the power calculation table if one or more of these options are connected to the system unit.

Model number	+5 V	3V3
Interface option		
5AC901.I485-00	1 W	-
5AC901.ICAN-00	TBD	TBD
5AC901.IHDA-00	0.2 W	0.2 W
Monitor / Panel option		
5AC901.LDPO-00	2 W	1 W
5AC901.LSDL-00	2 W	1 W

Table 9: Power rating table for interface and monitor / panel options

2.3.3 Power calculation with 5PC910.SX02-00

Information:

The power supply's maximum total power of 130 Watts must not be exceeded.

Information:	CPU board										Current system Enter values in this column
	SPC900.TS77-00	SPC900.TS77-01	SPC900.TS77-02	SPC900.TS77-03	SPC900.TS77-04	SPC900.TS77-05	SPC900.TS77-06	SPC900.TS77-07	SPC900.TS77-08		
Total power supply power (maximum)										130	
Maximum possible										130	
CPU board, permanent consumers	53	43	33	25	43	43	25	25	25		
1024 MB RAM, each 2 W, max. 2 pcs.											
2048 MB RAM, each 2.5 W, max. 2 pcs.											
4096 MB RAM, each 3 W, max. 2 pcs.											
8192 MB RAM, each 3.5 W, max. 2 pcs.											
Fan kit, optional	3	3	3	3	3	3	3	3	3		
External consumers, optional	10	10	10	10	10	10	10	10	10		
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 6 W with fan kit) ¹⁾											
Power consumption of the PCIe x8 cards, optional (max. 3 W without fan kit, max. 20 W with fan kit) ¹⁾											
Consumers Σ										45	
Slide-in compact (HDD / SSD)	4	4	4	4	4	4	4	4	4		
Slide-in (DVD / ...)	4	4	4	4	4	4	4	4	4		
5x USB peripherals, each max. 5 W											
Interface option, optional ²⁾ max. 2 connections											
Monitor / panel option, optional ²⁾											
External consumers, optional	5	5	5	5	5	5	5	5	5		
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 20 W with fan kit) ¹⁾											
Maximum possible at -12V										1.2	
-12 V Power consumption of the PCI cards, optional (max. 1.2 W with and without fan kit) ¹⁾											
Consumers -12 V Σ											
Consumers +5 V Σ											
Maximum possible at 3V3										30	
3V3 System unit, permanent consumers	5	5	5	5	5	5	5	5	5		
CFast card	1	1	1	1	1	1	1	1	1		
Interface option, optional ²⁾											
Monitor / panel option, optional ²⁾											
Power consumption of the PCI cards, optional (max. 3 W without fan kit, max. 15 W with fan kit) ¹⁾											
Power consumption of the PCIe x8 cards, optional (max. 3 W without fan kit, max. 10 W with fan kit) ¹⁾											
Consumers 3V3 Σ											
Total power supply, permanent consumers Σ											

1) The total performance of one PCI/PCIe card per PCI slot (= sum of power consumptions for each voltage area) may not exceed the limits stated for operation with or without a fan kit.

2) Power ratings for the interface and monitor / panel options can be found in the table below.

Table 10: Power calculation APC 2 slot

In order to accurately determine the total power of the entire device, the values in this table must be entered in the power calculation table if one or more of these options are connected to the system unit.

Model number	+5 V	3V3
Interface option		
5AC901.I485-00	1 W	-
5AC901.ICAN-00	TBD	TBD
5AC901.IHDA-00	0.2 W	0.2 W
Monitor / Panel option		
5AC901.LDPO-00	2 W	1 W
5AC901.LSDL-00	2 W	1 W

Table 11: Power rating table for interface and monitor / panel options

2.4 Block diagram

The following block diagrams show the simplified structure of system units with a CPU board that depend on different bus units.

2.4.1 System unit 5PC910.SX01-00 + bus unit 5AC901.BX01-00

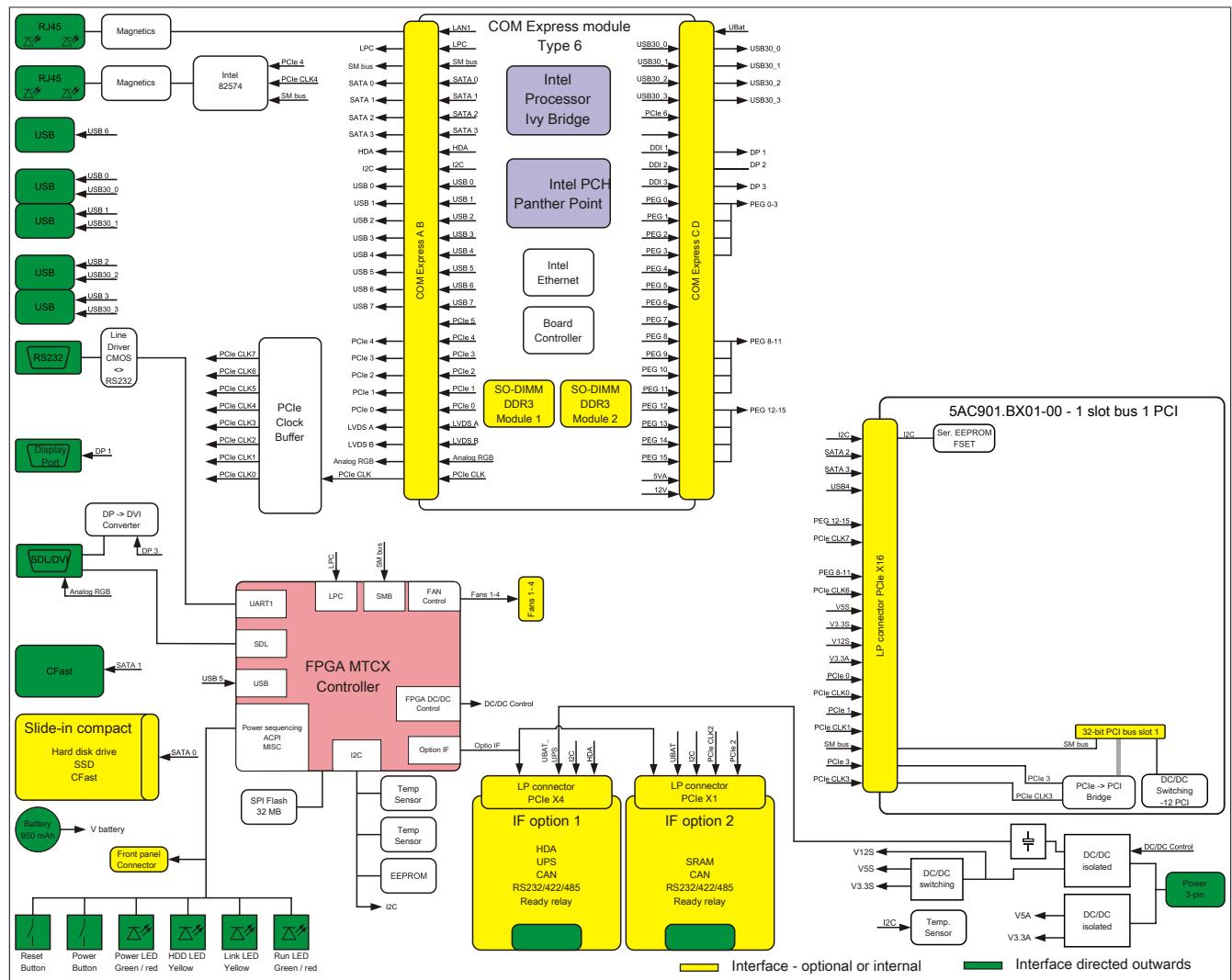


Figure 6: System unit 5PC910.SX01-00 + bus unit 5AC901.BX01-00 block diagram

2.4.2 System unit 5PC910.SX01-00 + bus unit 5AC901.BX01-01

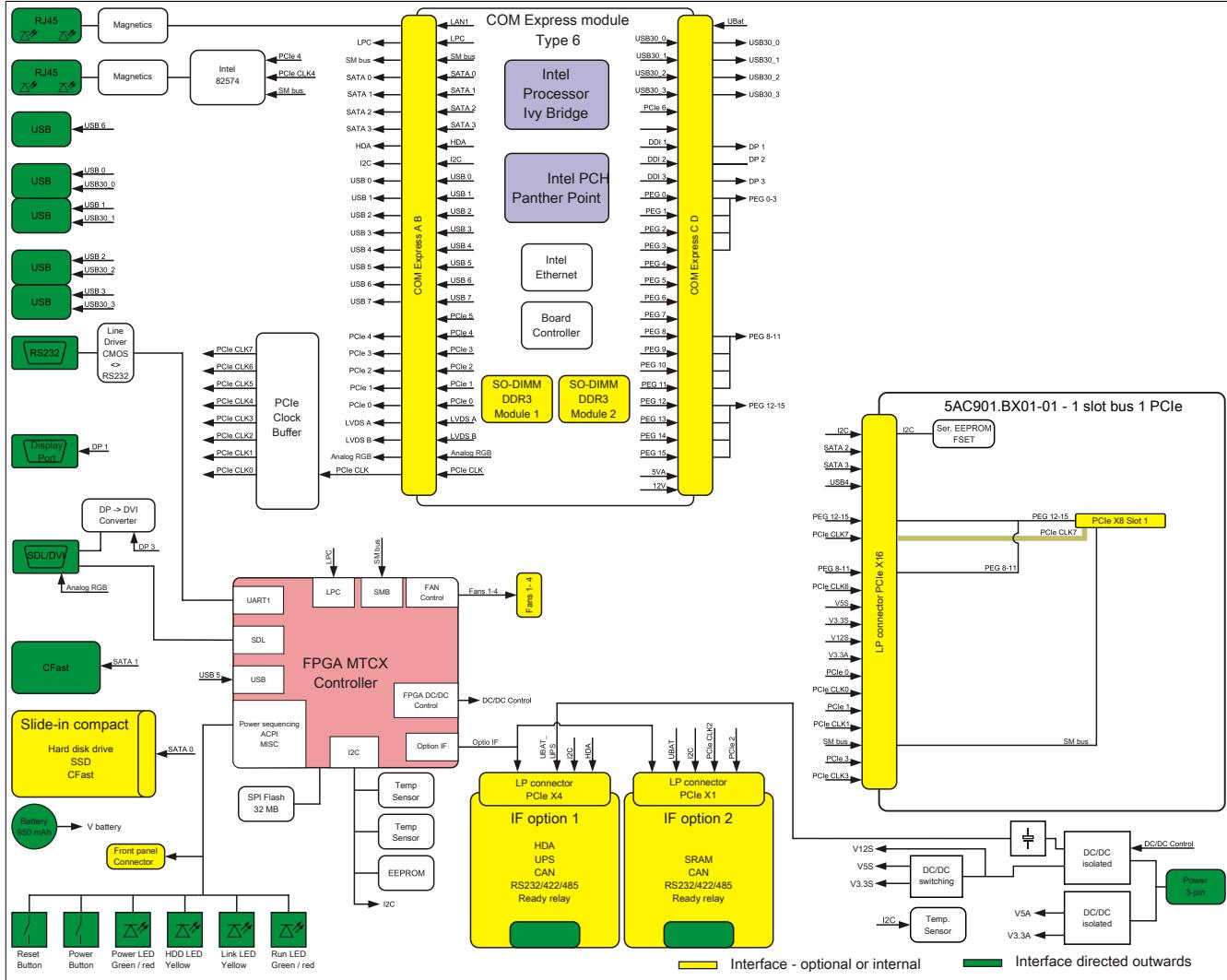


Figure 7: System unit 5PC910.SX01-00 + bus unit 5AC901.BX01-01 block diagram

2.4.3 System unit 5PC910.SX02-00 + bus unit 5AC901.BX02-00

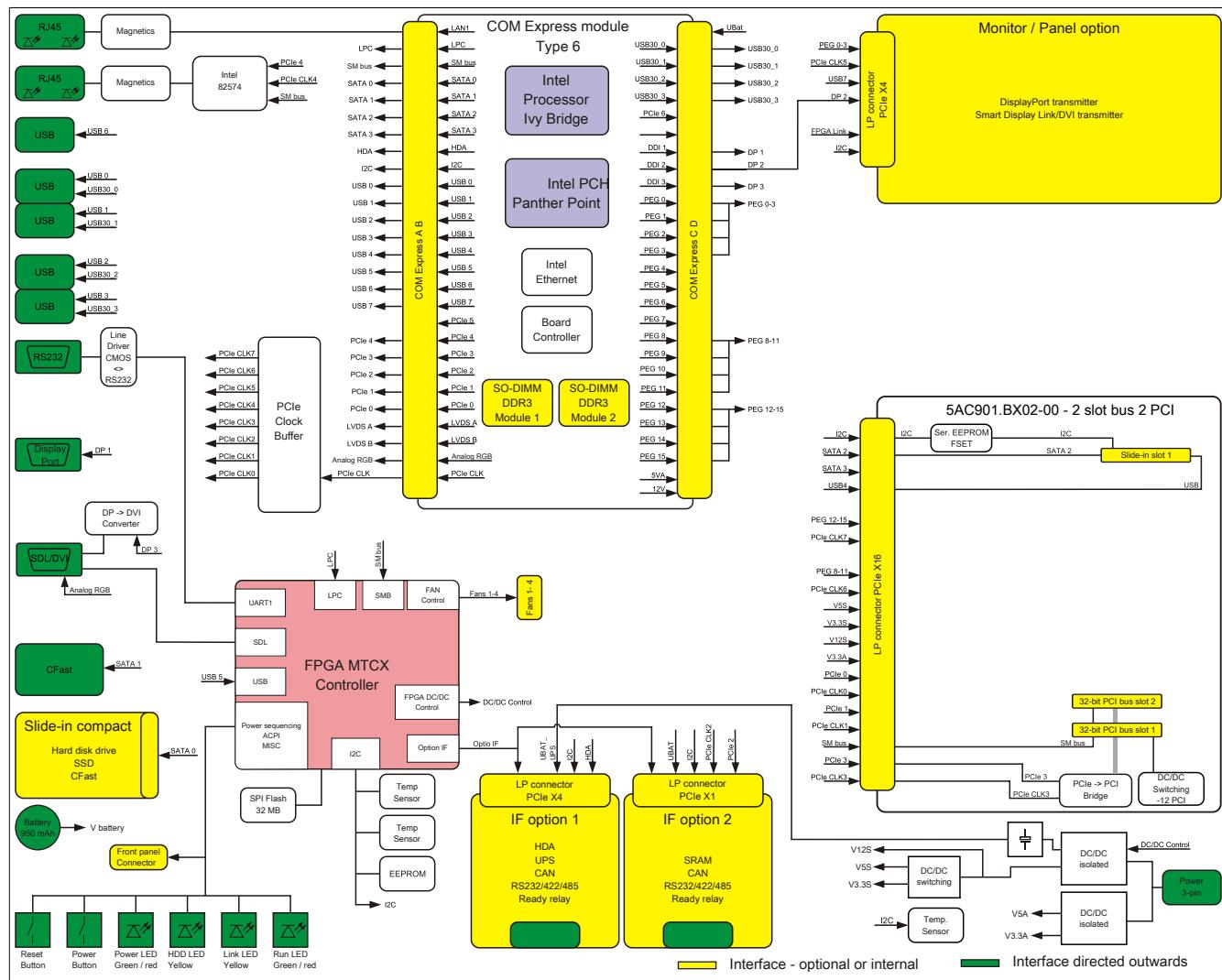


Figure 8: System unit 5PC910.SX02-00 + bus unit 5AC901.BX02-00 block diagram

2.4.4 System unit 5PC910.SX02-00 + bus unit 5AC901.BX02-01

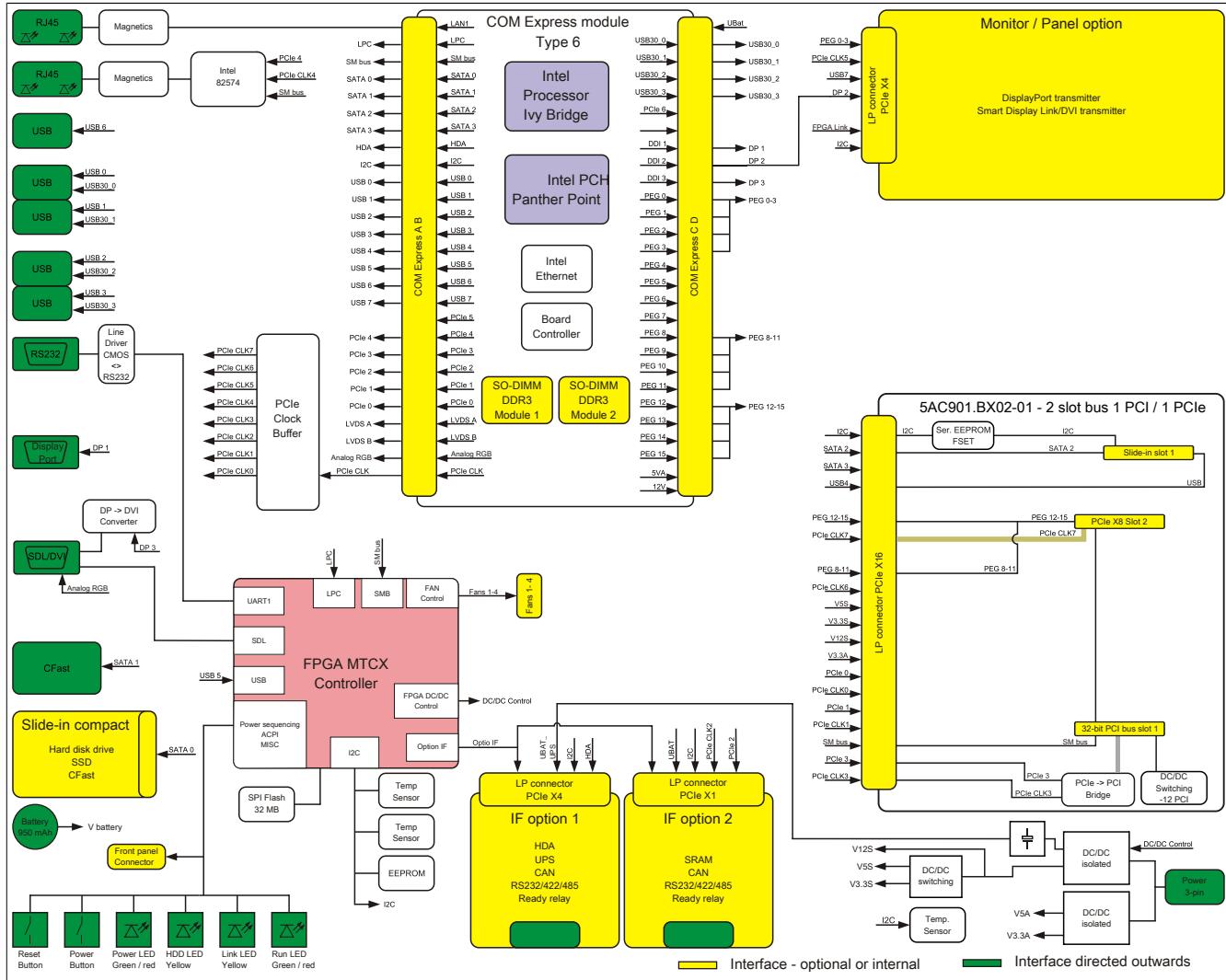


Figure 9: System unit 5PC910.SX02-00 + bus unit 5AC901.BX02-01 block diagram

2.4.5 Monitor / panel options

DisplayPort transmitter

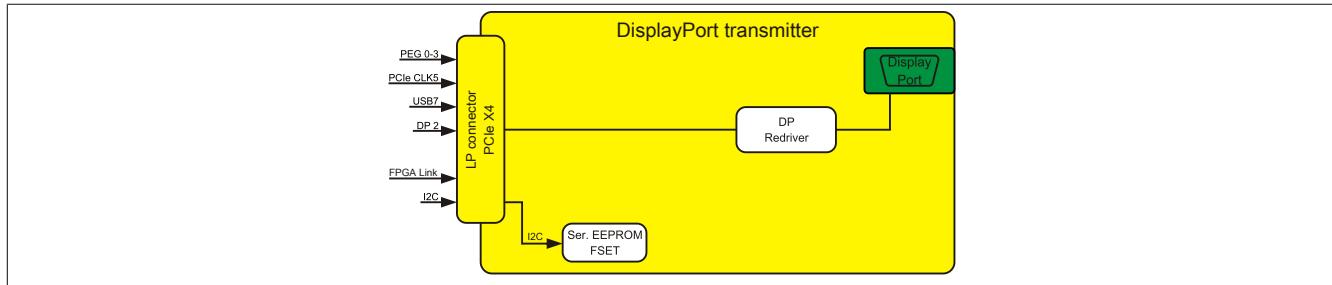


Figure 10: DisplayPort transmitter 5AC901.LDPO-00 block diagram

SDL / DVI transmitter

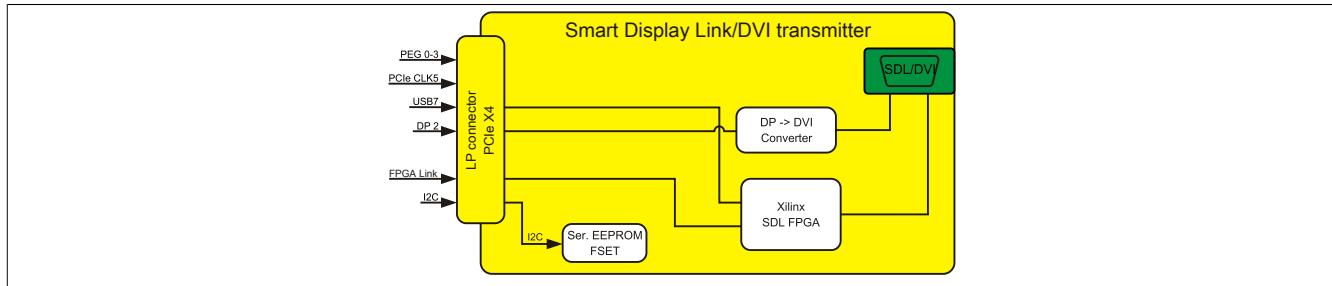


Figure 11: Smart Display Link/DVI transmitter 5AC901.LSDL-00 block diagram

2.5 Device interfaces

2.5.1 Overview of device interfaces

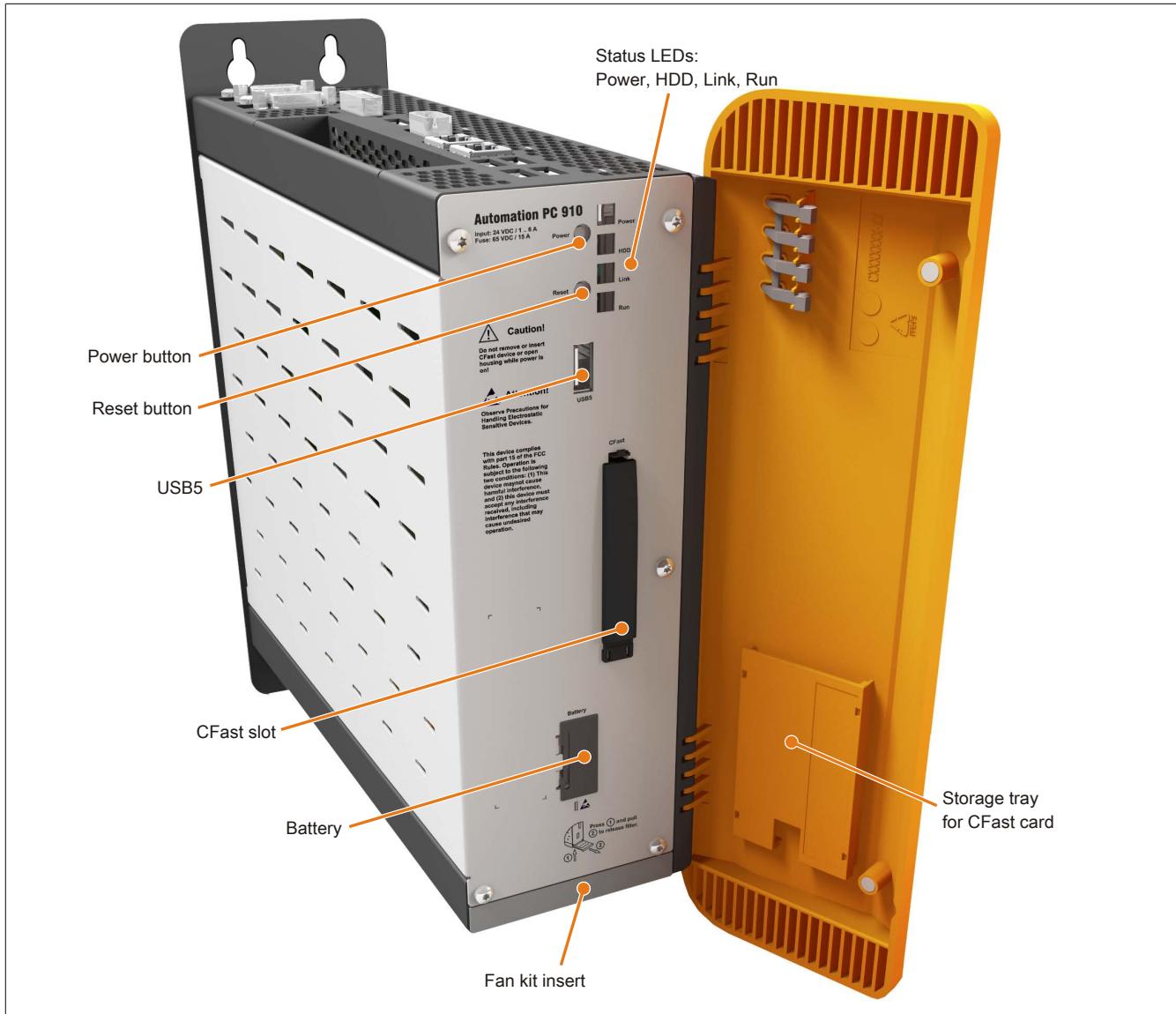


Figure 12: Device interfaces - Overview (front)

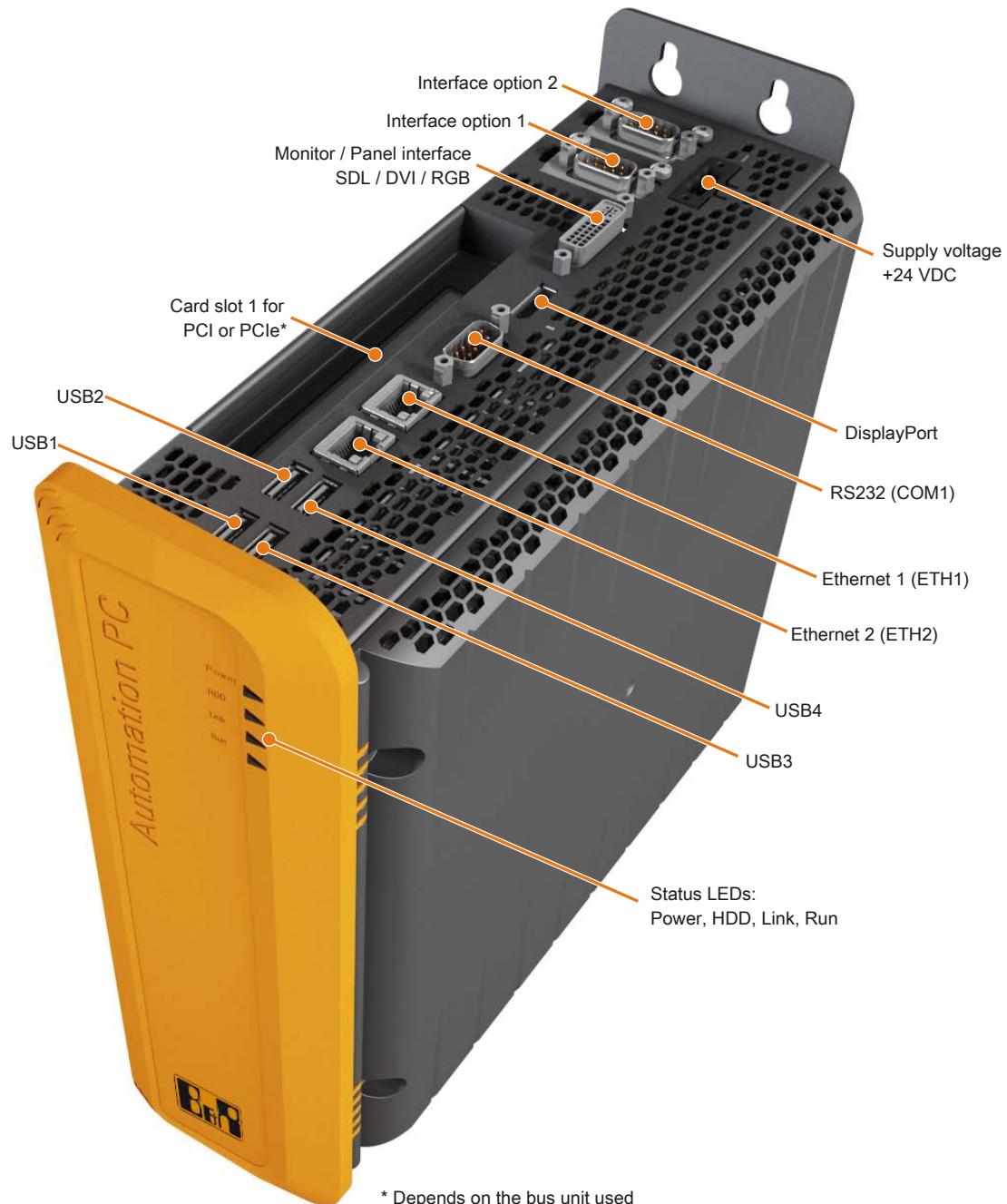


Figure 13: Device interfaces - Overview (top)

2.5.2 Supply voltage +24 VDC

The 3-pin socket required for the supply voltage connection is not included in delivery. This can be ordered from B&R using model number 0TB103.9 (screw clamp) or 0TB103.91 (cage clamp).

The pinout can be found either in the following table or printed on the housing. The supply voltage is protected internally by a soldered fuse (15 A, fast-acting) so that the device cannot be damaged if an overload occurs (fuse replacement necessary) or the voltage supply is connected incorrectly (reverse polarity protection - fuse replacement not necessary). The device must be returned to B&R for repairs if the fuse is blown due to an error.

		Supply voltage	
		Protected against reverse polarity	3-pin, male
Pin	Description		
1	+		
2	Functional ground		
3	-		
Model number	Short description		
Terminal blocks			
0TB103.9	Connector 24 V 5.08 3-pin screw clamp		
0TB103.91	Connector 24 V 5.08 3-pin cage clamp		



Table 12: 24 VDC supply voltage connection

Ground

Caution!

The pin's connection to the functional ground (pin 2) should be as short a path as possible (e.g. in the control cabinet). We recommend using the largest possible conductor cross section on the supply plug.

The grounding connection is located on the bottom of the APC910 systems.



Figure 14: Ground connection

The M4 self-locking nut can be used, for example, to fasten a copper strip that is built into the APC910 at a central grounding point in the control cabinet or system. The largest possible conductor cross section should be used (at least 2.5 mm²).

2.5.3 Serial interface COM1

Serial interface COM1 ¹⁾	
RS232	
Type	RS232, modem-capable, not electrically isolated
UART	16550-compatible, 16-byte FIFO
Transfer rate	Max. 115 kbit/s
Bus length	Max. 15 m
Pin	Assignment
1	DCD
2	RXD
3	TXD
4	DTR
5	GND
6	DSR
7	RTS
8	CTS
9	RI

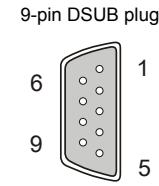


Table 13: Pin assignments - COM1

- 1) The interfaces, etc. available on the device or module have been numbered as such for easy identification. This numbering can differ from that used by the particular operating system.

2.5.4 Monitor / panel connection

Monitor / Panel connection - RGB / SDL (Smart Display Link) / DVI		
CPU board	Video signals for all system unit types	
5PC900.TS77-00	RGB, DVI, SDL	
5PC900.TS77-01	RGB, DVI, SDL	
5PC900.TS77-02	RGB, DVI, SDL	
5PC900.TS77-03	RGB, DVI, SDL	
5PC900.TS77-04	RGB, DVI, SDL	
5PC900.TS77-05	RGB, DVI, SDL	
5PC900.TS77-06	RGB, DVI, SDL	
5PC900.TS77-07	RGB, DVI, SDL	
5PC900.TS77-08	RGB, DVI, SDL	



Table 14: Monitor / Panel connection - RGB, DVI, SDL

Pinout

Pin	assignment	Description	Pin	assignment	Description
1	TMDS Data 2-	DVI lane 2 (negative)	16	HPD	Hot plug detect
2	TMDS Data 2+	DVI lane 2 (positive)	17	TMDS Data 0-	DVI lane 0 (negative)
3	TMDS Data 2/4 SHIELD	Shield for data pair 2 and 4	18	TMDS Data 0+	DVI lane 0 (positive)
4	SDL-	SDL lane (negative)	19	TMDS Data 0/ XUSB1 SHIELD	Shield for data pair 0 and USB1
5	SDL+	SDL lane (positive)	20	XUSB1-	USB lane 1 (negative)
6	DDC Clock	DDC-based control signal (clock)	21	XUSB1+	USB lane 1 (positive)
7	DDC Data	DDC-based control signal (data)	22	TMDS Clock Shield	Shield for clock pair
8	n.c.	Not connected	23	TMDS Clock+	DVI clock (positive)
9	TMDS Data 1-	DVI lane 1 (negative)	24	TMDS Clock -	DVI clock (negative)
10	TMDS DATA 1+	DVI lane 1 (negative) HDMI clock (positive)	C1	ANALOG RED	Analog red
11	TMDS DATA 1/ XUSB0 SHIELD	Shield for data pair 1 and USB0	"c2"	ANALOG GREEN	Analog green
12	XUSB0-	USB lane 0 (negative)	C3	ANALOG BLUE	Analog blue
13	XUSB0+	USB lane 0 (positive)	C4	ANALOG HORZ SYNC	Analog horizontal synchronization
14	+5 V Power ¹⁾	+5 V power supply	C5	ANALOG GND	Analog ground (return for R, G and B signals)
15	Ground (return for +5 V, HSync and VSync)	Ground			

DVI 24-pin, female

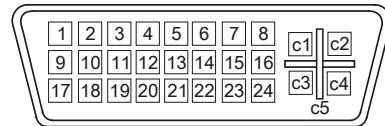


Table 15: Pinout - DVI connection

1) Protected internally by a multifuse

Cable lengths and resolutions for SDL transfer

The following table lists the relationship between segment lengths and maximum resolution depending on the SDL cable used:

SDL cables Segment length [m]	Resolution					
	VGA 640 x 480	SVGA 800 x 600	XGA 1024 x 768	SXGA 1280 x 1024	UXGA 1600 x 1200	FHD 1920 x 1080
1.8	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03	5CASDL.0018-00 5CASDL.0018-01 5CASDL.0018-03
5	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03	5CASDL.0050-00 5CASDL.0050-01 5CASDL.0050-03
10	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03	5CASDL.0100-00 5CASDL.0100-01 5CASDL.0100-03
15	5CASDL.0150-00 5CASDL.0150-01 5CASDL.0150-03	5CASDL.0150-00 5CASDL.0150-01 5CASDL.0150-03	5CASDL.0150-00 5CASDL.0150-01 5CASDL.0150-03	5CASDL.0150-00 5CASDL.0150-01 5CASDL.0150-03	-	-
20	5CASDL.0200-00 5CASDL.0200-03	5CASDL.0200-00 5CASDL.0200-03	5CASDL.0200-00 5CASDL.0200-03	5CASDL.0200-00 5CASDL.0200-03	-	-

Table 16: Cable lengths and resolutions for SDL transfer

SDL cables		Resolution					
		VGA 640 x 480	SVGA 800 x 600	XGA 1024 x 768	SXGA 1280 x 1024	UXGA 1600 x 1200	FHD 1920 x 1080
25		5CASDL.0250-00 5CASDL.0250-03	5CASDL.0250-00 5CASDL.0250-03	5CASDL.0250-00 5CASDL.0250-03	-	-	-
30		5CASDL.0300-00 5CASDL.0300-03	5CASDL.0300-00 5CASDL.0300-03	-	-	-	5CASDL.0300-13
40		5CASDL.0400-13	5CASDL.0400-13	5CASDL.0400-13	5CASDL.0400-13	-	5CASDL.0400-13

Table 16: Cable lengths and resolutions for SDL transfer

Cable lengths and resolutions for DVI transfer

The following table lists the relationship between segment lengths and maximum resolution depending on the DVI cable used:

DVI cable		Resolution					
		VGA 640 x 480	SVGA 800 x 600	XGA 1024 x 768	SXGA 1280 x 1024	UXGA 1600 x 1200	FHD 1920 x 1080
1.8		5CADVI.0018-00	5CADVI.0018-00	5CADVI.0018-00	5CADVI.0018-00	5CADVI.0018-00	5CADVI.0018-00
5		5CADVI.0050-00	5CADVI.0050-00	5CADVI.0050-00	5CADVI.0050-00	5CADVI.0050-00	5CADVI.0050-00

Table 17: Cable lengths and resolutions for DVI transfer

2.5.5 DisplayPort

DisplayPort 1.1							
CPU board		Video signals for all system unit types					
The following overview lists the video signals available on the DisplayPort 1.1 output. For details, see the technical data for the CPU board being used.							
5PC900.TS77-00							DisplayPort, DVI, HDMI
5PC900.TS77-01							DisplayPort, DVI, HDMI
5PC900.TS77-02							DisplayPort, DVI, HDMI
5PC900.TS77-03							DisplayPort, DVI, HDMI
5PC900.TS77-04							DisplayPort, DVI, HDMI
5PC900.TS77-05							DisplayPort, DVI, HDMI
5PC900.TS77-06							DisplayPort, DVI, HDMI
5PC900.TS77-07							DisplayPort, DVI, HDMI
5PC900.TS77-08							DisplayPort, DVI, HDMI

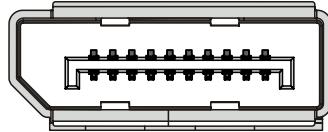


Table 18: DisplayPort 1.1

Pin assignments - DisplayPort

Pin	Signal	Description	Pin	Signal	Description	DisplayPort (20-pin, female)	
1	DP_LANE0+	DisplayPort lane 0 (positive)	11	GND	Ground		
2	GND	Ground	12	DP_LANE3-	DisplayPort lane 3 (negative)		
3	DP_LANE0-	DisplayPort lane 0 (negative)	13	CONFIG1	Configuration pin 1 (connected to ground)		
4	DP_LANE1+	DisplayPort lane 1 (positive)	14	CONFIG2	Configuration pin 2 (connected to ground)		
5	GND	Ground	15	DP_AUX+	Auxiliary channel (positive)		
6	DP_LANE1-	DisplayPort lane 1 (negative)	16	GND	Ground		
7	DP_LANE2+	DisplayPort lane 2 (positive)	17	DP_AUX-	Auxiliary channel (negative)		
8	GND	Ground	18	DP_HPD#	Hot Plug detect		
9	DP_LANE2-	DisplayPort lane 2 (negative)	19	RETURN	Return for power		
10	DP_LANE3+	DisplayPort lane 3 (positive)	20	DP_PWR	Power for connector		

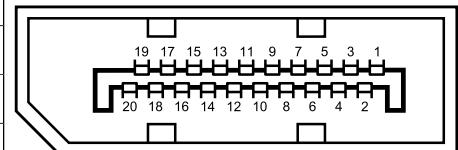


Table 19: Pin assignments - DisplayPort

2.5.6 Ethernet 1 (ETH1)

This Ethernet controller is integrated in the CPU board and connected to external devices via the system unit.

Ethernet 1 connection (ETH1 ¹⁾)		
Controller	Intel® 82579	
Cabling	S/STP (Cat5e)	
Transfer rate	10/100/1000 Mbit/s ²⁾	
Cable length	Max. 100 m (min. Cat5e)	
Speed LED	On	Off
Green	100 Mbit/s	10 Mbit/s ³⁾
Orange	1000 Mbit/s	-
Link LED	On	Off
Orange	Link (Ethernet network connection available)	Activity (blinking - data transfer in progress)

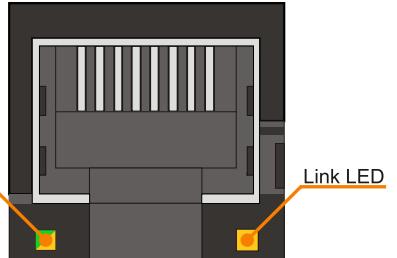


Table 20: Ethernet connection (ETH1)

- 1) The interfaces, etc. available on the device or module have been numbered as such for easy identification. This numbering can differ from that used by the particular operating system.
- 2) Switching takes place automatically.
- 3) The 10 Mbit/s transfer speed / connection is only present if the Link LED is also lit at the same time.

Driver support

A special driver is required in order to operate the Ethernet controller. Drivers for approved operating systems are available in the Downloads area of the B&R website (www.br-automation.com).

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

2.5.7 Ethernet 2 (ETH2)

This Ethernet controller is integrated in the main board and connected to external devices via the system unit.

Ethernet 2 connection (ETH2 ¹⁾)		
Controller	Intel® 82574L	
Cabling	S/STP (Cat5e)	
Transfer rate	10/100/1000 Mbit/s ²⁾	
Cable length	Max. 100 m (min. Cat5e)	
Speed LED	On	Off
Green	100 Mbit/s	10 Mbit/s ³⁾
Orange	1000 Mbit/s	-
Link LED	On	Off
Orange	Link (Ethernet network connection available)	Activity (blinking - data transfer in progress)

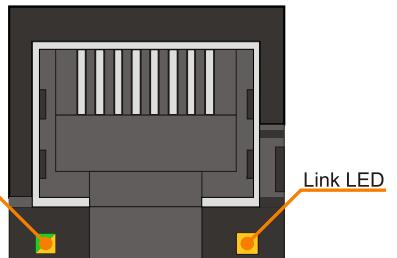


Table 21: Ethernet connection (ETH2)

- 1) The interfaces, etc. available on the device or module have been numbered as such for easy identification. This numbering can differ from that used by the particular operating system.
- 2) Switching takes place automatically.
- 3) The 10 Mbit/s transfer speed / connection is only present if the Link LED is also lit at the same time.

Driver support

A special driver is required in order to operate the Ethernet controller. Drivers for approved operating systems are available in the Downloads area of the B&R website (www.br-automation.com).

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

2.5.8 USB ports

The APC910 features a USB 3.0 (Universal Serial Bus) host controller with multiple USB ports, four of which are accessible externally for easy user access. The 4 USB ports (USB1-4) on the top are USB 3.0 ports. The USB port on the front (USB5) is a USB 2.0 port.

Warning!

Peripheral USB devices can be connected to the USB interfaces. Due to the vast number of USB devices available on the market, B&R cannot guarantee their performance. B&R does ensure the performance of all USB devices that they provide.

Caution!

Because this interface is designed according to general PC specifications, extreme care should be exercised with regard to EMC, cable routing, etc.

USB1, USB2, USB3, USB4

4 USB 3.0 ports are provided on the top of the APC910.

Universal Serial Bus (USB1, USB2, USB3, USB4) ¹⁾	
Type	USB 2.0 / 3.0
Design	Type A
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s), super speed (5 Gbit/s)
Current load ²⁾ USB1, USB2 USB3, USB4	Max. 1 A Max. 1 A
Cable length USB 2.0 USB 3.0	Max. 5 m (without hub) Max. TBD m (without hub)

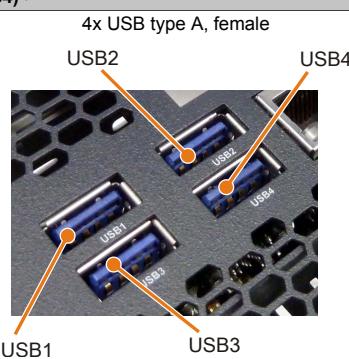


Table 22: USB1, USB2, USB3, USB4 connection

- 1) The interfaces, etc. available on the device or module have been numbered as such for easy identification. This numbering can differ from that used by the particular operating system.
- 2) Each USB port is secured with a maintenance-free "USB current-limiting circuit breaker" (max. 1 A).

USB5

A USB 2.0 port is provided on the front side of the APC910 behind the front cover.

Universal Serial Bus (USB5) ¹⁾	
Type	USB 2.0
Design	Type A
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s)
Current load ²⁾ USB5	Max. 1 A
Cable length	Max. 5 m (without hub)

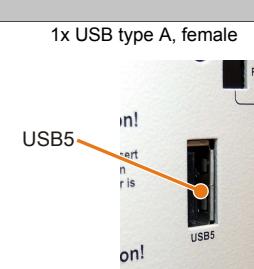


Table 23: USB5 connection

- 1) The interfaces, etc. available on the device or module have been numbered as such for easy identification. This numbering can differ from that used by the particular operating system.
- 2) Each USB port is secured with a maintenance-free "USB current-limiting circuit breaker" (max. 1 A).

2.5.9 IF option 1 slot

Automation PC 910 system units include 2 slots for interface options.

IF option 1 slot	
Model number	Short description
Interface option	
5AC901.I485-00	RS232/422/485 interface option; for installation in an APC910
5AC901.ICAN-00 ¹⁾	CAN interface option; for installation in an APC910
5AC901.IHDA-00	Audio interface option; connection for 1x MIC, 1x Line IN, 1x Line OUT for installation in an APC910



Table 24: IF option 1 slot

- 1) It is not possible to run two 5AC901.ICAN interface options (connected to both the IF Option 1 and IF Option 2 slots).

Information:

For information about replacing or exchanging an interface option, please refer to the section "Installation - Interface option" on page 139.

2.5.10 IF option 2 slot

Automation PC 910 system units include 2 slots for interface options.

IF option 2 slot	
Model number	Short description
Interface option	
5AC901.I485-00	RS232/422/485 interface option; for installation in an APC910
5AC901.ICAN-00 ¹⁾	CAN interface option; for installation in an APC910
5AC901.ISRM-00	SRAM interface option, 2 MB; for installation in an APC910



Table 25: IF option 2 slot

- 1) It is not possible to run two 5AC901.ICAN interface options (connected to both the IF Option 1 and IF Option 2 slots).

Information:

For information about replacing or exchanging an interface option, please refer to the section "Installation - Interface option" on page 139.

2.5.11 Card slot (PCI / PCIe)

Standard PCI 2.2 half-size cards or PCI Express (PCIe) half-size cards can be inserted depending on the type of bus unit. They cannot exceed the following dimensions.

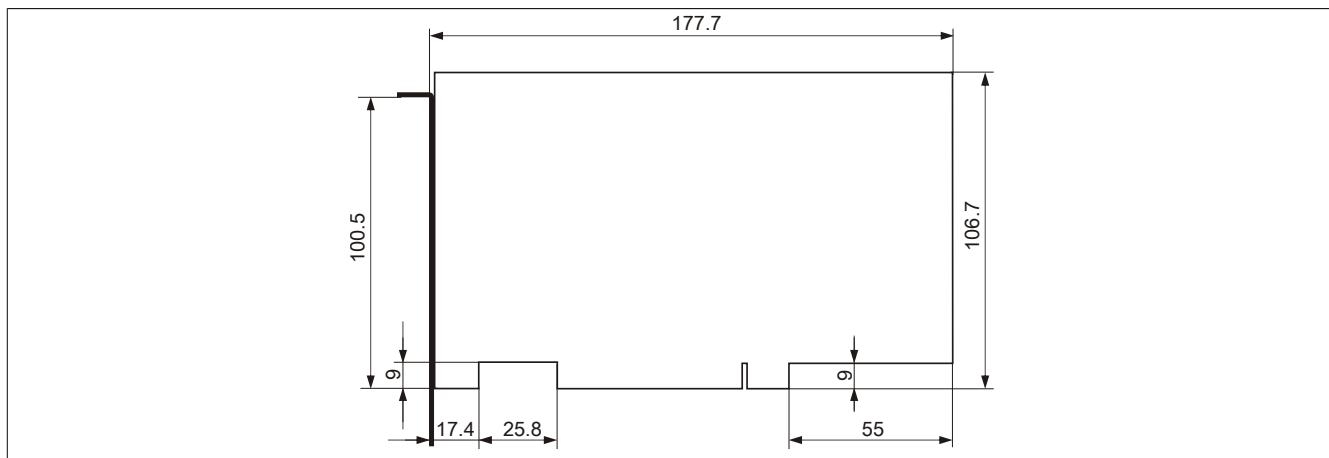


Figure 15: Dimensions - Standard half-size 32-bit PCI card

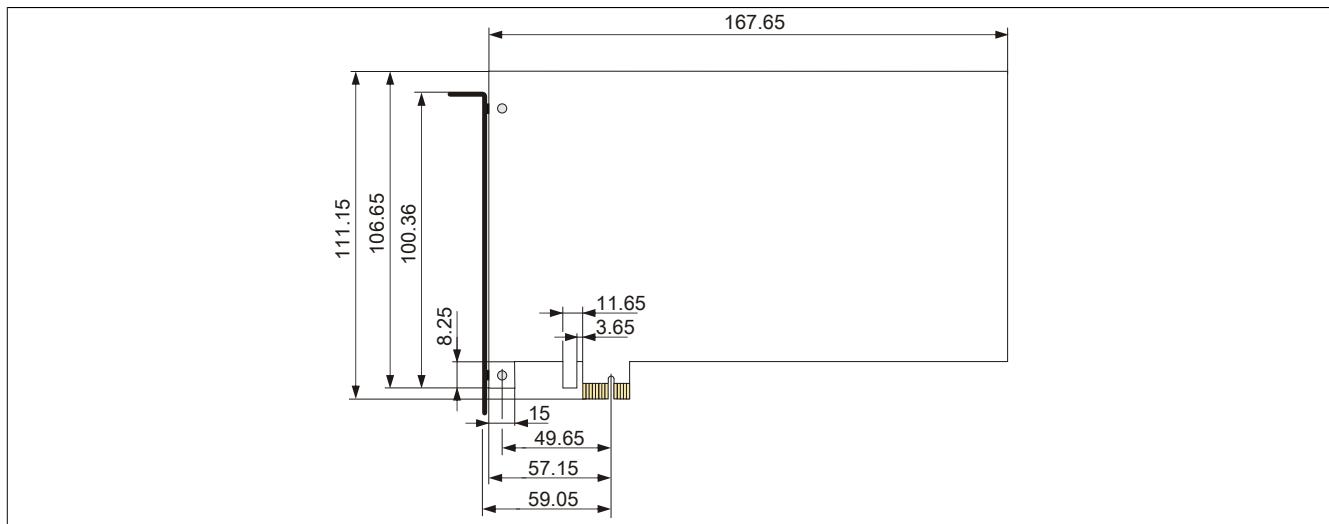
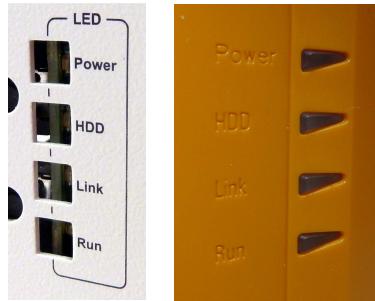


Figure 16: Dimensions - Standard half-size PCIe card

2.5.12 Status LEDs

Status LEDs are located on the front of the system unit.



The following timing is used for the status LEDs:

Block size: 250 ms

Repeat interval: 500 ms; 2 boxes represent one interval

LED	Color	Status	Meaning	LED Indicator
Power	Green	On	Supply voltage OK	
		Blinking	The device has booted, the battery status is "BAD".	
		Information: For more information, see "Battery" on page 44.		
	Red	On	The system is in standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)	
		Blinking	The MTCX is running, the battery status is "BAD". The system is in standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk).	
	Red / green	Blinking	Faulty or incomplete BIOS, MTCX or I/O FPGA update, battery status OK, power supply OK	
			Faulty or incomplete BIOS, MTCX or I/O FPGA update, battery status OK, standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)	
			Faulty or incomplete BIOS, MTCX or I/O FPGA update, battery status BAD, power supply OK	
			Faulty or incomplete BIOS, MTCX or I/O FPGA update, battery status BAD, standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)	
	Information: An update must be performed again.			
HDD	Yellow	On	Indicates drive access (HDD, CFast)	
Link	Yellow	On	Indicates an active SDL connection on the panel plug	
		Blinking	An active SDL connection has been interrupted by a loss of power to the display unit.	
Information: Check the power supply / power connector for the connected display unit.				
Run	Green	Blinking	Automation Runtime booting Handled by Automation Runtime (ARemb and ARwin)	
	Green	On	Application running Handled by Automation Runtime (ARemb and ARwin)	
	Red	On	Application in service mode Handled by Automation Runtime (ARemb and ARwin)	

Table 26: Data - Status LEDs

2.5.13 Power button

The power button provides a wide range of ATX power supply functions.

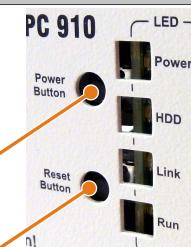
Power button	
<p>The power button can be pressed with a pointed object (e.g. paper clip or tip of a pen).</p> <p>The power button acts like the on/off switch on a normal desktop PC with an ATX power supply:</p> <p>Press and release ... Switches on the APC910 or shuts down the operating system and switches off the APC910.</p> <p>Press and hold ... ATX power supply switches off without shutting down the APC910 (data could be lost!).</p> <p>Pressing the power button does not reset the MTCX processor.</p>	

Table 27: Power button

2.5.14 Reset button

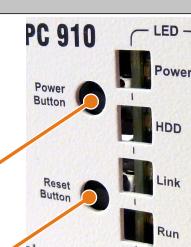
Reset button	
<p>The reset button can be pressed with a pointed object (e.g. paper clip or tip of a pen).</p> <p>Pushing the reset button triggers a hardware and PCI reset. The APC910 is restarted (cold restart).</p> <p>Pressing the reset button does not reset the MTCX processor.</p>	

Table 28: Reset button

Warning!

A system reset can result in lost data!

2.5.15 Battery

The lithium battery (3 V, 950 mAh) buffers the internal real-time clock (RTC). It is located behind the black cover on the front of the device. The battery's buffer lifespan is at least TBD years (at 50°C, TBD µA for the components being supplied and a self-discharge of 40%). The battery has a limited lifespan and should be replaced regularly (after the specified service life at the latest).

Battery	
Battery	Renata 950 mAh Yes, accessible from the outside TBD Years ¹⁾
Model number	Short description
	Batteries
0AC201.91	Lithium batteries, 4 pcs., 3 V / 950 mAh, button cell
4A0006.00-000	Lithium battery, 1 pc., 3 V / 950 mAh, button cell

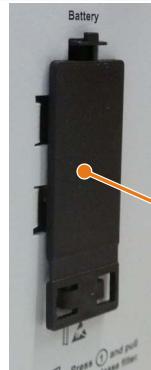


Table 29: Battery

1) At 50°C, TBD µA for the components being supplied and a self-discharge of 40%

The status of the battery is determined immediately after the device is started and subsequently checked by the system every 24 hours. During this measurement, the battery is subjected to a brief (approximately 1 second) load and then evaluated. Once determined, the battery status is displayed in BIOS (under Advanced -> OEM Features -> System Board Features -> Voltage Values) and in the B&R Control Center (ADI driver); it can also be read in a customer application using the ADI library.

Battery status	Meaning
N/A	The hardware or firmware being used is too old and does not support reading the battery status.
GOOD	Data buffering is provided.
BAD	Data buffering is provided for approximately another 500 hours from the point when battery capacity is recognized as insufficient (BAD).

Table 30: Meaning of the battery status

Data buffering is provided for approximately another 500 hours from the point when battery capacity is recognized as insufficient. When replacing the battery, data is buffered for approximately 10 minutes by a gold leaf capacitor.

2.5.16 CFast slot

The APC910 offers an easy-to-reach CFast slot behind its front cover so that the CFast card can also be used as removable media for transferring data or performing upgrades.

This CFast slot is connected to the chipset internally via SATA I.

CFast slot	
Connection	SATA I
Model number	Short description
	CFast cards
5CFAST.2048-00	CFast card, 2 GB
5CFAST.4096-00	CFast card, 4 GB
5CFAST.8192-00	CFast card, 8 GB
5CFAST.016G-00	CFast card, 16 GB
5CFAST.032G-00	CFast card, 32 GB

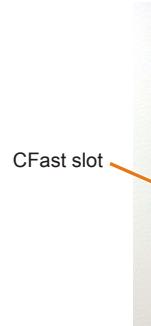


Table 31: CFast slot

Warning!

Power must be turned off before inserting or removing CFast cards!

2.5.17 Slide-in compact slot

The internal connection between the slide-in compact slot and the chipset is made via SATA 0.

Slide-in compact slot	
Connection	SATA 0
Model number	Short description
	Drives
5AC901.CHDD-00	250 GB SATA slide-in compact hard disk, 24/7 hard disk with extended temperature range. Note: Please see manual for information about using this hard disk.
5AC901.CSSD-00	32 GB SATA SSD (SLC), slide-in compact drive
5AC901.CSSD-01	60 GB SATA SSD (MLC), slide-in compact drive
5AC901.CSSD-02	180 GB SATA SSD (MLC), slide-in compact drive
5AC901.CCFA-00	CFast adapter for operating a CFast card in a slide-in compact slot

Table 32: Slide-in compact slot

Information:

The slide-in compact slot cannot be accessed from the outside. The side panel must be removed in order to exchange a drive. For information about replacing or exchanging an slide-in compact drive, please refer to the section "Slide-in compact drive installation / replacement" on page 147.

3 Individual components

3.1 System units

The system unit unites all of the individual components into one compact device. It consists of a housing and an integrated main board. Interfaces are easily accessible either on top of the device or behind the orange cover on the front. System units either have 1 or 2 card slots.

3.1.1 5PC910.SX01-00

General information

- Slot for a bus unit with 1 PCI or 1 PCIe slot
- Insert for 1 slide-in compact drive
- Insert for 2 interface options
- SDL/DVI/Monitor and DisplayPort interfaces
- CFast slot

Order data

Model number	Short description	Figure
	System units	
5PC910.SX01-00	APC910 system unit, 1 slot (PCI Express / PCI, depending on bus), 1 slide-in compact slot; Smart Display Link/DVI/monitor, DisplayPort, 1x RS232, 5x USB, 2x ETH 10/100/1000, 1 CFast slot, 24 VDC	
	Required accessories	
	Bus units	
5AC901.BX01-00	APC910 bus, 1 PCI	
5AC901.BX01-01	APC910 bus, 1 PCI Express (x4)	
	CPU boards	
5PC900.TS77-00	Intel Core i7 3615QE CPU board, 2.3 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-01	Intel Core i7 3612QE CPU board, 2.1 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-02	Intel Core i7 3555LE CPU board, 2.5 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-03	Intel Core i7 3517UE CPU board, 1.7 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-04	Intel Core i5 3610ME CPU board, 2.7 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-05	Intel Core i3 3120ME CPU board, 2.4 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-06	Intel Core i3 3217UE CPU board, 1.6 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-07	Intel Celeron M 847E CPU board, 1.1 GHz, dual-core, 1 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-08	Intel Celeron M 827E CPU board, 1.4 GHz, single-core, 1.5 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
	Heat sink	
5AC901.HS00-00	APC910 heat sink active	
5AC901.HS01-00	APC910 heat sink passive	
	Main memory	
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB	
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB	
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB	
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB	
	Terminal blocks	
0TB103.9	Connector, 24 VDC, 3-pin female, screw clamps 3.31 mm ² , protected against vibration by the screw flange	
0TB103.91	Connector, 24 VDC, 3-pin female, cage clamps 3.31 mm ² , protected against vibration by the screw flange	
	Optional accessories	

Table 33: 5PC910.SX01-00 - Order data

Model number	Short description	Figure
	Drives	
5AC901.CCFA-00	CFast adapter to operate a CFast card in a slide-in compact slot	
5AC901.CHDD-00	250 GB SATA hard disk, Slide-in compact, 24/7 hard disk	
5AC901.CSSD-00	32 GB SATA SSD (SLC), Slide-in compact	
5AC901.CSSD-01	60 GB SATA SSD (MLC), Slide-in compact	
5AC901.CSSD-02	180 GB SATA SSD (MLC), Slide-in compact	
	Fan kits	
5AC901.FA01-00	APC910 fan kit for system unit 5PC910.SX01-00	
	Interface options	
5AC901.I485-00	RS232/422/485 interface option; for APC910	
5AC901.ICAN-00	CAN interface option; for APC910	
5AC901.IHDA-00	Audio interface option, connection for 1x MIC, 1x Line IN, 1x Line OUT; for APC910	
5AC901.ISRM-00	SRAM interface option, 2 MB; for APC910	

Table 33: 5PC910.SX01-00 - Order data

Technical data

Product ID	5PC910.SX01-00
General information	
Cooling	Passive via heat sink and optionally supported with an active fan kit
LEDs	Power, HDD, Link, Run
B&R ID code	\$D6DA
Battery	
Type	Renata 950 mAh
Lifespan	TBD ¹⁾
removable	Yes, accessible behind the orange front doors
Design	Lithium Ion
Power button	Yes
Reset button	Yes
Buzzer	Yes
Certification	
CE	Yes
Controller	
Boot loader	BIOS
Real-time clock	
Battery-buffered	Yes
Power failure logic	
Controller	MTCX ²⁾
Buffer time	10 ms
Graphics	
Controller	Depending on the CPU board used
Memory	
Type	SO-DIMM DDR3 SDRAM
Size	Max. 16 GB
Interfaces	
COM1	
Type	RS232, modem-capable, not electrically isolated
Design	9-pin DSUB plug
UART	16550-compatible, 16-byte FIFO
Max. baud rate	115 kbit/s
CFast slot	
Quantity	1
USB	
Quantity	5
Type	4x USB 3.0 (top) 1x USB 2.0 (front)
Design	Type A
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s), super speed (5 GBit/s) ³⁾
Current load	Max. 1 A per connection
Ethernet	
Quantity	2
Design	Shielded RJ45 port
Transfer rate	10/100/1000 Mbit/s
Max. baud rate	1 Gbit/s
DisplayPort	
Quantity	1
Version	1.1
Panel/Monitor interface	
Design	DVI-I socket
Type	SDL/DVI/Monitor
Inserts	
PCI / PCIe slots	

Table 34: 5PC910.SX01-00 - Technical data

Product ID		5PC910.SX01-00
Quantity		1 PCI slot or 1 PCIe slot ⁴⁾
Slide-in drives		No
Compact slide-in drive		1
Interface option		2
Monitor/Panel option		No
Add-on UPS slot		Yes ⁵⁾
Insert for fan kit		Yes
Electrical characteristics		
Nominal voltage		24 VDC ±25%
Nominal current		5.5 A
Starting current		Max. 60 A for < 300 µs
Electrical isolation		Yes
Operating conditions		
EN 60529 protection		IP20 ⁶⁾
Environmental conditions		
Temperature		Component-dependent ⁷⁾
Operation		-20 to 60°C
Storage		-20 to 60°C
Transport		
Relative humidity		Component-dependent
Operation		Component-dependent
Storage		Component-dependent
Transport		
Vibration ⁸⁾		TBD
Operation (continuous)		TBD
Operation (occasional)		TBD
Storage		TBD
Transport		TBD
Shock ⁸⁾		TBD
Operation		TBD
Storage		TBD
Transport		TBD
Altitude		TBD ⁹⁾
Operation		
Mechanical characteristics		
Housing ¹⁰⁾		Galvanized plate, plastic
Material		Colored orange plastic (similar to Pantone 144CV)
Front cover		Anthracite gray
Paint		
Dimensions		
Width		91 mm
Height		270 mm
Depth		254.75 mm
Weight		2050 g

Table 34: 5PC910.SX01-00 - Technical data

- 1) At 50°C, 8.5 µA of the supplied components and a self-discharge of 40%.
- 2) Maintenance Controller Extended
- 3) Super-speed transfer rate (5 GBit/s) is only possible with USB 3.0.
- 4) The PCI and PCIe slots available depend on the bus unit being used (5AC901.BX01-00 or 5AC901.BX01-01).
- 5) This UPS module can only be operated in the IF option 1 slot.
- 6) Only if all interface covers and front cover are in place.
- 7) Detailed information can be found in the temperature tables in the user's manual.
- 8) Maximum values, as long as no other individual component specifies any other.
- 9) Derating the maximum ambient temperature - typically 1°C per 1000 meters (from 500 meters above sea level).
- 10) Depending on the process or batch, there may be visible deviations in the color and surface structure.

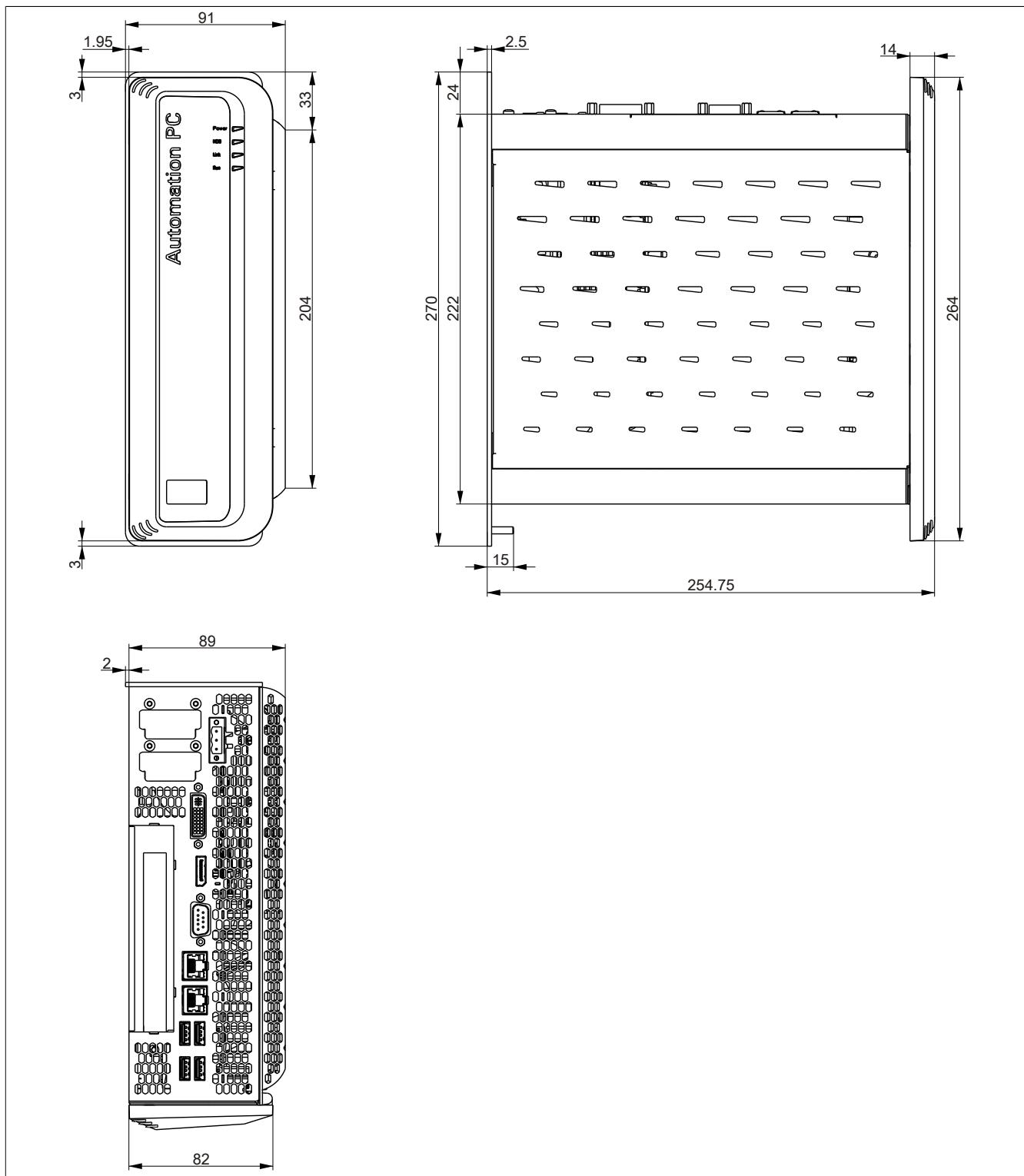
Dimensions

Figure 17: 5PC910.SX01-00 - Dimensions

Drilling template

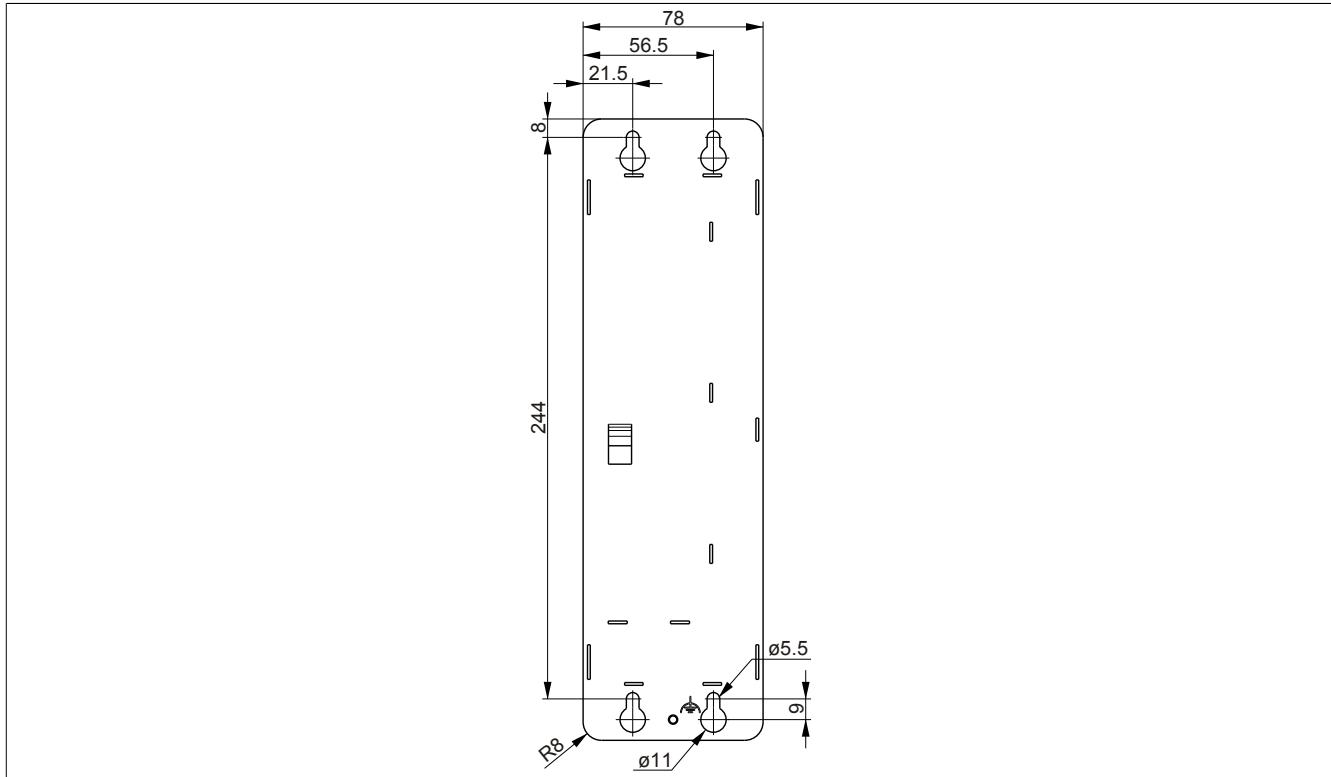


Figure 18: 5PC910.SX01-00 - Drilling template

3.1.2 5PC910.SX02-00

General information

- Slot for a bus unit with 2 PCI slots or 1 PCI and 1 PCIe slots
- Insert for 1 slide-in compact and 1 slide-in drive
- Insert for 2 interface options
- SDL/DVI/Monitor and DisplayPort interfaces
- Insert for Monitor/Panel option
- CFast slot

Order data

Model number	Short description	Figure	
System units			
5PC910.SX02-00	APC910 system unit, 2 slots (PCI Express / PCI, depending on bus), 1 slot for monitor/panel option, 1 slide-in compact and 1 slide-in slot; Smart Display Link/DVI/Monitor, DisplayPort, 1x RS232, 5x USB, 2x ETH 10/100/1000, 1 CFast slot, 24 VDC		
Required accessories			
Bus units			
5AC901.BX02-00	APC910 bus, 2 PCI		
5AC901.BX02-01	APC910 bus, 1 PCI, 1 PCI Express (x8)		
CPU boards			
5PC900.TS77-00	Intel Core i7 3615QE CPU board, 2.3 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-01	Intel Core i7 3612QE CPU board, 2.1 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-02	Intel Core i7 3555LE CPU board, 2.5 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)		
5PC900.TS77-03	Intel Core i7 3517UE CPU board, 1.7 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)		
5PC900.TS77-04	Intel Core i5 3610ME CPU board, 2.7 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)		
5PC900.TS77-05	Intel Core i3 3120ME CPU board, 2.4 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-06	Intel Core i3 3217UE CPU board, 1.6 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-07	Intel Celeron M 847E CPU board, 1.1 GHz, dual-core, 1 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-08	Intel Celeron M 827E CPU board, 1.4 GHz, single-core, 1.5 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
Heat sink			
5AC901.HS00-00	APC910 heat sink active		
5AC901.HS01-00	APC910 heat sink passive		
Main memory			
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB		
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB		
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB		
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB		
Terminal blocks			
0TB103.9	Connector, 24 VDC, 3-pin female, screw clamps 3.31 mm ² , protected against vibration by the screw flange		
0TB103.91	Connector, 24 VDC, 3-pin female, cage clamps 3.31 mm ² , protected against vibration by the screw flange		
Optional accessories			
Drives			
5AC901.CCFA-00	CFast adapter to operate a CFast card in a slide-in compact slot		
5AC901.CHDD-00	250 GB SATA hard disk, Slide-in compact, 24/7 hard disk		
5AC901.CSSD-00	32 GB SATA SSD (SLC), Slide-in compact		
5AC901.CSSD-01	60 GB SATA SSD (MLC), Slide-in compact		
5AC901.CSSD-02	180 GB SATA SSD (MLC), Slide-in compact		
5AC901.SDVW-00	DVD-R/RW DVD+R/RW SATA drive, Slide-in		
Fan kits			

Table 35: 5PC910.SX02-00 - Order data

Model number	Short description	Figure
5AC901.FA02-00	APC910 fan kit for system unit 5PC910.SX02-00	
	Interface options	
5AC901.I485-00	RS232/422/485 interface option; for APC910	
5AC901.ICAN-00	CAN interface option; for APC910	
5AC901.IHDA-00	Audio interface option, connection for 1x MIC, 1x Line IN, 1x Line OUT; for APC910	
5AC901.ISRM-00	SRAM interface option, 2 MB; for APC910	
	Monitor / Panel options	
5AC901.LDPO-00	DisplayPort transmitter	
5AC901.LSDL-00	Smart Display Link/DVI transmitter	

Table 35: 5PC910.SX02-00 - Order data

Technical data

Product ID	5PC910.SX02-00
General information	
Cooling	Passive via heat sink and optionally supported with an active fan kit
LEDs	Power, HDD, Link, Run
B&R ID code	\$D6DB
Battery	
Type	Renata 950 mAh
Lifespan	TBD ¹⁾
removable	Yes, accessible behind the orange front doors
Design	Lithium Ion
Power button	Yes
Reset button	Yes
Buzzer	Yes
Certification	
CE	Yes
Controller	
Boot loader	BIOS
Real-time clock	
Battery-buffered	Yes
Power failure logic	
Controller	MTCX ²⁾
Buffer time	10 ms
Graphics	
Controller	Depending on the CPU board used
Memory	
Type	SO-DIMM DDR3 SDRAM
Size	Max. 16 GB
Interfaces	
COM1	
Type	RS232, modem-capable, not electrically isolated
Design	9-pin DSUB plug
UART	16550-compatible, 16-byte FIFO
Max. baud rate	115 kbit/s
CFast slot	
Quantity	1
USB	
Quantity	5
Type	4x USB 3.0 (top) 1x USB 2.0 (front)
Design	Type A
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s), super speed (5 GBit/s) ³⁾
Current load	Max. 1 A per connection
Ethernet	
Quantity	2
Design	Shielded RJ45 port
Transfer rate	10/100/1000 Mbit/s
Max. baud rate	1 Gbit/s
DisplayPort	
Quantity	1
Version	1.1
Panel/Monitor interface	
Design	DVI-I socket
Type	SDL/DVI/Monitor
Inserts	
PCI / PCIe slots	
Quantity	2 PCI slots, or 1 PCI and 1 PCIe slot ⁴⁾
Slide-in drives	1
Compact slide-in drive	1
Interface option	2

Table 36: 5PC910.SX02-00 - Technical data

Product ID	5PC910.SX02-00
Monitor/Panel option	1
Add-on UPS slot	Yes ⁵⁾
Insert for fan kit	Yes
Electrical characteristics	
Nominal voltage	24 VDC ±25%
Nominal current	5.5 A
Starting current	Max. 60 A for < 300 µs
Electrical isolation	Yes
Operating conditions	
EN 60529 protection	IP20 ⁶⁾
Environmental conditions	
Temperature	
Operation	Component-dependent ⁷⁾
Storage	-20 to 60°C
Transport	-20 to 60°C
Relative humidity	
Operation	Component-dependent
Storage	Component-dependent
Transport	Component-dependent
Vibration ⁸⁾	
Operation (continuous)	TBD
Operation (occasional)	TBD
Storage	TBD
Transport	TBD
Shock ⁸⁾	
Operation	TBD
Storage	TBD
Transport	TBD
Altitude	
Operation	TBD ⁹⁾
Mechanical characteristics	
Housing ¹⁰⁾	
Material	Galvanized plate, plastic
Front cover	Colored orange plastic (similar to Pantone 144CV)
Paint	Anthracite gray
Dimensions	
Width	130 mm
Height	270 mm
Depth	254.75 mm
Weight	2550 g

Table 36: 5PC910.SX02-00 - Technical data

- 1) At 50°C, 8.5 µA of the supplied components and a self-discharge of 40%.
- 2) Maintenance Controller Extended
- 3) Super-speed transfer rate (5 GBit/s) is only possible with USB 3.0.
- 4) The PCI and PCIe slots available depend on the 5AC901.BX01-00 or 5AC901.BX01-01 bus unit being used.
- 5) This UPS module can only be operated in the IF option 1 slot.
- 6) Only if all interface covers and front cover are in place.
- 7) Detailed information can be found in the temperature tables in the user's manual.
- 8) Maximum values, as long as no other individual component specifies any other.
- 9) Derating the maximum ambient temperature - typically 1°C per 1000 meters (from 500 meters above sea level).
- 10) Depending on the process or batch, there may be visible deviations in the color and surface structure.

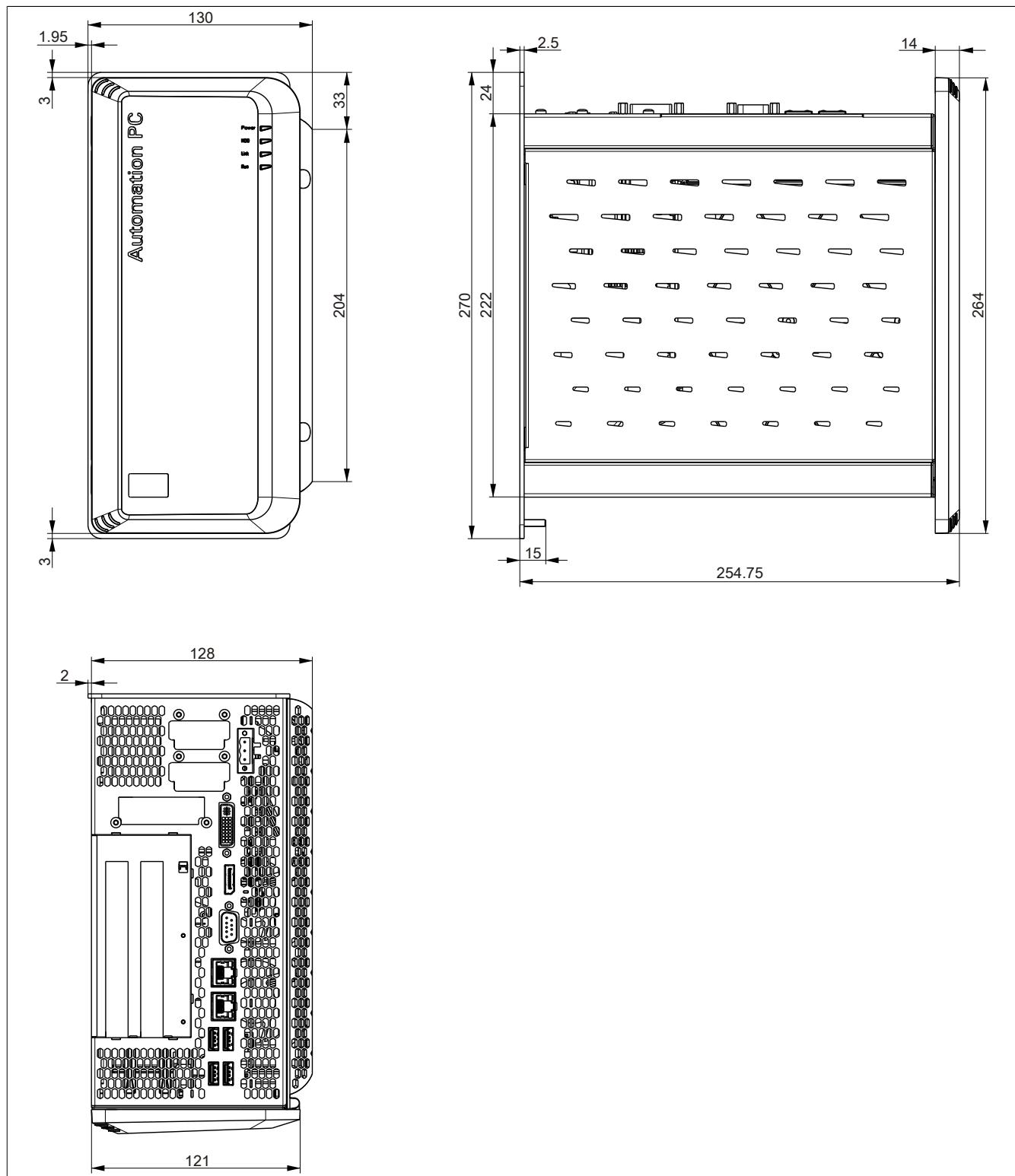
Dimensions

Figure 19: 5PC910.SX02-00 - Dimensions

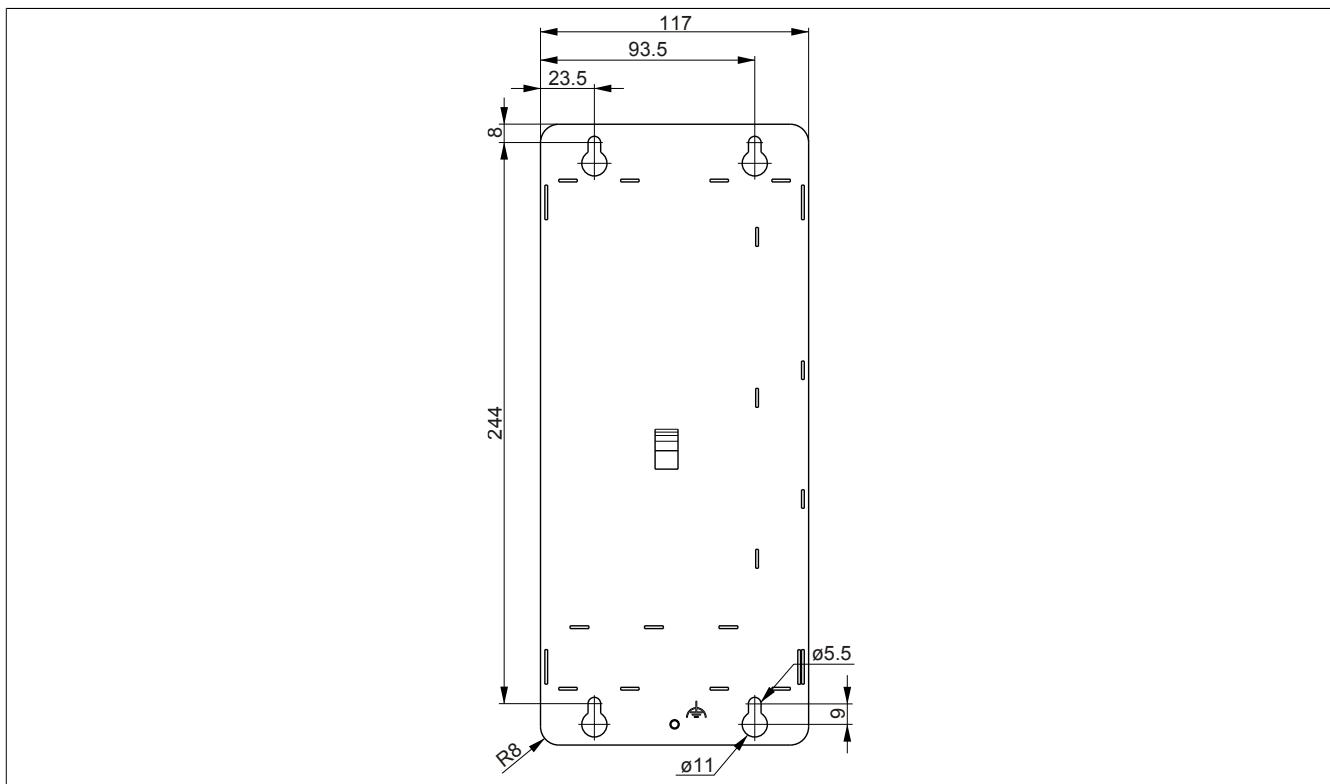
Drilling template

Figure 20: 5PC910.SX02-00 - Drilling template

3.2 QM77 CPU boards

3.2.1 5PC900.TS77-0x

General information

- Intel® Core™ i-series processors
- Intel® QM77 chipset
- 2x DDR3 memory socket
- Intel® HD Graphics 4000
- AMI BIOS (UEFI)

Information:

A fan kit is required when using the 5PC900.TS77-00 CPU board.

Order data

Model number	Short description	Figure
CPU boards		
5PC900.TS77-00	Intel Core i7 3615QE CPU board, 2.3 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-01	Intel Core i7 3612QE CPU board, 2.1 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-02	Intel Core i7 3555LE CPU board, 2.5 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-03	Intel Core i7 3517UE CPU board, 1.7 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-04	Intel Core i5 3610ME CPU board, 2.7 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-05	Intel Core i3 3120ME CPU board, 2.4 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-06	Intel Core i3 3217UE CPU board, 1.6 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
Required accessories		
Heat sink		
5AC901.HS00-00	APC910 heat sink active	
5AC901.HS01-00	APC910 heat sink passive	
Main memory		
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB	
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB	
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB	
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB	

Table 37: 5PC900.TS77-00, 5PC900.TS77-01, 5PC900.TS77-02, 5PC900.TS77-03, 5PC900.TS77-04, 5PC900.TS77-05, 5PC900.TS77-06 - Order data

Technical data

Product ID	5PC900. TS77-00	5PC900. TS77-01	5PC900. TS77-02	5PC900. TS77-03	5PC900. TS77-04	5PC900. TS77-05	5PC900. TS77-06
General information							
Certification CE	Yes						
Controller							
Boot loader	embedded AMI BIOS						
Processor							
Type	Intel® Core™ i7 3615QE	Intel® Core™ i7 3612QE	Intel® Core™ i7 3555LE	Intel® Core™ i7 3517UE	Intel® Core™ i5 3610ME	Intel® Core™ i3-3120ME	Intel® Core™ i3-3217UE
Clock frequency	2300 MHz	2100 MHz	2500 MHz	1700 MHz	2700 MHz	2400 MHz	1600 MHz
Number of cores	4	4	2	2	2	2	2
Architectures							
Intel® Smart Cache	6 MB	6 MB	4 MB	4 MB	3 MB	3 MB	3 MB

Table 38: 5PC900.TS77-00, 5PC900.TS77-01, 5PC900.TS77-02, 5PC900.TS77-03, 5PC900.TS77-04, 5PC900.TS77-05, 5PC900.TS77-06 - Technical data

Product ID	5PC900. TS77-00	5PC900. TS77-01	5PC900. TS77-02	5PC900. TS77-03	5PC900. TS77-04	5PC900. TS77-05	5PC900. TS77-06
External bus				DMI, 5 GT/s			
Intel® 64 Architecture				Yes			
Intel® Turbo Boost Technology	2.0		2.0		2.0		No
Intel® Hyper-Threading Technology				Yes			
Intel® Virtualization Technology (VT-x)				Yes			
Enhanced Intel SpeedStep® Tech- nology				Yes			
Chipset				Intel® QM77			
Real-time clock							
Precision				At 25°C: typ. 12 ppm (1 seconds) per day ¹⁾			
Battery-buffered				Yes			
Memory socket							
Number of memory channels				2			
Type				DDR3			
Size				Max. 16 GB			
Max. memory bandwidth				25.6 GB/s			
Graphics							
Controller				Intel® HD Graphics 4000			
Max. dynamic graphics frequency	1 GHz		1 GHz		1 GHz		950 MHz
Color depth				Max. 32-bit			
Resolution							
DVI				Resolution up to 1920 x 1200 (WUXGA)			
RGB				350 MHz RAMDAC, resolution up to 2048 x 1536 @ 75 Hz (QXGA)			
DisplayPort				Version 1.1			
Mass memory management				4x SATA			
Power management				ACPI 4.0 with battery support			

Table 38: 5PC900.TS77-00, 5PC900.TS77-01, 5PC900.TS77-02, 5PC900.TS77-03,
5PC900.TS77-04, 5PC900.TS77-05, 5PC900.TS77-06 - Technical data

1) At max. specified ambient temperature: typically 58 ppm (5 seconds) - worst-case 220 ppm (19 seconds).

3.3 HM76 CPU boards

3.3.1 5PC900.TS77-0x

General information

- Intel® Celeron® processors
- Intel® HM76 chipset
- 2x DDR3 memory socket
- Intel® HD Graphics 4000
- AMI BIOS (UEFI)

Order data

Model number	Short description	Figure	
CPU boards			
5PC900.TS77-07	Intel Celeron M 847E CPU board, 1.1 GHz, dual-core, 1 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
5PC900.TS77-08	Intel Celeron M 827E CPU board, 1.4 GHz, single-core, 1.5 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)		
Required accessories			
Heat sink			
5AC901.HS00-00	APC910 heat sink active		
5AC901.HS01-00	APC910 heat sink passive		
Main memory			
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB		
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB		
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB		
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB		

Table 39: 5PC900.TS77-07, 5PC900.TS77-08 - Order data

Technical data

Product ID	5PC900.TS77-07	5PC900.TS77-08	
General information			
Certification CE		Yes	
Controller			
Boot loader	embedded AMI BIOS		
Processor			
Type	Intel® Celeron® M 847E	Intel® Celeron® M 827E	
Clock frequency	1100 MHz	1400 MHz	
Number of cores	2	1	
Architectures	32 nm TBD Yes No No Yes Yes	1.5 MB TBD Yes No No Yes Yes	
Intel® Smart Cache			
External bus			
Intel® 64 Architecture			
Intel® Turbo Boost Technology			
Intel® Hyper-Threading Technology			
Intel® Virtualization Technology (VT-x)			
Enhanced Intel SpeedStep® Technology			
Chipset	Intel® HM76		
Real-time clock	At 25°C: typ. 12 ppm (1 seconds) per day ¹⁾ Yes		
Precision Battery-buffered			
Memory socket	Number of memory channels Type Size Max. memory bandwidth		
	2 DDR3 Max. 16 GB 21.3 GB/s		
Graphics	Controller Max. dynamic graphics frequency Color depth Resolution DVI		
	Intel® HD Graphics 3000 800 MHz Max. 32-bit Resolution up to 1920 x 1200 (WUXGA)		

Table 40: 5PC900.TS77-07, 5PC900.TS77-08 - Technical data

Product ID	5PC900.TS77-07	5PC900.TS77-08
RGB DisplayPort	350 MHz RAMDAC, resolution up to 2048 x 1536 @ 75 Hz (QXGA) Version 1.1	
Mass memory management	4x SATA	
Power management	ACPI 4.0 with battery support	

Table 40: 5PC900.TS77-07, 5PC900.TS77-08 - Technical data

- 1) At max. specified ambient temperature: typically 58 ppm (5 seconds) - worst-case 220 ppm (19 seconds).

3.4 Main memory

3.4.1 5MMDDR.xxxx-03

General information

These 204-pin DDR3 main memory modules operate at 1600 MHz and range in size from 1 GB to 8 GB.

If two RAM modules with the same size (e.g. 2 GB) are inserted into the CPU board, then dual-channel memory technology is supported. This technology is not supported if two RAM modules of different sizes (e.g. 2 GB and 4 GB) are inserted.

If two 2 GB modules or one 4 GB module is installed on a 32-bit operating system, only 3 GB of main memory can be used. On a 64-bit operating system, up to 16 GB of main memory can be used.

Order data

Model number	Short description	Figure
<u>Main memory</u>		
5MMDDR.1024-03	SO-DIMM DDR3, 1024 MB	
5MMDDR.2048-03	SO-DIMM DDR3, 2048 MB	
5MMDDR.4096-03	SO-DIMM DDR3, 4096 MB	
5MMDDR.8192-03	SO-DIMM DDR3, 8192 MB	

Table 41: 5MMDDR.1024-03, 5MMDDR.2048-03, 5MMDDR.4096-03, 5MMDDR.8192-03 - Order data

Technical data

Product ID	5MMDDR.1024-03	5MMDDR.2048-03	5MMDDR.4096-03	5MMDDR.8192-03
General information				
Type	SO-DIMM DDR3 SDRAM			
Memory size	1 GB	2 GB	4 GB	8 GB
Construction	204-pin			
Organization	128M x 64 bit	256M x 64-bit	512M x 64-bit	1024M x 64 bits
Speed	DDR3-1600 (PC3-12800)			
Certification				
CE	Yes			

Table 42: 5MMDDR.1024-03, 5MMDDR.2048-03, 5MMDDR.4096-03, 5MMDDR.8192-03 - Technical data

Information:

A main memory module can only be replaced at the B&R plant.

3.5 Bus units

3.5.1 5AC901.BX0x-0x

General information

These bus units are compatible with system units that support PCI and/or PCI Express.

Up to Revision A0, the PCI Express slots on the bus units 5AC901.BX01-01 and 5AC901.BX02-01 are equipped with the PCIe Standard x4.

Order data

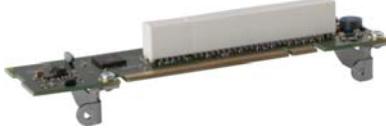
Model number	Short description	Figure
Bus units		
5AC901.BX01-00	APC910 bus, 1 PCI	
5AC901.BX01-01	APC910 bus, 1 PCI Express (x4)	
5AC901.BX02-00	APC910 bus, 2 PCI	
5AC901.BX02-01	APC910 bus, 1 PCI, 1 PCI Express (x8)	

Table 43: 5AC901.BX01-00, 5AC901.BX01-01, 5AC901.BX02-00, 5AC901.BX02-01 - Order data

Technical data

Product ID	5AC901.BX01-00	5AC901.BX01-01	5AC901.BX02-00	5AC901.BX02-01
Inserts				
PCIe slots				
Quantity	-	1	-	1
Design	-	PCIe half-size	-	PCIe half-size
Standard	-	1.0 a	-	1.0 a
Bus speed	-	x8 (2 GB/s)	-	x8 (2 GB/s)
PCI slots				
Quantity	1	-	2	1
Type	32-bit	-	32-bit	32-bit
Design	PCI half-size	-	PCI half-size	PCI half-size
Standard	2.2	-	2.2	2.2
Bus speed	33 MHz	-	33 MHz	33 MHz
PCIe to PCI bridge	Yes	-	Yes	Yes

Table 44: 5AC901.BX01-00, 5AC901.BX01-01, 5AC901.BX02-00, 5AC901.BX02-01 - Technical data

3.6 Heat sink

3.6.1 5AC901.HS0x-00

General information

The 5AC901.HS00-00 heat sink has cooling fins and heat pipes for improved heat dissipation. It is only used together with system units that have fan kits.

The 5AC901.HS01-00 heat sink has cooling fins and heat pipes for improved heat dissipation. It is only used together with system units that do not have fan kits.

Order data

Model number	Short description	Figure
	Heat sink	
5AC901.HS00-00	APC910 heat sink active	Image not found for 5AC901.HS00-00!
5AC901.HS01-00	APC910 heat sink passive	
	Required accessories	
	CPU boards	
5PC900.TS77-00	Intel Core i7 3615QE CPU board, 2.3 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-01	Intel Core i7 3612QE CPU board, 2.1 GHz, quad-core, 6 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-02	Intel Core i7 3555LE CPU board, 2.5 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-03	Intel Core i7 3517UE CPU board, 1.7 GHz, dual-core, 4 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-04	Intel Core i5 3610ME CPU board, 2.7 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (max. total memory 16 GB)	
5PC900.TS77-05	Intel Core i3 3120ME CPU board, 2.4 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-06	Intel Core i3 3217UE CPU board, 1.6 GHz, dual-core, 3 MB L2 cache; QM77 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-07	Intel Celeron M 847E CPU board, 1.1 GHz, dual-core, 1 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	
5PC900.TS77-08	Intel Celeron M 827E CPU board, 1.4 GHz, single-core, 1.5 MB L2 cache; HM76 chipset; 2 sockets for SO-DIMM DDR3 modules (total memory max. 16 GB)	

Table 45: 5AC901.HS00-00, 5AC901.HS01-00 - Order data

3.7 Fan kit

Information:

The fan kits are subject to wear and must be checked with appropriate frequency and cleaned or replaced when not functioning properly (e.g. due to dirt and grime). For information about replacing fan filters, please refer to the section "Fan filter replacement" on page 151.

Information:

For information about replacing or exchanging the fan kit, please refer to the section "Fan kit replacement" on page 152.

3.7.1 5AC901.FA01-00

General information

The fan kit includes 3 fans that are installed in order to improve heat dissipation on APC910 1-slot system units.

- 3 fans for improved heat dissipation
- Simply mounting and removal

Order data

Model number	Short description	Figure
	Fan kits	
5AC901.FA01-00	APC910 fan kit for system unit 5PC910.SX01-00	
	Optional accessories	
	Accessories	
5AC901.FI01-00	Fan filter for APC910 5 pcs. (spare part), for 5AC901.FA01-00	

Table 46: 5AC901.FA01-00 - Order data

Technical data

Product ID	5AC901.FA01-00
General information	
Number of fans	3 (1x 50x50x15, 2x 70x70x15)
Speed	Max. 5000 ±10% rpm (50x50x15) Max. 2200 ±250 rpm (70x70x15)
Noise level	33.5 dB(A) (50x50x15) 28.3 dB(A) (70x70x15)
Lifespan	100,000 hours at 40°C (50x50x15) 100,000 hours at 40°C (70x70x15)
Mechanical characteristics	
Dimensions	
Fan	
Width	50 mm 70 mm
Height	50 mm 70 mm
Depth	15 mm 15 mm

Table 47: 5AC901.FA01-00 - Technical data

3.7.2 5AC901.FA02-00

General information

The fan kit includes 4 fans that are installed in order to improve heat dissipation on APC910 2-slot system units.

- 4 fans for improved heat dissipation
- Simply mounting and removal

Order data

Model number	Short description	Figure
	Fan kits	
5AC901.FA02-00	APC910 fan kit for system unit 5PC910.SX02-00	
	Optional accessories	
	Accessories	
5AC901.FI02-00	Fan filter for APC910 5 pcs. (spare part), for 5AC901.FA02-00	

Table 48: 5AC901.FA02-00 - Order data

Technical data

Product ID	5AC901.FA02-00
General information	
Number of fans	4 (3x 50x50x15, 1x 70x70x15)
Speed	Max. 5000 ±10% rpm (50x50x15) Max. 2200 ±250 rpm (70x70x15)
Noise level	33.5 dB(A) (50x50x15) 28.3 dB(A) (70x70x15)
Lifespan	100,000 hours at 40°C (50x50x15) 100,000 hours at 40°C (70x70x15)
Mechanical characteristics	
Dimensions	
Fan	
Width	50 mm 70 mm
Height	50 mm 70 mm
Depth	15 mm 15 mm

Table 49: 5AC901.FA02-00 - Technical data

3.8 Drives

3.8.1 5AC901.CHDD-00

General information

This 250 GB slide-in compact hard disk is specified for 24-hour operation and can be used in APC910 system units.

- 250 GB hard disk
- Slide-in compact
- Specified for 24-hour operation
- S.M.A.R.T. support

Order data

Model number	Short description	Figure
Drives		
5AC901.CHDD-00	250 GB SATA hard disk, Slide-in compact, 24/7 hard disk	

Table 50: 5AC901.CHDD-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.CHDD-00
General information	
Certification	
CE	Yes
Hard disk drive	
Capacity	250 GB
Number of heads	2
Number of sectors	488,397,168
Bytes per sector	512
Cache	8 MB
Speed	5400 rpm ±0.2%
Startup time	Typ. 3.6 s (from 0 rpm to read access)
MTBF	550,000 POH ¹⁾
S.M.A.R.T. Support	Yes
Interface	SATA
Access time	5.6 ms
Supported transfer modes	SATA 1.0, Serial ATA Revision 2.6 PIO mode 0-4, multiword DMA mode 0-2, UDMA mode 0-6
Data transfer rate	
Internal	Max. 1175 Mbit/s
To/from host	Max. 150 MB/s (SATA I), max. 300 MB/s (SATA II)
Positioning time	
Minimum (track to track)	1 ms
Nominal (read only)	14 ms
Maximum (read only)	30 ms
Environmental conditions	
Temperature ²⁾	
Operation ³⁾	0 to 60°C
Operation - 24-hour ⁴⁾	0 to 60°C
Storage	-40 to 70°C
Transport	-40 to 70°C
Relative humidity ⁵⁾	
Operation	5 to 95%, non-condensing
Storage	5 to 95%, non-condensing
Transport	5 to 95%, non-condensing
Vibration	
Operation (continuous)	5 to 500 Hz: 0.25 g; no unrecoverable errors
Operation (occasional)	5 to 500 Hz: 0.5 g; no unrecoverable errors
Storage	10 to 500 Hz: 5 g; no unrecoverable errors

Table 51: 5AC901.CHDD-00 - Technical data

Product ID	5AC901.CHDD-00
Transport	10 to 500 Hz: 5 g; no unrecoverable errors
Shock	
Operation	350 g and 2 ms duration; no unrecoverable errors
Storage	800 g and 2 ms duration; no unrecoverable errors 800 g and 1 ms duration; no unrecoverable errors 600 g and 0.5 ms duration; no unrecoverable errors
Transport	800 g and 2 ms duration; no unrecoverable errors 800 g and 1 ms duration; no unrecoverable errors 600 g and 0.5 ms duration; no unrecoverable errors
Altitude	
Operation	-300 to 3048 m
Storage	-300 to 12192 m
Mechanical characteristics	
Installation	Fixed ⁶⁾
Dimensions	
Width	13 mm
Height	98 mm
Depth	105 mm
Weight	134 g
Manufacturer information	
Manufacturer	Seagate
Manufacturer's product ID	ST9250311CS

Table 51: 5AC901.CHDD-00 - Technical data

- 1) With 8760 POH (power on hours) per year and 25°C surface temperature.
- 2) Temperature values for 305 meter altitude. The temperature specification must be reduced linearly by 1 °C every 305 meters. The temperature increase and decrease can be a maximum of 20 °C per hour.
- 3) Standard operation means 333 POH (power-on hours) per month.
- 4) 24-hour operation means 732 POH (power-on hours) per month.
- 5) Humidity gradient: Maximum 30% per hour.
- 6) Slide-in compact mounting

Temperature humidity diagram

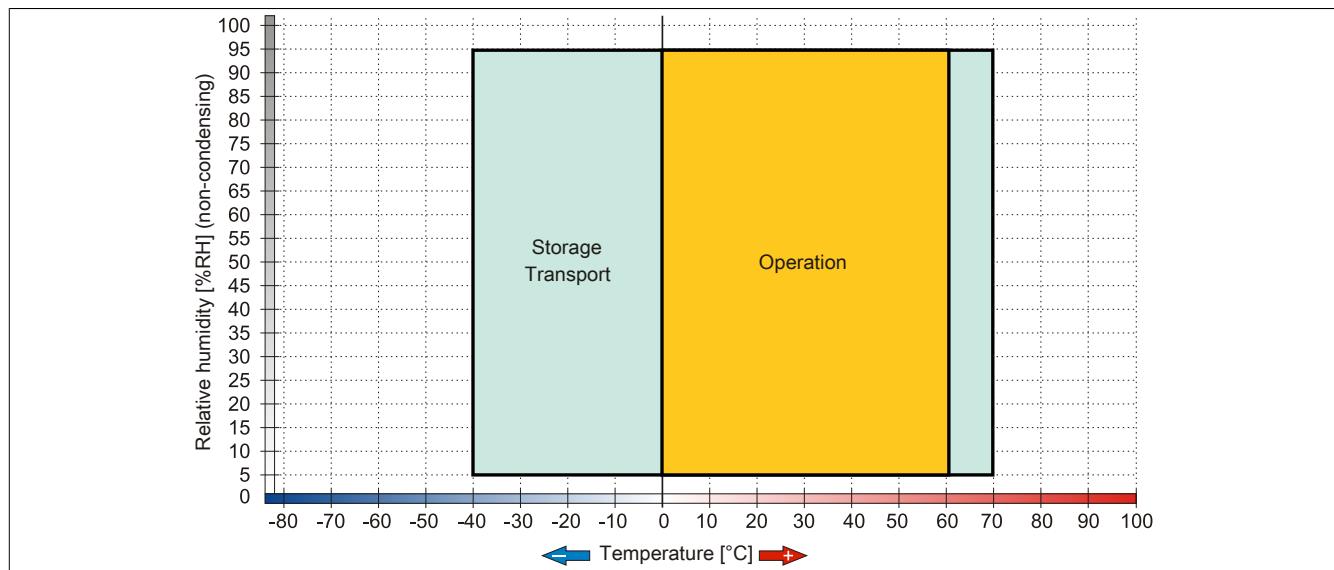


Figure 21: 5AC901.CHDD-00 - Temperature humidity diagram

3.8.2 5AC901.CSSD-00

General information

This 32 GB slide-in compact SSD (Solid State Drive) is based on Single Level Cell (SLC) technology and is SATA 2.6 compatible. The slide-in compact drive can be used in APC910 system units.

- 32 GB solid state drive
- SLC Flash
- S.M.A.R.T. Support
- Slide-in compact
- SATA 2.6 compatible

Order data

Model number	Short description	Figure
Drives		Image not found for 5AC901.CSSD-00!
5AC901.CSSD-00	32 GB SATA SSD (SLC), Slide-in compact	

Table 52: 5AC901.CSSD-00 - Order data

Technical data

Caution!

A sudden loss of power can cause data to be lost! In very rare cases, the mass memory may also become damaged.

To prevent damage and loss of data, it is recommended to use a UPS device.

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.CSSD-00
General information	
Certification CE	Yes
Solid state drive	
Capacity	32 GB
Data reliability	< 1 unrecoverable errors in 10 ¹⁶ bit read accesses
MTBF	2,000,000 hours
Power on/off cycles	50000
S.M.A.R.T. Support	Yes
Interface	SATA
Maintenance	None
Continuous reading	Max. 250 MB/s
Continuous writing	Max. 195 MB/s
IOPS ¹⁾	
4k read	45,000
4k write	5,500
Endurance	
Guaranteed data volume Guaranteed Results for 5 years	700 TB 350 GB/day
SLC Flash	Yes
Wear leveling	Static
Error Correction Coding (ECC)	Yes
Compatibility	SATA revision 2.6 compliant, compatible with SATA 1.5 Gbit/s and 3 Gbit/s interface rates ATA/ATAPI-7 SSD Enhanced SMART ATA feature set Native Command Queuing (NCQ) command
Environmental conditions	
Temperature Operation Storage Transport	0 to 70°C -55 to 95°C -55 to 95°C
Relative humidity	

Table 53: 5AC901.CSSD-00 - Technical data

Product ID	5AC901.CSSD-00
Operation	5 to 95%
Storage	5 to 95%
Transport	5 to 95%
Vibration	
Operation	5 to 700 Hz: 2.17 g
Storage	5 to 800 Hz: 3.13 g
Transport	5 to 800 Hz: 3.13 g
Shock	
Operation	1500 g, 0.5 ms
Storage	1500 g, 0.5 ms
Transport	1500 g, 0.5 ms
Altitude	
Operation	-300 to 12,192 m
Storage	-300 to 12,192 m
Transport	-300 to 12,192 m
Mechanical characteristics	
Installation	Fixed ²⁾
Dimensions	
Width	13 mm
Height	98 mm
Depth	105 mm
Weight	118 g
Manufacturer information	
Manufacturer	Intel
Manufacturer's product ID	SSDSA2SH032G201

Table 53: 5AC901.CSSD-00 - Technical data

1) IOPS: Random read and write input/output operations per second

2) Slide-in compact mounting

Temperature humidity diagram

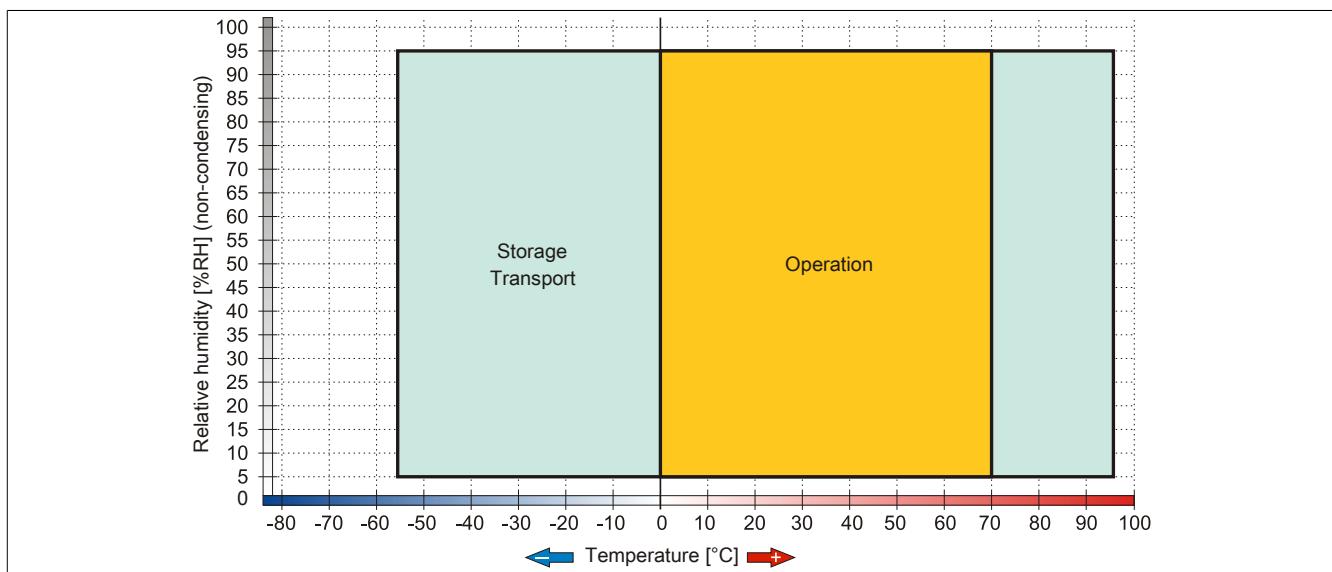


Figure 22: 5AC901.CSSD-00 - Temperature humidity diagram

3.8.3 5AC901.CSSD-01

General information

This 60 GB slide-in compact SSD (Solid State Drive) is based on Multi Level Cell (MLC) technology and is SATA 3.0 compatible. The slide-in compact drive can be used in APC910 system units.

- 60 GB solid state drive
- MLC flash
- S.M.A.R.T. Support
- Slide-in compact
- SATA 3.0 compatible

Order data

Model number	Short description	Figure
Drives		
5AC901.CSSD-01	60 GB SATA SSD (MLC), Slide-in compact	Image not found for 5AC901.CSSD-01!

Table 54: 5AC901.CSSD-01 - Order data

Technical data

Caution!

A sudden loss of power can cause data to be lost! In very rare cases, the mass memory may also become damaged.

To prevent damage and loss of data, it is recommended to use a UPS device.

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.CSSD-01
General information	
Certification CE	Yes
Solid state drive	
Capacity	60 GB
Data reliability	< 1 unrecoverable errors in 10 ¹⁶ bit read accesses
MTBF	1,200,000 hours
S.M.A.R.T. Support	Yes
Interface	SATA
Maintenance	None
Continuous reading	Max. 550 MB/s with SATA 6 Gbit/s Max. 280 MB/s with SATA 3 Gbit/s
Continuous writing	Max. 475 MB/s with SATA 6 Gbit/s Max. 245 MB/s with SATA 3 Gbit/s
IOPS ¹⁾	
4k read	15000
4k write	
Typical	23000
Maximum	80000
Endurance	
MLC flash	Yes
Compatibility	SATA Revision 3.0 compliant ACS-2 SSD Enhanced SMART ATA feature set Native Command Queuing (NCQ) command
Environmental conditions	
Temperature	
Operation	0 to 70°C
Storage	-55 to 95°C
Transport	-55 to 95°C
Relative humidity	
Operation	5 to 95%
Storage	5 to 95%
Transport	5 to 95%

Table 55: 5AC901.CSSD-01 - Technical data

Product ID	5AC901.CSSD-01
Vibration	
Operation	5 to 700 Hz: 2.17 g
Storage	5 to 800 Hz: 3.13 g
Transport	5 to 800 Hz: 3.13 g
Shock	
Operation	1500 g, 0.5 ms
Storage	1500 g, 0.5 ms
Transport	1500 g, 0.5 ms
Altitude	
Operation	-300 to 12,192 m
Storage	-300 to 12,192 m
Transport	-300 to 12,192 m
Mechanical characteristics	
Installation	Fixed ²⁾
Dimensions	
Width	13 mm
Height	98 mm
Depth	105 mm
Weight	118 g
Manufacturer information	
Manufacturer	Intel
Manufacturer's product ID	SSDSC2CW060A3

Table 55: 5AC901.CSSD-01 - Technical data

- 1) IOPS: Random read and write input/output operations per second
 2) Slide-in compact mounting

Temperature humidity diagram

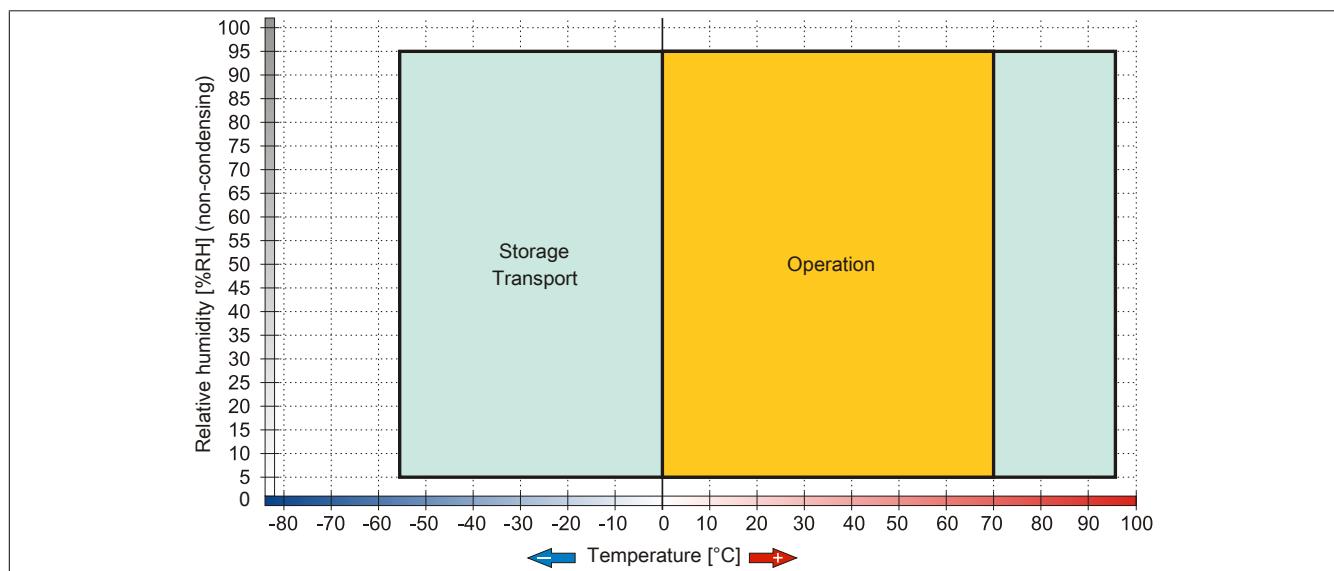


Figure 23: 5AC901.CSSD-01 - Temperature humidity diagram

3.8.4 5AC901.CSSD-02

General information

This 180 GB slide-in compact SSD (Solid State Drive) is based on Multi Level Cell (MLC) technology and is SATA 3.0 compatible. The slide-in compact drive can be used in APC910 system units.

- 180 GB solid state drive
- MLC flash
- S.M.A.R.T. Support
- Slide-in compact
- SATA 3.0 compatible

Order data

Model number	Short description	Figure
5AC901.CSSD-02	180 GB SATA SSD (MLC), Slide-in compact	Image not found for 5AC901.CSSD-02!

Table 56: 5AC901.CSSD-02 - Order data

Technical data

Caution!

A sudden loss of power can cause data to be lost! In very rare cases, the mass memory may also become damaged.

To prevent damage and loss of data, it is recommended to use a UPS device.

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.CSSD-02
General information	
Certification CE	Yes
Solid state drive	
Capacity	180 GB
Data reliability	< 1 unrecoverable errors in 10 ¹⁶ bit read accesses
MTBF	1,200,000 hours
S.M.A.R.T. Support	Yes
Interface	SATA
Maintenance	None
Continuous reading	Max. 550 MB/s with SATA 6 Gbit/s Max. 280 MB/s with SATA 3 Gbit/s
Continuous writing	Max. 520 MB/s with SATA 6 Gbit/s Max. 260 MB/s with SATA 3 Gbit/s
IOPS ¹⁾	
4k read	50000
4k write	
Typical	60000
Maximum	80000
Endurance	
MLC flash	Yes
Compatibility	SATA Revision 3.0 compliant ACS-2 SSD Enhanced SMART ATA feature set Native Command Queuing (NCQ) command
Environmental conditions	
Temperature	
Operation	0 to 70°C
Storage	-55 to 95°C
Transport	-55 to 95°C
Relative humidity	
Operation	5 to 95%
Storage	5 to 95%
Transport	5 to 95%

Table 57: 5AC901.CSSD-02 - Technical data

Product ID	5AC901.CSSD-02
Vibration	
Operation	5 to 700 Hz: 2.17 g
Storage	5 to 800 Hz: 3.13 g
Transport	5 to 800 Hz: 3.13 g
Shock	
Operation	1500 g, 0.5 ms
Storage	1500 g, 0.5 ms
Transport	1500 g, 0.5 ms
Altitude	
Operation	-300 to 12,192 m
Storage	-300 to 12,192 m
Transport	-300 to 12,192 m
Mechanical characteristics	
Installation	Fixed ²⁾
Dimensions	
Width	13 mm
Height	98 mm
Depth	105 mm
Weight	118 g
Manufacturer information	
Manufacturer	Intel
Manufacturer's product ID	SSDSC2CW180A3

Table 57: 5AC901.CSSD-02 - Technical data

- 1) IOPS: Random read and write input/output operations per second
 2) Slide-in compact mounting

Temperature humidity diagram

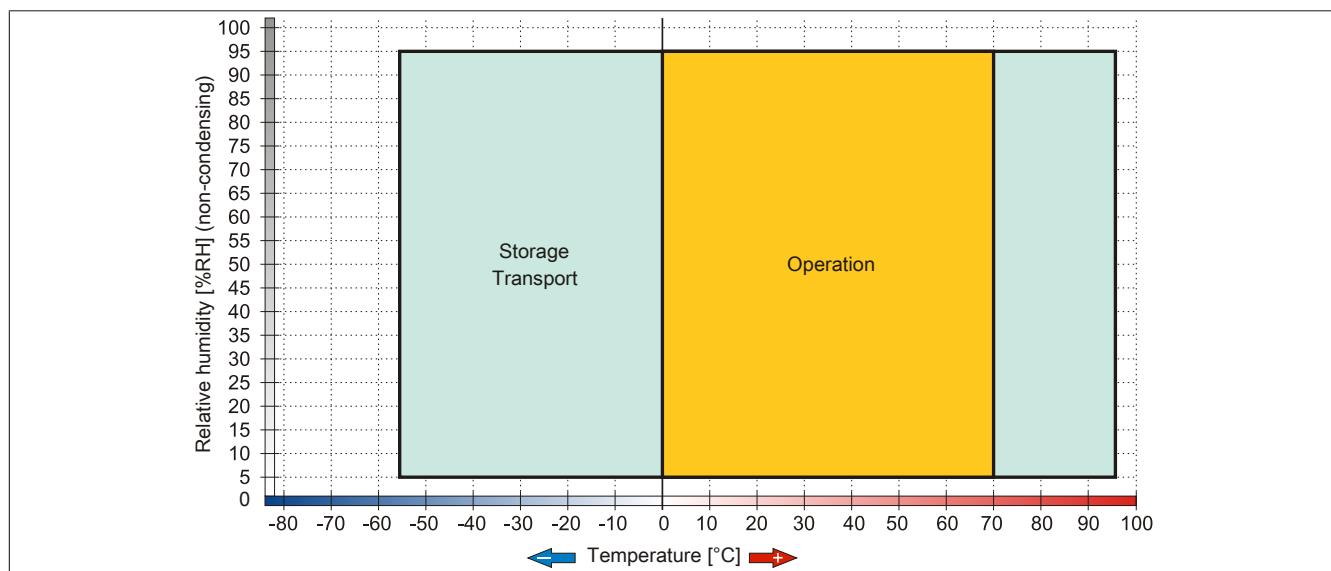


Figure 24: 5AC901.CSSD-02 - Temperature humidity diagram

3.8.5 5AC901.CCFA-00

General information

The CFast adapter is a slide-in compact adapter where a CFast card can be installed and then operated on the B&R industrial PC. The CFast adapter can be used in APC910 system units.

- CFast slot
- Slide-in compact

Order data

Model number	Short description	Figure
Drives		Image not found for 5AC901.CCFA-00!
5AC901.CCFA-00	CFast adapter to operate a CFast card in a slide-in compact slot	

Table 58: 5AC901.CCFA-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.CCFA-00
General information	
Certification CE	Yes
Interfaces	
CFast slot Quantity	1
Environmental conditions	
Temperature Operation	TBD
Storage	TBD
Transport	TBD
Relative humidity Operation	5 to 90%
Storage	5 to 95%
Transport	5 to 95%

Table 59: 5AC901.CCFA-00 - Technical data

3.9 Interface options

Information:

For information about replacing or exchanging an interface option, please refer to the section "Installation - Interface option" on page 139.

3.9.1 5AC901.I485-00

General information

The 5AC901.I485-00 interface option is equipped with an RS232/422/485 interface. The operating mode (RS232/RS422/RS485) is selected automatically, depending on the electrical connection.

- 1x RS232/422/485 interface
- Compatible with the APC910

Order data

Model number	Short description	Figure
Interface options		Image not found for 5AC901.I485-00!
5AC901.I485-00	RS232/422/485 interface option; for APC910	

Table 60: 5AC901.I485-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.I485-00
General information	
B&R ID code	\$D84A
Certification CE	Yes
Interfaces	
COM1 Type Design UART Max. baud rate	RS232/422/485, electrically isolated 9-pin DSUB plug 16550-compatible, 16-byte FIFO 115 kbit/s
Electrical characteristics	
Power consumption	1 W
Environmental conditions	
Temperature Operation Storage Transport	0 to 55°C ¹⁾ -20 to 60°C -20 to 60°C
Relative humidity Operation Storage Transport	5 to 90% 5 to 95% 5 to 95%

Table 61: 5AC901.I485-00 - Technical data

1) Detailed information can be found in the temperature tables in the user's manual.

Serial interface COM

Serial interface (COM)		
	RS232	RS422/485
Type	RS232; not modem capable; electrically isolated	
UART	16550-compatible, 16-byte FIFO	
Transfer rate	Max. 115 kbit/s	
Bus length	Max. 15 m	Max. 1200 m
Pin	RS232 pinout	RS422 pinout
1	n.c.	TXD\
2	RXD	n.c.
3	TXD	n.c.
4	n.c.	TXD
5	GND	GND
6	n.c.	RXD\
7	RTS	n.c.
8	CTS	n.c.
9	n.c.	RXD

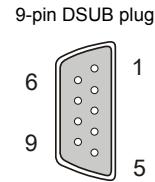


Table 62: Pinout - COM

Bus length and cable type RS232

The maximum transfer rate of 115 kbit/s depends on the cable type being used.

Extension	Transfer rate
≤ 15 m	Typ. 64 kbit/s
≤ 10 m	Typ. 115 kbit/s
≤ 5 m	Typ. 115 kbit/s

Table 63: RS232 - Bus length and transfer rate

The material used for the cable should preferably have all or most of the following properties in order to reach an optimal transfer rate.

RS232 cable	Property
Signal lines	
Cable cross section	4x 0.16 mm ² (26AWG), tinned Cu wire
Wire insulation	PE
Conductor resistance	≤ 82 Ω/km
Stranding	Wires stranded in pairs
Shield	Paired shield with aluminum foil
Grounding line	
Cable cross section	1x 0.34 mm ² (22AWG/19), tinned Cu wire
Wire insulation	PE
Conductor resistance	≤ 59 Ω/km
Outer sheathing	
Material	PUR mixture
Features	Halogen free
Cable shielding	From tinned cu wires

Table 64: RS232 - Cable requirements

RS422 - Bus length and cable type

The RTS line must be switched on to activate the sender.

The maximum transfer rate of 115 kbit/s depends on the cable type being used.

Extension	Transfer rate
1200 m	Typ. 115 kbit/s

Table 65: RS422 - Bus length and transfer rate

The material used for the cable should preferably have all or most of the following properties in order to reach an optimal transfer rate.

RS422 cable	Property
Signal lines	
Cable cross section	4x 0.25 mm ² (24AWG/19), tinned Cu wire
Wire insulation	PE
Conductor resistance	≤ 82 Ω/km
Stranding	Wires stranded in pairs
Shield	Paired shield with aluminum foil

Table 66: RS422 - Cable requirements

RS422 cable	Property
Grounding line	
Cable cross section Wire insulation Conductor resistance	1x 0.34 mm ² (22AWG/19), tinned Cu wire PE ≤59 Ω/km
Outer sheathing	
Material Features Cable shielding	PUR mixture Halogen free From tinned cu wires

Table 66: RS422 - Cable requirements

When used as an RS485 interface

The pins of the RS422 default interface (1, 4, 6 and 9) should be used for operation. The pins should be connected as shown.

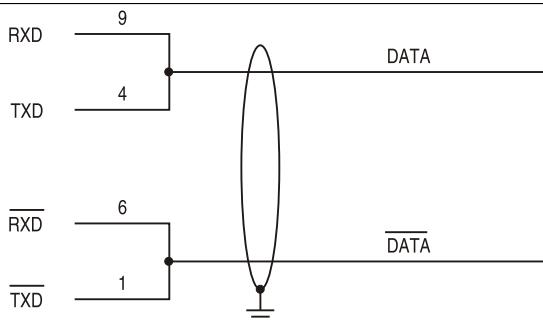


Figure 25: RS232/422/485 interface - operated in RS485 mode

The RTS line must be switched each time the driver is sent and received; there is no automatic switch back. This cannot be configured in Windows.

The voltage drop caused by long line lengths can lead to greater potential differences between the bus stations, which can hinder communication. This can be improved by running ground wire with the others.

RS485 - Bus length and cable type

The maximum transfer rate of 115 kbit/s depends on the cable type being used.

Extension	Transfer rate
1200 m	Typ. 115 kbit/s

Table 67: RS485 - Bus length and transfer rate

The material used for the cable should preferably have all or most of the following properties in order to reach an optimal transfer rate.

RS485 cable	Property
Signal lines	
Cable cross section Wire insulation Conductor resistance Stranding Shield	4x 0.25 mm ² (24AWG/19), tinned Cu wire PE ≤82 Ω/km Wires stranded in pairs Paired shield with aluminum foil
Grounding line	
Cable cross section Wire insulation Conductor cross section	1x 0.34 mm ² (22AWG/19), tinned Cu wire PE ≤59 Ω/km
Outer sheathing	
Material Features Cable shielding	PUR mixture Halogen free From tinned cu wires

Table 68: RS485 - Cable requirements

Terminating resistor

A terminating resistor for the serial interface is already integrated on the IF option. A switch is provided to enable or disable the terminating resistor. However, the side cover must be removed from the system unit in order to do this (see Installation - Interface option, steps 1 to 4). An active terminating resistor is indicated by a yellow LED.

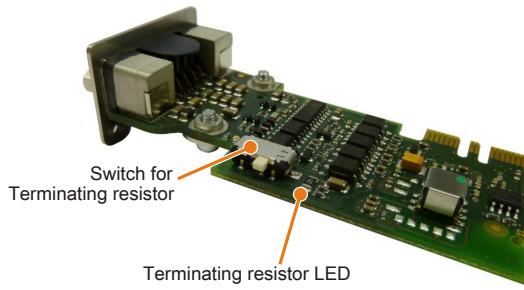


Figure 26: 5AC901.I485-00 - Terminating resistor

3.9.2 5AC901.ICAN-00

General information

The 5AC901.ICAN-00 interface option is equipped with a CAN Master interface.

- 1x CAN master interface
- Compatible with the APC910

It is not possible to run two 5AC901.ICAN interface options (connected to both the IF Option 1 and IF Option 2 slots).

Order data

Model number	Short description	Figure
	Interface options	
5AC901.ICAN-00	CAN interface option; for APC910	

Table 69: 5AC901.ICAN-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.ICAN-00
General information	
B&R ID code	\$D84B
Certification CE	Yes
Interfaces	
CAN Quantity Design Transfer rate	1 9-pin DSUB plug Max. 500 kbit/s
Electrical characteristics	
Power consumption	TBD
Environmental conditions	
Temperature Operation Storage Transport	0 to 55°C ¹⁾ -20 to 60°C -20 to 60°C
Relative humidity Operation Storage Transport	5 to 90% 5 to 95% 5 to 95%

Table 70: 5AC901.ICAN-00 - Technical data

1) Detailed information can be found in the temperature tables in the user's manual.

CAN interface

CAN bus	
Type	Electrically isolated
Transfer rate	Max. 500 kbit/s
Bus length	Max. 1000 meters
Pin	Assignment
1	n.c.
2	CAN low
3	GND
4	n.c.
5	n.c.
6	Reserved
7	CAN high
8	n.c.
9	n.c.

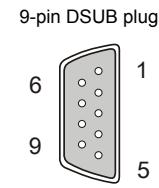


Table 71: 5AC901.ICAN-00 - CAN pinout

Terminating resistor

A terminating resistor for the CAN interface is already integrated on the IF option. A switch is provided to enable or disable the terminating resistor. However, the side cover must be removed from the system unit in order to do this (see Installation - Interface option, steps 1 to 4). An active terminating resistor is indicated by a yellow LED.

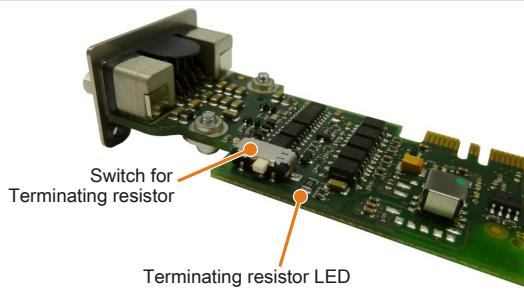


Figure 27: 5AC901.ICAN-00 - Terminating resistor

3.9.3 5AC901.IHDA-00

General information

The 5AC901.IHDA-00 interface option has an HDA sound chip with externally accessible MIC, Line IN and Line OUT channels.

- 1x MIC
- 1x Line IN
- 1x Line OUT
- Compatible with the APC910

The interface option 5AC901.IHDA-00 can only be operated in the IF option 1 slot.

Order data

Model number	Short description	Figure
Interface options		
5AC901.IHDA-00	Audio interface option, connection for 1x MIC, 1x Line IN, 1x Line OUT; for APC910	

Table 72: 5AC901.IHDA-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.IHDA-00
General information	
B&R ID code	\$D84E
Certification CE	Yes
Interfaces	
Audio Type Controller Inputs Outputs	HDA sound Realtek ALC 662 Microphone, Line in Line OUT
Electrical characteristics	
Power consumption	0.4 W
Environmental conditions	
Temperature Operation Storage Transport	0 to 55°C ¹⁾ -20 to 60°C -20 to 60°C
Relative humidity Operation Storage Transport	5 to 90% 5 to 95% 5 to 95%

Table 73: 5AC901.IHDA-00 - Technical data

1) Detailed information can be found in the temperature tables in the user's manual.

MIC, Line IN, Line OUT

MIC, Line IN, Line OUT	
Controller	Realtek ALC 662
MIC	Connection of a mono microphone with a 3.5mm jack.
Line IN	Stereo Line IN signal supplied via a 3.5mm jack.
Line OUT	Connection of a stereo sound device (e.g. amplifier) via a 3.5 mm jack.

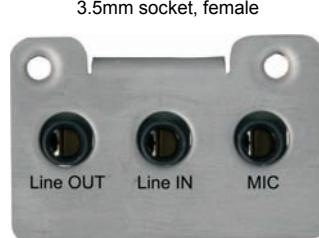


Table 74: MIC, Line IN, Line OUT

A special driver is required in order to operate the audio controller. Drivers for approved operating systems are available in the Downloads area of the B&R website (www.br-automation.com).

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

3.9.4 5AC901.ISRM-00

General information

The 5AC901.ISRM-00 interface option has 2 MB SRAM.

- 2 MB SRAM
- Compatible with the APC910

The SRAM interface option 5AC901.ISRM-00 can only be operated in the IF option 2 slot.

Information:

When writing, reading or accessing the SRAM, "not-aligned-accesses" are not supported by the AVLON- bus (internal bus in the PCI Express core).

Order data

Model number	Short description	Figure
5AC901.ISRM-00	Interface options	Image not found for 5AC901.ISRM-00!
5AC901.ISRM-00	SRAM interface option, 2 MB; for APC910	

Table 75: 5AC901.ISRM-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.ISRM-00
General information	
Connection to system	Via PCI Express bus
B&R ID code	\$D850
Certification CE	Yes
Controller	
SRAM	
Size	2 MB
Battery-buffered	Yes
Remanent variables in power fail mode	512 kB (e.g. for Automation Runtime, see AS help documentation)
Electrical characteristics	
Power consumption	TBD
Environmental conditions	
Temperature	
Operation	TBD ¹⁾
Storage	-20 to 60°C
Transport	-20 to 60°C
Relative humidity	
Operation	5 to 90%
Storage	5 to 95%
Transport	5 to 95%

Table 76: 5AC901.ISRM-00 - Technical data

1) Detailed information can be found in the temperature tables in the user's manual.

3.10 Monitor / panel options

Information:

Monitor / panel options can only be connected to system units with 2 PCI / PCIe slots.

Information:

For information about replacing or exchanging an monitor / panel option, please refer to the section "Installation - Monitor / panel option" on page 143.

3.10.1 5AC901.LDPO-00

General information

The 5AC901.LDPO-00 monitor/panel option is equipped with a DisplayPort 1.1 and USB 2.0 interface.

- DisplayPort interface
- USB 2.0 port

Order data

Model number	Short description	Figure
Monitor / Panel options		
5AC901.LDPO-00	DisplayPort transmitter	

Table 77: 5AC901.LDPO-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.LDPO-00
General information	
B&R ID code	\$D852
Certification	
CE	Yes
Interfaces	
USB	
Quantity	1
Type	USB 2.0
Design	Type A
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s)
Current load	Max. 1 A
DisplayPort	
Quantity	1
Version	1.1
Electrical characteristics	
Power consumption	3 W
Environmental conditions	
Temperature	
Operation	TBD ¹⁾
Storage	TBD
Transport	TBD
Relative humidity	
Operation	TBD
Storage	TBD
Transport	TBD

Table 78: 5AC901.LDPO-00 - Technical data

1) Detailed information can be found in the temperature tables in the user's manual.

Pin assignments - DisplayPort

Pin	Signal	Description	Pin	Signal	Description
1	DP_LANE0+	DisplayPort lane 0 (positive)	11	GND	Ground
2	GND	Ground	12	DP_LANE3-	DisplayPort lane 3 (negative)
3	DP_LANE0-	DisplayPort lane 0 (negative)	13	CONFIG1	Configuration pin 1 (connected to ground)
4	DP_LANE1+	DisplayPort lane 1 (positive)	14	CONFIG2	Configuration pin 2 (connected to ground)
5	GND	Ground	15	DP_AUX+	Auxiliary channel (positive)
6	DP_LANE1-	DisplayPort lane 1 (negative)	16	GND	Ground
7	DP_LANE2+	DisplayPort lane 2 (positive)	17	DP_AUX-	Auxiliary channel (negative)
8	GND	Ground	18	DP_HPD#	Hot Plug detect
9	DP_LANE2-	DisplayPort lane 2 (negative)	19	RETURN	Return for power
10	DP_LANE3+	DisplayPort lane 3 (positive)	20	DP_PWR	Power for connector

DisplayPort (20-pin, female)

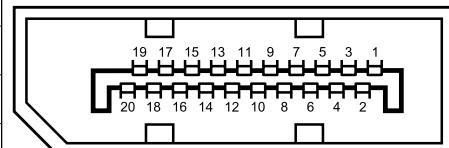


Table 79: Pin assignments - DisplayPort

3.10.2 5AC901.LSDL-00

General information

The 5AC901.LSDL-00 monitor/panel option is equipped with a monitor/panel interface for connecting additional panels via SDL or DVI.

- DVI/SDL interface

Order data

Model number	Short description	Figure
	Monitor / Panel options	
5AC901.LSDL-00	Smart Display Link/DVI transmitter	Image not found for 5AC901.LSDL-00!

Table 80: 5AC901.LSDL-00 - Order data

Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5AC901.LSDL-00
General information	
B&R ID code	\$D853
Certification CE	Yes
Interfaces	
Panel/Monitor interface Design Type	DVI-D socket SDL/DVI
Electrical characteristics	
Power consumption	TBD
Environmental conditions	
Temperature Operation Storage Transport	TBD ¹⁾ TBD TBD
Relative humidity Operation Storage Transport	TBD TBD TBD

Table 81: 5AC901.LSDL-00 - Technical data

- 1) Detailed information can be found in the temperature tables in the user's manual.

Pinout

Pin	assignment	Description	Pin	assignment	Description
1	TMDS Data 2-	DVI lane 2 (negative)	16	HPD	Hot plug detect
2	TMDS Data 2+	DVI lane 2 (positive)	17	TMDS Data 0-	DVI lane 0 (negative)
3	TMDS Data 2/4 SHIELD	Shield for data pair 2 and 4	18	TMDS Data 0+	DVI lane 0 (positive)
4	SDL-	SDL lane (negative)	19	TMDS Data 0/ XUSB1 SHIELD	Shield for data pair 0 and XUSB1
5	SDL+	SDL lane (positive)	20	XUSB1-	USB lane 1 (negative)
6	DDC Clock	DDC-based control signal (clock)	21	XUSB1+	USB lane 1 (positive)
7	DDC Data	DDC-based control signal (data)	22	TMDS Clock Shield	Shield for clock pair
8	n.c.	Not connected	23	TMDS Clock+	DVI clock (positive)
9	TMDS Data 1-	DVI lane 1 (negative)	24	TMDS Clock -	DVI clock (negative)
10	TMDS DATA 1+	DVI lane 1 (negative) HDMI clock (positive)	C1	ANALOG RED	Analog red
11	TMDS DATA 1/ XUSB0 SHIELD	Shield for data pair 1 and XUSB0	"c2"	ANALOG GREEN	Analog green
12	XUSB0-	USB lane 0 (negative)	C3	ANALOG BLUE	Analog blue
13	XUSB0+	USB lane 0 (positive)	C4	ANALOG HORZ SYNC	Analog horizontal synchronization

DVI 24-pin, female

1	2	3	4	5	6	7	8	c1	c2															
9	10	11	12	13	14	15	16																	
17	18	19	20	21	22	23	24	c3	c4															

Table 82: Pinout - DVI connection

Pin	assignment	Description	Pin	assignment	Description
14	+5 V Power ¹⁾	+5 V power supply	C5	ANALOG GND	Analog ground (return for R, G and B signals)
15	Ground (return for +5 V, HSync and VSync)	Ground			

Table 82: Pinout - DVI connection

1) Protected internally by a multifuse

3.11 Front covers

3.11.1 5AC901.FF0x-00

General information

The front cover on the APC910 keeps the front-side ports free of dust, dirt and other contaminants.

A front cover is available for each APC910 system unit model.

Order data

Model number	Short description	Figure
	Front cover	
5AC901.FF01-00	APC910 front cover, 1 slot, orange	
5AC901.FF02-00	APC910 front cover 2 slot, orange	

Table 83: 5AC901.FF01-00, 5AC901.FF02-00 - Order data

Chapter 3 • Commissioning

1 Mounting

Devices are installed using the mounting plates found on the housing. These plates are designed for M5 screws.

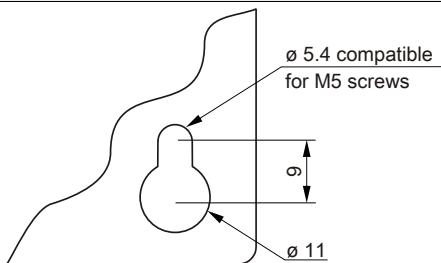


Figure 28: Mounting plates

The exact positioning of the mounting holes can be seen in the drilling templates in Chapter 2 "Technical data", section "Individual components" on page 46.

1.1 Important mounting information

- Environmental conditions must be taken into consideration.
- This device must be mounted to a flat surface.
- This device is only certified for operation in closed rooms.
- This device must not be subjected to direct sunlight.
- The ventilation holes must not be covered.
- This device must be mounted in one of the approved orientations.
- The wall or control cabinet must be able to withstand four times the total weight of the device.
- When connecting cables (DVI, SDL, USB, etc.), the flex radius must not be exceeded.

1.2 Procedure

1. Drill the necessary holes in the control cabinet. The exact positioning of the mounting holes can be seen in the drilling templates.
2. Mount the B&R Industrial PC to the control cabinet using M5 screws.

1.3 Mounting orientation

The following diagrams show approved mounting orientations for the Automation PC 910 device. The APC910 system must be mounted as described in the following sections.

1.3.1 Mounting orientation - Vertical

APC910 systems with and without fan kit can be mounted this way.

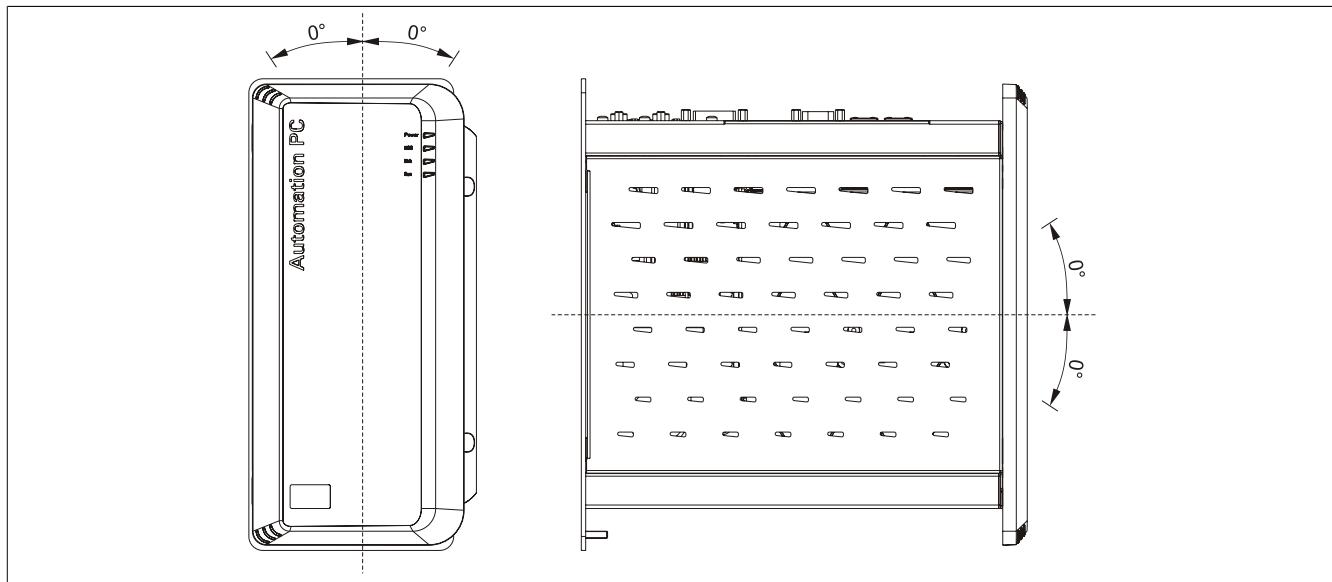


Figure 29: Mounting orientation - Vertical

Mount the device so that the spacing is as indicated in section "Spacing for air circulation" on page 90 in order to facilitate natural air circulation.

1.3.2 Mounting orientation - Horizontal

Operation in the optional horizontal mounting orientation (heat sink on top) requires the use of a fan kit. The maximum ambient temperature specification must be derated by 5°C.

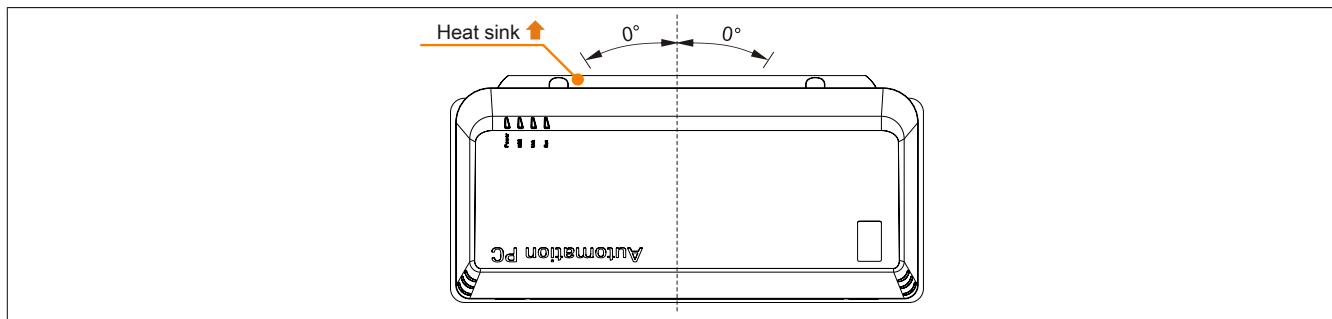


Figure 30: Mounting orientation - Horizontal

Mount the device so that the spacing is as indicated in section "Spacing for air circulation" on page 90 in order to facilitate natural air circulation.

1.4 Spacing for air circulation

In order to guarantee sufficient air circulation, allow the specified amount of space above, below, to the side and behind the Automation PC 910. The minimum specified spacing is indicated in the following diagrams. This applies for all Automation PC 910 variants.

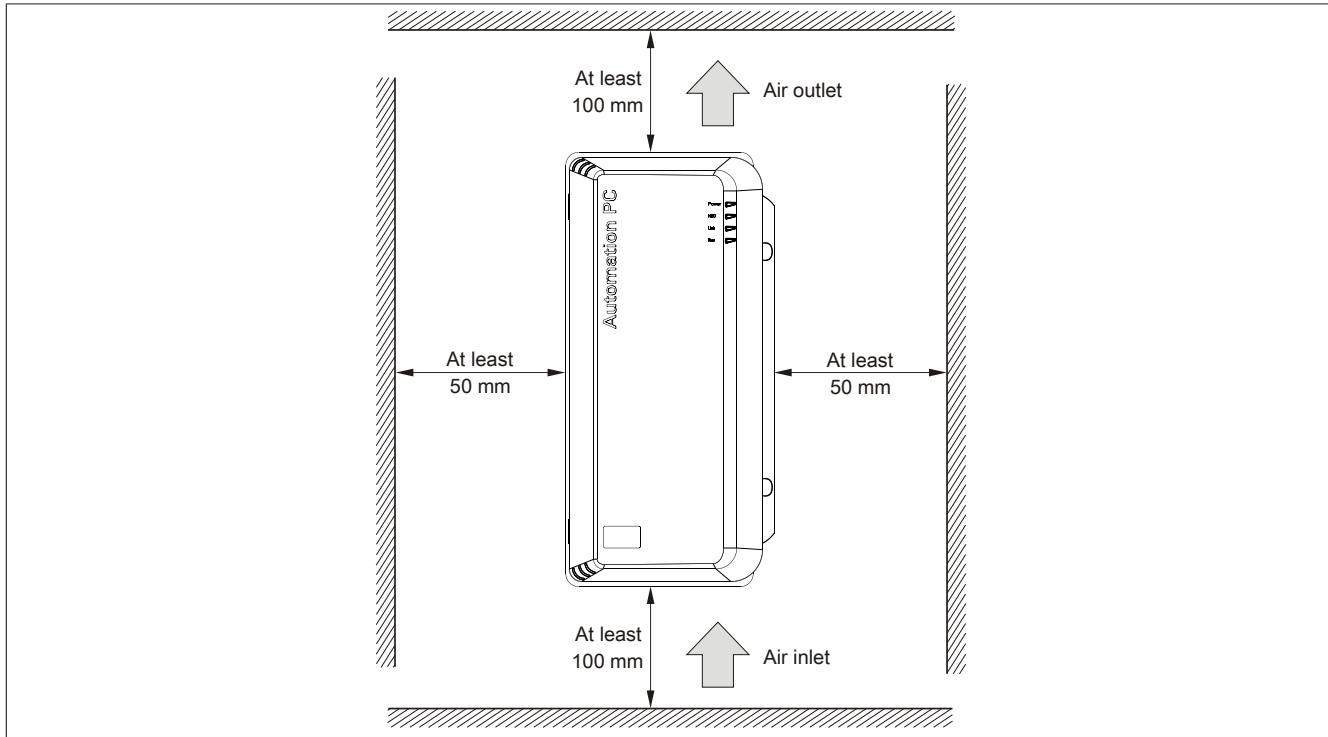


Figure 31: Standard mounting - Mounting distances

These defined distances are valid for both vertical and horizontal mounting of the APC910.

Information:

The spacing specifications for air circulation are based on the worst case scenario for operation at maximum specified ambient temperature (see "Temperature specifications" in the chapter "Technical data").

If the spacing specifications for air circulation cannot be adhered to, then the maximum specified temperatures for the temperature sensors (see "Temperature sensor locations" in chapter "Technical data") must be monitored by the user and according measures must be taken if exceeded.

2 Cable connections

The flex radius specification must be taken into account when connecting or laying cables.

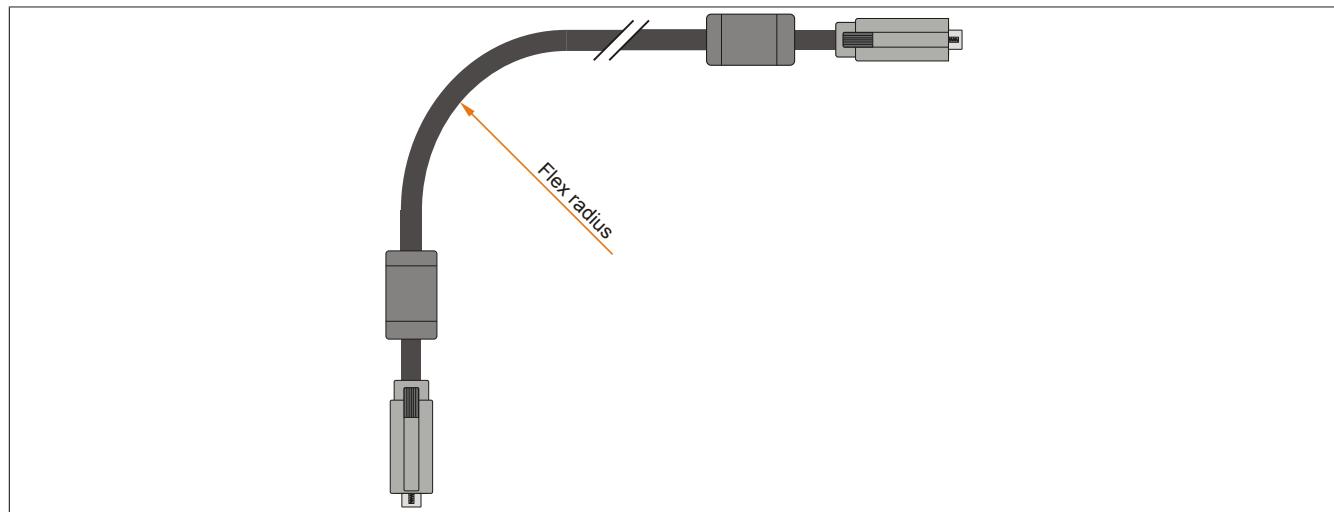


Figure 32: Flex radius - Cable connection

Information:

The specified flex radius can be found in the Automation Panel 800 or Automation Panel 900 User's Manual, which can be downloaded as a .PDF file from the B&R website (www.br-automation.com).

3 Grounding concept

Functional ground is a current path of low impedance between electrical circuits and ground. It is used, for example, to improve immunity to disturbances and not necessarily as a protective measure. It therefore serves only to deflect disturbances, not to provide any kind of protection against electric shock.

The functional ground on the device has 2 connections:

- Supply voltage
- Ground connection

To guarantee secure dissipation of electric disturbances, the following points should be observed:

- The device should be connected to the central grounding point in the control cabinet using the shortest route possible.
- Use a cable with a minimum cross section of 2.5 mm^2 per connection.
- Note the line shielding concept, all connected data cables are used as shielded lines.

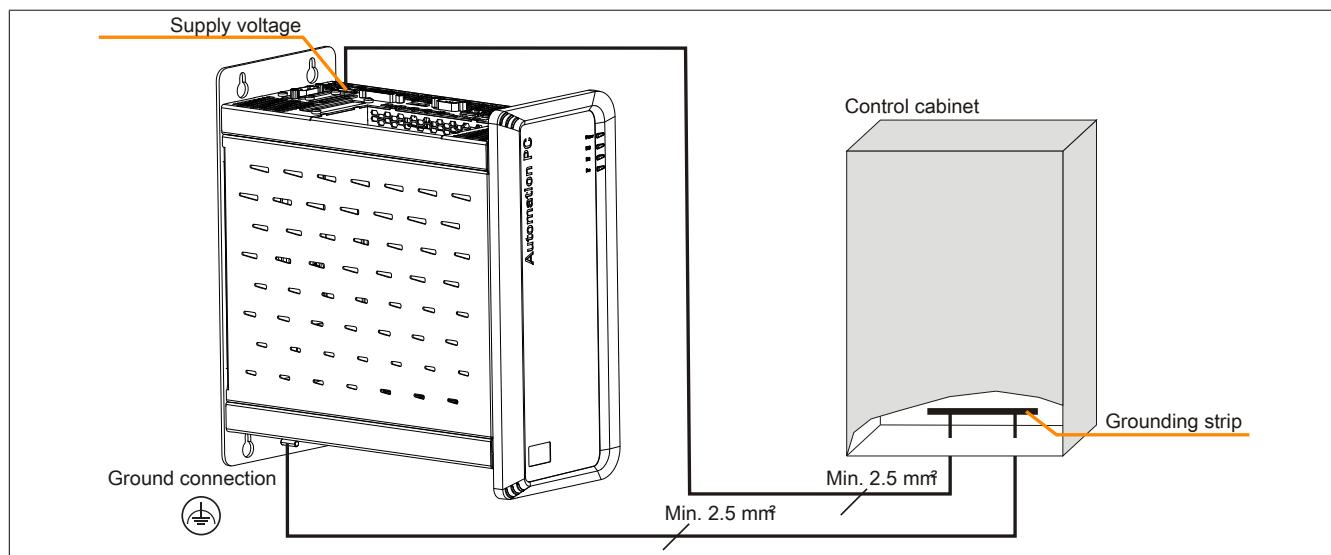


Figure 33: Grounding concept

Chapter 4 • Software

1 Windows 7

1.1 General information

Windows® 7 offers a wealth of innovative features and performance improvements. The 64-bit variants can also exploit the full power of current PC architectures. Faster switching to power saving mode, quicker restores, less memory usage and high-speed detection of USB devices are just a few of the advantages provided by Windows® 7. Both English and German are available in Windows® 7 Professional, while Windows® 7 Ultimate supports up to 35 different languages (up to 36 languages in Service Pack 1). Product activation is not necessary on B&R PCs, which is a huge advantage for simple logistical procedures relating to machine automation.

All of the Windows® operating systems offered by B&R are from the Microsoft Embedded Division. This guarantees much longer availability, especially when compared to products offered on the consumer market.

1.2 Order data

Model number	Short description	Figure
	Windows 7	
5SWWI7.1100-GER	Microsoft OEM Windows 7 Professional 32-bit, Service Pack 1, DVD, German. Only available with a new device.	
5SWWI7.1100-ENG	Microsoft OEM Windows 7 Professional 32-bit, Service Pack 1, DVD, English. Only available with a new device.	
5SWWI7.1200-GER	Microsoft OEM Windows 7 Professional 64-bit, Service Pack 1, DVD, German. Only available with a new device.	
5SWWI7.1200-ENG	Microsoft OEM Windows 7 Professional 64-bit, Service Pack 1, DVD, English. Only available with a new device.	
5SWWI7.1300-MUL	Microsoft OEM Windows 7 Ultimate 32-bit, Service Pack 1, DVD, multilanguage. Only available with a new device.	
5SWWI7.1400-MUL	Microsoft OEM Windows 7 Ultimate 64-bit, Service Pack 1, DVD, multilanguage. Only available with a new device.	

Table 84: 5SWWI7.1100-GER, 5SWWI7.1100-ENG, 5SWWI7.1200-GER, 5SWWI7.1200-ENG, 5SWWI7.1300-MUL, 5SWWI7.1400-MUL - Order data

1.3 Overview

Model number	Edition	Target system	Chipset	Service Pack	Architectures	Language	Preinstalled	Minimum size of the disk	Minimum amount of RAM
5SWWI7.1100-GER	Professional	APC510 APC511 APC810 APC910 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP1	32-bit	German	Optional	16 GB	1 GB
5SWWI7.1100-ENG	Professional	APC510 APC511 APC810 APC910 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP1	32-bit	English	Optional	16 GB	1 GB
5SWWI7.1200-GER	Professional	APC810 APC910 PPC800	945GME Intel® Core™2 Duo GM45 QM77/HM76	SP1	64-bit	German	Optional	20 GB	2 GB
5SWWI7.1200-ENG	Professional	APC810 APC910 PPC800	945GME Intel® Core™2 Duo GM45 QM77/HM76	SP1	64-bit	English	Optional	20 GB	2 GB

Model number	Edition	Target system	Chipset	Service Pack	Architectures	Language	Preinstalled	Minimum size of the disk	Minimum amount of RAM
5SWWI7.1300-MUL	Ultimate	APC510 APC511 APC810 APC910 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP1	32-bit	Multilingual	Optional	16 GB ¹⁾	1 GB
5SWWI7.1400-MUL	Ultimate	APC810 APC910 PPC800	945GME Intel® Core™2 Duo GM45 QM77/HM76	SP1	64-bit	Multilingual	Optional	20 GB ¹⁾	2 GB

1) The memory space needed for additional language packs is not included in the minimum size specified for the data storage medium.

1.4 Installation

Upon request, B&R can pre-install the required Windows 7 version on the desired mass storage device (e.g. CompactFlash card, etc.). All of the drivers required for operation (graphics, network, etc.) are also installed when doing so.

1.5 Drivers

The latest drivers for all approved operating systems can be found in the Download area (Service / Material-related downloads - BIOS / Drivers / Updates) of the B&R website (www.br-automation.com).

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

1.6 Special considerations, limitations

- Windows 7 does not contain a Beep.sys file, which means that audible signal is no longer played (i.e. when touching a key or button).
- Windows 7 system classification is not currently supported (does not apply to PP500, APC510, APC511, APC910 or PPC800 with NM10 chipset).

2 Windows Embedded Standard 7

2.1 General information

The successor to Windows® XP Embedded has been given the name Windows® Embedded Standard 7. As with previous versions, this embedded operating system offers full system support of B&R industrial PCs. In addition to brand new features that are also included in Windows® 7 Professional, Windows® Embedded Standard 7 includes embedded components such as Enhanced Write Filter, File-Based Write Filter, Registry Filter and USB Boot. Windows® Embedded Standard 7 is available in two different versions. The main difference between them has to do with multilingual support. Windows® Embedded Standard 7 is only available in a single language, whereas Windows® Embedded Standard 7 Premium supports the installation of several languages simultaneously.

With Windows® Embedded Standard 7, Microsoft has made substantial improvements in the area of security. The AppLocker program, available in the premium version, can prevent the execution of unknown or potentially unwanted applications that should be installed over a network or from drives that are directly connected. A tiered approach allows the differentiation between scripts (.ps1, .bat, .cmd, .vbs and .js), installer files (.msi, .msp) and libraries (.dll, .ocx). AppLocker can also be configured to record undesired activity and display it in the Event Viewer. Windows® Embedded Standard 7 is available in both 32-bit and 64-bit versions⁷⁾. This ensures that even the most demanding applications have the level of support they need.

2.2 Order data

Model number	Short description	Figure
	Windows Embedded Standard 7	
5SWWI7.1540-ENG	Microsoft OEM Windows Embedded Standard 7 32-bit, Service Pack 1, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	
5SWWI7.1640-ENG	Microsoft OEM Windows Embedded Standard 7 64-bit, Service Pack 1, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	
5SWWI7.1740-MUL	Microsoft OEM Windows Embedded Standard 7 Premium 32-bit, Service Pack 1, multilanguage; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB without language packages).	
5SWWI7.1840-MUL	Microsoft OEM Windows Embedded Standard 7 Premium 64-bit, Service Pack 1, multilanguage; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 16 GB).	
	Required accessories	
	CFast cards	
5CFAST.016G-00	CFast 16 GB	
5CFAST.032G-00	CFast 32 GB	
	Optional accessories	
	Windows Embedded Standard 7	
5SWWI7.1900-MUL	Microsoft OEM Windows Embedded Standard 7 32-bit, Service Pack 1, Language Pack DVD	
5SWWI7.2000-MUL	Microsoft OEM Windows Embedded Standard 7 64-bit, Service Pack 1, Language Pack DVD	

Table 85: 5SWWI7.1540-ENG, 5SWWI7.1640-ENG, 5SWWI7.1740-MUL, 5SWWI7.1840-MUL - Order data

2.3 Overview

Model number	Edition	Target system	Chipset	Architectures	Language	Preinstalled	Minimum size of the disk	Minimum amount of RAM
5SWWI7.1540-ENG	Embedded	APC910	QM77 HM76	32-bit	English	Optional	16 GB	1 GB
5SWWI7.1640-ENG	Embedded	APC910	QM77 HM76	64-bit	English	Optional	16 GB	2 GB
5SWWI7.1740-MUL	Premium	APC910	QM77 HM76	32-bit	Multilingual	Optional	16 GB ¹⁾	1 GB
5SWWI7.1840-MUL	Premium	APC910	QM77 HM76	64-bit	Multilingual	Optional	16 GB ¹⁾	2 GB

1) The memory space needed for additional language packs is not included in the minimum size specified for the data storage medium.

7) 64-bit versions are not supported by all systems

2.4 Features with WEST (Windows Embedded Standard 7)

The feature list shows the most important device functions in Windows Embedded Standard 7.

Functionality	Windows Embedded Standard 7	Windows Embedded Standard 7 Premium
Enhanced Write Filter (EWF)	✓	✓
File Based Write Filter (FBWF)	✓	✓
Administrator account	✓	✓
User account	Configurable	Configurable
Windows Explorer Shell	✓	✓
Registry filter	✓	✓
Internet Explorer 8.0	✓	✓
Internet Information Service (IIS) 7.0	✓	✓
AntiMalware (Windows Defender)	-	✓
Add-ons (Snipping tool, Sticky Notes)	-	✓
Windows Firewall	✓	✓
.NET Framework 3.5	✓	✓
32-bit and 64-bit	✓	✓
Remote Desktop Protocol 7.0	✓	✓
File Compression Utility	✓	✓
Windows Installer Service	✓	✓
Windows XP Mode	-	-
Media Player 12	✓	✓
DirectX	✓	✓
Multilingual User Interface Packs in the same image	-	✓
International Components and Language Services	✓	✓
Language Pack Setup	✓	✓
Windows Update	Configurable	Configurable
Windows PowerShell 2.0	✓	✓
BitLocker	-	✓
Applocker	-	✓
Tablet PC support	-	✓
Windows Touch	-	✓
Boot from USB Stick	✓	✓
Accessories	✓	✓
Page file	Configurable	Configurable
Number of fonts	134	134

Table 86: Device functions in Windows Embedded Standard 7

2.5 Installation

Upon request, Windows Embedded Standard 7 can be pre-installed at B&R Austria on a suitable CFast card (32-bit: at least 8 GB, 64-bit: at least 16 GB). The system is then automatically configured when it is switched on for the first time. This procedure takes approximately 30 minutes, and the device will be rebooted a number of times.

2.6 Drivers

All drivers required for operation are preinstalled on the operating system. If an older version of the driver is still being used, the latest version can be downloaded from the B&R website (www.br-automation.com) and installed. Be sure to check whether the Enhanced Write Filter (EWF) is disabled.

2.6.1 Touch screen driver

A touch screen driver will be automatically installed if a touch controller is detected during the Windows Embedded Standard 7 setup. If a touch controller is not detected during Windows Embedded Standard 7 setup, or if an Automation Panel 800/900 is connected later on, the touch screen driver needs to be installed or the additional touch screen interface needs to be selected in the touch screen settings in the Windows Control Panel. The driver is available in the Download area of the B&R website (www.br-automation.com). When doing so, be sure that the Enhanced Write Filter (EWF) or File Based Write Filter (FBWF) are not enabled.

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

3 Windows XP Professional

3.1 Order data

Model number	Short description	Figure
Windows XP Professional		
5SWWXP.0600-ENG	Microsoft OEM Windows XP Professional Service Pack 3, CD, English. Only available with a B&R device.	
5SWWXP.0600-GER	Microsoft OEM Windows XP Professional Service Pack 3, CD, German. Only available with a device.	
5SWWXP.0600-MUL	Microsoft OEM Windows XP Professional Service Pack 3, CD, multilanguage. Only available with a B&R device.	

Table 87: 5SWWXP.0600-ENG, 5SWWXP.0600-GER, 5SWWXP.0600-MUL - Order data

3.2 Overview

Model number	Edition	Target system	Chipset	Service Pack	Language	Preinstalled	Memory required on the disk	Minimum amount of RAM
5SWWXP.0600-ENG	Professional	APC510 APC511 APC620 APC810 APC820 APC910 PPC700 PPC725 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP3	English	Optional	≤ 2.1 GB	128 MB
5SWWXP.0600-GER	Professional	APC510 APC511 APC620 APC810 APC820 APC910 PPC700 PPC725 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP3	German	Optional	≤ 2.1 GB	128 MB
5SWWXP.0600-MUL	Professional	APC510 APC511 APC620 APC810 APC820 APC910 PPC700 PPC725 PPC800 PP500	945GME GM45 QM77/HM76 NM10 US15W	SP3	Multilanguage	Optional	≤ 2.1 GB	128 MB

3.3 Installation

Upon request, B&R can pre-install the required Windows XP Professional version on the desired mass storage device (e.g. CompactFlash card, etc.). All of the drivers required for operation (graphics, network, etc.) are also installed when doing so.

3.4 Drivers

The latest drivers for all approved operating systems can be found in the Download area (Service / Material-related downloads - BIOS / Drivers / Updates) of the B&R website (www.br-automation.com).

Information:

Required drivers can only be downloaded from the B&R homepage, not from manufacturers' pages.

4 Windows Embedded Standard 2009

4.1 General information

Windows® Embedded Standard 2009 is the modular version of Windows® XP Professional. It's used if XP applications require a smaller operating system size to run. Together with CompactFlash memory, Windows® Embedded Standard 2009 makes it possible to use the Microsoft desktop operating system in rough environmental conditions. In addition to the familiar features included in Windows® XP Professional, Windows® Embedded Standard 2009 has been improved with regard to dependability by adding a write filter for individual memory partitions. By protecting individual partitions such as the boot partition, the PC system can be started without any problems, even after an unexpected power failure. B&R offers complete images for industrial PCs, Power Panel and Mobile Panel devices to make the transition to Windows® Embedded Standard 2009 as easy as possible. In addition to Windows® Embedded Standard 2009, the standard Windows® XP Professional operating system is also available in English, German and multilingual.

Windows® Embedded Standard 2009 is based on the same binary files as Windows® XP Professional with Service Pack 3 and is optimally tailored to the hardware being used. In other words, only the functions and modules required by the respective device are included. Windows® Embedded Standard 2009 is also based on the same reliable code as Windows® XP Professional with SP3. It provides industry with leading reliability, improvements in security and performance, and the latest technology for Web browsing and extensive device support.

4.2 Order data

Model number	Short description	Figure
	Windows Embedded Standard 2009	
5SWWXP.0740-ENG	Microsoft OEM Windows Embedded Standard 2009, English; for APC910 with QM77/HM76 chipset; please order CFast separately (minimum 2 GB).	 Windows Embedded Standard 2009
	Required accessories	
	CFast cards	
5CFAST.016G-00	CFast 16 GB	
5CFAST.032G-00	CFast 32 GB	
5CFAST.2048-00	CFast 2 GB	
5CFAST.4096-00	CFast 4 GB	
5CFAST.8192-00	CFast 8 GB	

Table 88: 5SWWXP.0740-ENG - Order data

4.3 Overview

Model number	Target system	Chipset	Language	Preinstalled	Minimum size of the disk	Minimum amount of RAM
5SWWXP.0740-ENG	APC910	QM77 HM76	English	Yes	2 GB	256 MB

4.4 Features with WES2009 (Windows Embedded Standard 2009)

The feature list shows the most important device functions in Windows Embedded Standard 2009.

Function	Present
Enhanced Write Filter (EWF)	✓
File Based Write Filter (FBWF)	✓
Page file	Configurable
Administrator account	✓
User account	Configurable
Explorer shell	✓
Registry filter	✓
Internet Explorer 8.0	✓
Internet information service (IIS)	-
Terminal service	✓
Windows Firewall	✓
MSN Explorer	-
Outlook Express	-
Administrative Tools	✓
Remote Desktop	✓
Remote Assistance	-
.NET Framework	-
ASP.NET	-
OpenGL support	✓
Local Network Bridge	✓

Table 89: Device functions in Windows Embedded Standard 2009

Function	Present
Codepages/User Locale/Keyboard	✓
Disk Management Service	✓
Windows Installer Service	✓
Class Installer	✓
CoDevice Installer	✓
Media Player 6.4	✓
DirectX 9.0c	✓
Accessories	✓
Number of fonts	89

Table 89: Device functions in Windows Embedded Standard 2009

4.5 Installation

Upon request, Windows Embedded Standard 2009 can be pre-installed at B&R Austria on a suitable CFast card (min. 2 GB). The system is then automatically configured when it is switched on for the first time. This procedure takes approximately 10 minutes, and the device will be rebooted a number of times.

4.6 Drivers

All drivers required for operation are preinstalled on the operating system. If an older version of the driver is still being used, the latest version can be downloaded from the B&R website (www.br-automation.com) and installed. Be sure to check whether the Enhanced Write Filter (EWF) is disabled.

5 B&R Automation Device Interface (ADI) - Control Center

The ADI (Automation Device Interface) enables access to specific functions of B&R devices. Settings for this device can be read and edited using the B&R Control Center applet in the control panel.

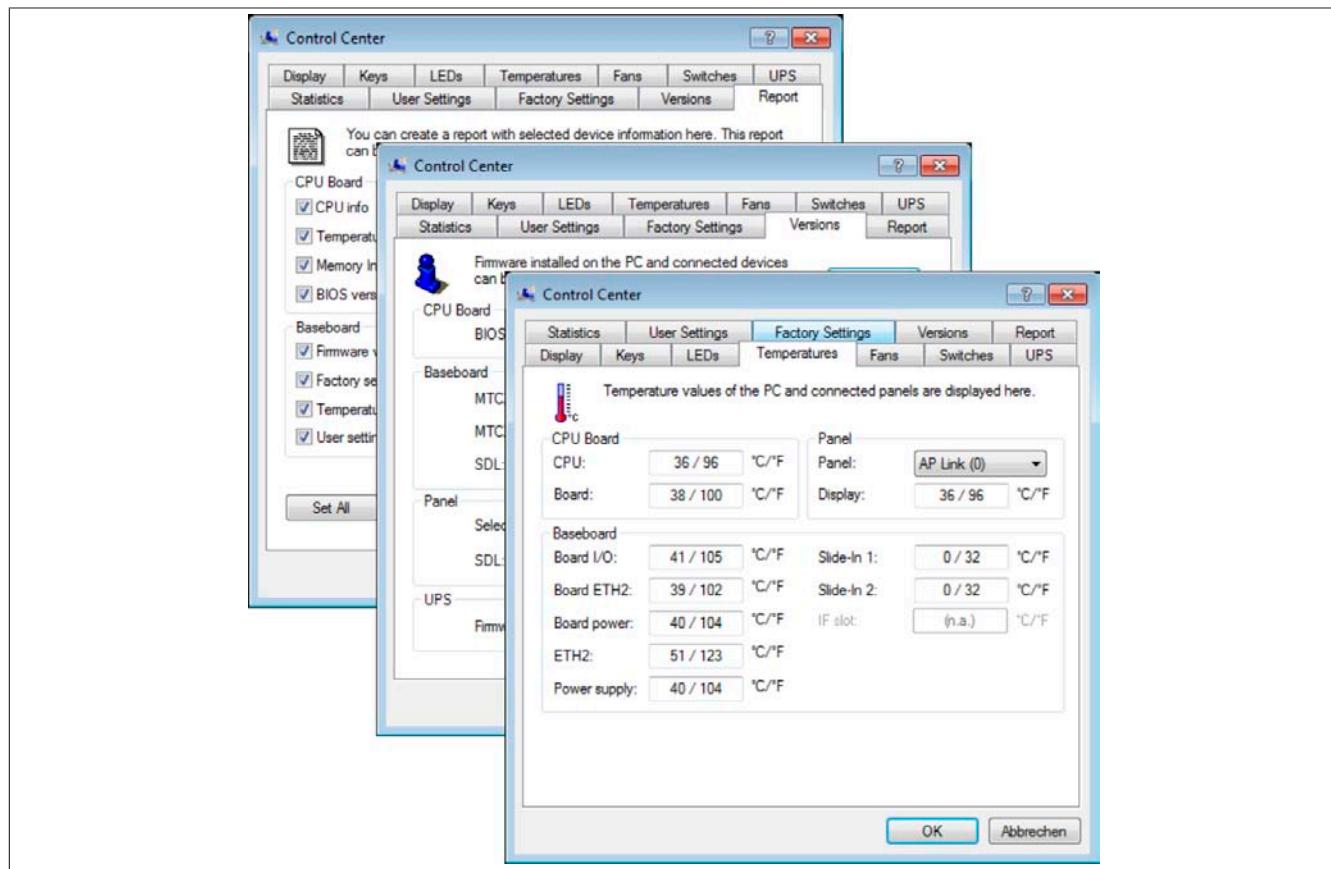


Figure 34: ADI Control Center screenshots - Examples (symbol photo)

Information:

The displayed temperature and voltage values (e.g. CPU temperature, core voltage, battery voltage) on the corresponding ADI page represent uncalibrated information values. These cannot be used to draw any conclusions about any hardware alarms or error conditions. The hardware components used have automatic diagnostics functions that can be applied in the event of error.

5.1 Functions

Information:

The functions provided by the Automation Device Interface (ADI) - Control Center vary according to device series.

- Changing display-specific parameters
- Reading device-specific keys
- Updating the key configuration
- Activating device-specific LEDs on a membrane keypad
- Read or calibrate the entry devices (e.g. key switch, handwheel, joystick, potentiometer)
- Reading temperatures, fan speeds, statistical data and switch settings
- Read the operating hours (power on hours)
- Reading user and factory settings
- Reading software versions
- Updating and securing BIOS and firmware
- Creating reports about the current system (support assistance)
- Setting the SDL equalizer value for the SDL cable adjustment
- Changing the User Serial ID

Supports the following systems:

- Automation PC 510
- Automation PC 511
- Automation PC 620
- Automation PC 810
- Automation PC 820
- Automation PC 910
- Panel PC 300
- Panel PC 700
- Panel PC 725
- Panel PC 800
- Power Panel 100/200
- Power Panel 300/400
- Power Panel 500
- Mobile Panel 40/50
- Mobile Panel 100/200
- Connected Automation Panel 800
- Connected Automation Panel 900

5.2 Installation

A detailed description of the Control Center can be found in the integrated online help. The B&R Automation Device Interface (ADI) driver (also contains Control Center) is available in the Downloads section of the B&R website (www.br-automation.com).

1. Download and unzip the ZIP archive
2. Close all applications
3. Run the Setup.exe file (e.g. double-click on it in Explorer).

Information:

The ADI driver is already included in the B&R images of embedded operating systems.

If a more current ADI driver version exists (see the Downloads area of the B&R website), it can be installed later. During installation, make sure to check whether or not the Enhanced Write Filter (EWF) is disabled.

6 B&R Automation Device Interface (ADI) Development Kit

This software can be used to access B&R Automation Device Interface (ADI) functions from Windows applications created e.g. using the following development environments:

- Microsoft Visual C++ 6.0
- Microsoft Visual Basic 6.0
- Microsoft Embedded Visual C++ 4.0
- Microsoft Visual Studio 2005 (or newer)

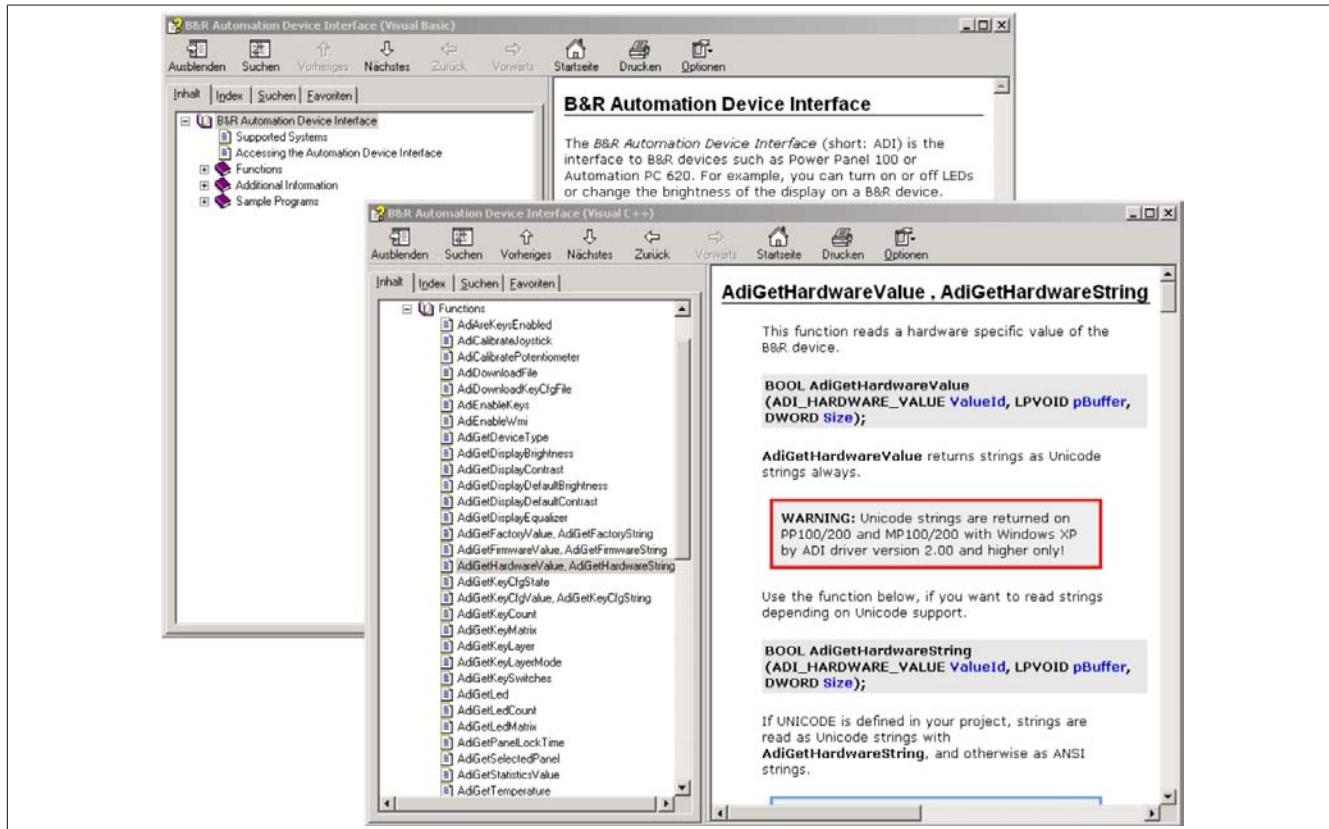


Figure 35: ADI Development Kit screenshots (Version 3.40)

Features:

- One Microsoft Visual Basic module with ADI function declarations
- Header files and import libraries for Microsoft Visual C++
- Help files for Visual Basic and Visual C++
- Sample projects for Visual Basic and Visual C++
- ADI DLL (for application testing if no ADI driver is installed)

Supports the following systems (Version 3.40 and higher):

- Automation PC 510
- Automation PC 511
- Automation PC 620
- Automation PC 810
- Automation PC 820
- Automation PC 910
- Panel PC 300
- Panel PC 700
- Panel PC 800
- Power Panel 100/200
- Power Panel 300/400
- Power Panel 500
- Mobile Panel 40/50

- Mobile Panel 100/200

The ADI driver suitable for the device must be installed on the stated product series. The ADI driver is already included in the B&R images of embedded operating systems.

A detailed description of using the ADI functions can be found in the online help system.

The B&R Automation Device Interface (ADI) Development Kit is available in the Download area of the B&R website (www.br-automation.com).

7 B&R Automation Device Interface (ADI) .NET SDK

This software can be used to access B&R Automation Device Interface (ADI) functions from .NET applications created using Microsoft Visual Studio 2005 or later.

Supported programming languages:

- Visual Basic
- Visual C++
- Visual C#

System requirements

- Development system: PC with Windows XP/7 and
 - Microsoft Visual Studio 2005 (or newer)
 - Microsoft .NET Framework 2.0 and/or Microsoft .NET Compact Framework 2.0 (or newer)

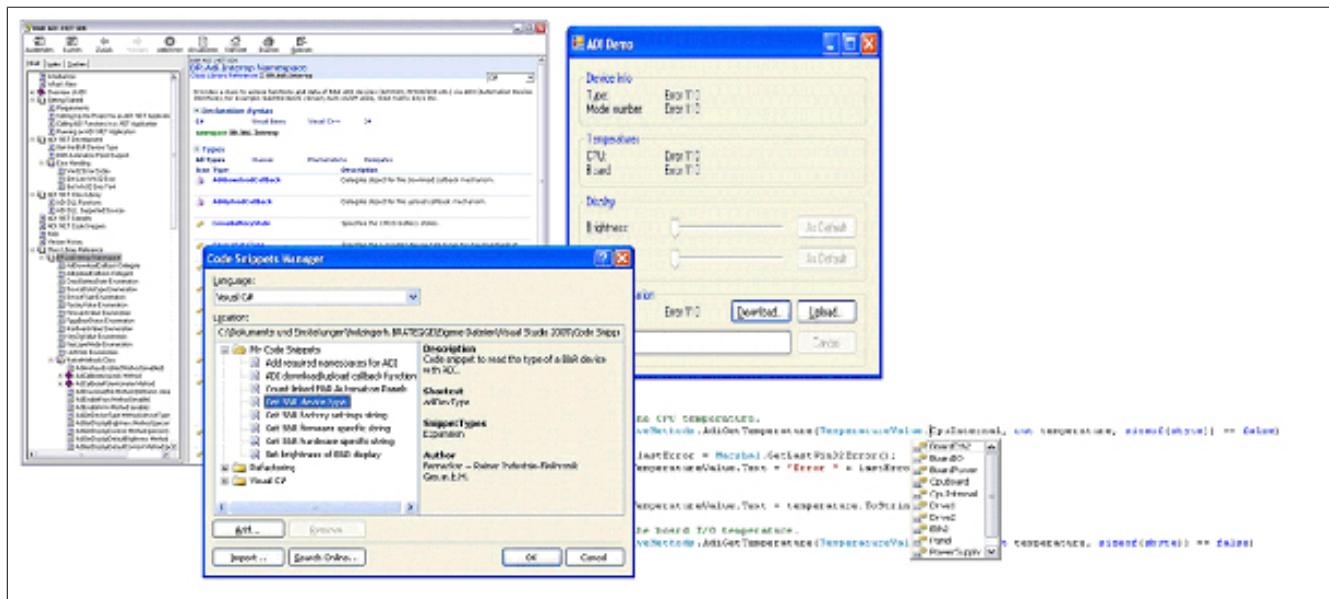


Figure 36: ADI .NET SDK screenshots (Version 1.80)

Features (Version 1.80 and higher)

- ADI .NET class library.
- Help files in HTML Help 1.0 format (.chm file) and MS Help 2.0 format (.HxS file). (Help documentation is in English)
- Sample projects and code snippets for Visual Basic, Visual C++, and Visual C#
- ADI DLL (for application testing if no ADI driver is installed).

Supports the following systems (Version 1.80 and higher):

- Automation PC 510
- Automation PC 511
- Automation PC 620
- Automation PC 810
- Automation PC 820
- Automation PC 910
- Panel PC 300
- Panel PC 700
- Panel PC 800
- Power Panel 100/200
- Power Panel 300/400
- Power Panel 500
- Mobile Panel 40/50
- Mobile Panel 100/200

The ADI driver suitable for the device must be installed on the stated product series. The ADI driver is already included in the B&R images of embedded operating systems.

A detailed description of using the ADI functions can be found in the online help system.

ADI .NET SDK is available in the Downloads area of the B&R website (www.br-automation.com).

Chapter 5 • Accessories

The following accessories have passed B&R's functional testing and are approved for use with this device. Nevertheless, it is important to observe any limitations that may apply to the complete device when operated with different components. When operating the complete device, it is the specifications for the individual components that must be adhered to.

All components listed in this manual have been subjected to extensive system and compatibility testing and are approved for use. B&R can make no guarantee regarding the functionality of non-approved accessories.

1 Power connectors

1.1 0TB103.9x

1.1.1 General information

The single row 3-pin terminal block TB103 is used to connect the supply voltage.

1.1.2 Order data

Model number	Short description	Figure
Terminal blocks		
0TB103.9	Connector, 24 VDC, 3-pin female, screw clamps 3.31 mm ² , protected against vibration by the screw flange	
0TB103.91	Connector, 24 VDC, 3-pin female, cage clamps 3.31 mm ² , protected against vibration by the screw flange	

Table 90: 0TB103.9, 0TB103.91 - Order data

1.1.3 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	0TB103.9	0TB103.91
Terminal block		
Note	Protected against vibration by the screw flange Rated values according to UL	
Number of pins	3 (female)	
Type of terminal clamp	Screw clamps	Cage clamps ²⁾
Cable type	Copper wires only (no aluminum wires!)	
Distance between contacts	5.08 mm	
Connection cross section		
AWG wire	26 to 12 AWG	
Wire tip sleeves with plastic covering	0.20 to 1.50 mm ²	
Solid wires	0.20 to 2.50 mm ²	
Fine strand wires		0.20 to 2.50 mm ²
With wire tip sleeves	0.20 to 1.50 mm ²	
Fastening torque	0.4 Nm	-
Electrical characteristics		
Nominal voltage	300 V	
Nominal current ¹⁾	10 A / contact	
Contact resistance	≤ 5 mΩ	

Table 91: 0TB103.9, 0TB103.91 - Technical data

1) Please take the respective limit data for the I/O modules into consideration!

2) Cage clamp terminal blocks cannot be strung together.

2 Replacement CMOS batteries

2.1 0AC201.91 / 4A0006.00-000

2.1.1 General information

This lithium battery is needed to back BIOS CMOS data and the real-time clock (RTC).

The battery is subject to wear and must be replaced when the battery power ("Bad" status) is insufficient.

2.1.2 Order data

Model number	Short description	Figure
Batteries		
0AC201.91	Lithium batteries 4 pieces, 3 V / 950 mAh button cell Hereby we declare that the Lithium cells contained in this shipment qualify as „partly regulated“. Handle with care. If the package is damaged, inspect cells, repack intact cells and protect cells against short circuits. For emergency information, call RENATA SA at +41 61 319 28 27	
4A0006.00-000	Lithium battery, 3 V / 950 mAh, button cell	

Table 92: 0AC201.91, 4A0006.00-000 - Order data

2.1.3 Technical data

Warning!

Replace battery with Renata, type CR2477N only. Use of another battery may present a risk of fire or explosion.

Battery may explode if mistreated. Do not recharge, disassemble or dispose of in fire.

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	0AC201.91	4A0006.00-000
General information		
Storage time	Max. 3 years at 30°C	
Electrical characteristics		
Capacity	950 mAh	
Self discharging	<1% per year (at 23°C)	
Voltage range	3V	
Environmental conditions		
Temperature Storage	-20 to 60°C	
Relative humidity Operation	0 to 95%	
Storage	0 to 95%	
Transport	0 to 95%	

Table 93: 0AC201.91, 4A0006.00-000 - Technical data

3 CFast cards

3.1 5CFAST.xxxx-00

3.1.1 General information

CFast cards are based on Single Level Cell (SLC) technology and are SATA 2.6 compatible. The dimensions are identical to CompactFlash cards.

3.1.2 Order data

Model number	Short description	Figure
5CFAST.2048-00	CFast 2 GB	Image not found for 5CFAST.2048-00!
5CFAST.4096-00	CFast 4 GB	
5CFAST.8192-00	CFast 8 GB	
5CFAST.016G-00	CFast 16 GB	
5CFAST.032G-00	CFast 32 GB	

Table 94: 5CFAST.2048-00, 5CFAST.4096-00, 5CFAST.8192-00, 5CFAST.016G-00, 5CFAST.032G-00 - Order data

3.1.3 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those specified for the entire device.

Product ID	5CFAST.2048-00	5CFAST.4096-00	5CFAST.8192-00	5CFAST.016G-00	5CFAST.032G-00
General information					
Capacity	2 GB	4 GB	8 GB	16 GB	32 GB
Data retention			10 years		
Data reliability			< 1 unrecoverable error in 10 ¹⁴ bit read accesses		
Lifetime monitoring			Yes		
MTBF			> 2,500,000 hours (at 25°C)		
Maintenance			None		
Supported operating modes	SATA 2.6, max. PIO Mode 4, Multiword DMA Mode 2, Ultra DMA Mode 6				
Continuous reading					
Typical					
With 128 kB block size	56 MB/s	107 MB/s	116 MB/s	116 MB/s	116 MB/s
With 4 kB block size	23 MB/s	26 MB/s	29 MB/s	29 MB/s	29 MB/s
Maximum					
With 128 kB block size	60 MB/s	110 MB/s	120 MB/s	120 MB/s	120 MB/s
With 4 kB block size	25 MB/s	30 MB/s	35 MB/s	35 MB/s	35 MB/s
Continuous writing					
Typical					
With 128 kB block size	24 MB/s	49 MB/s	93 MB/s	93 MB/s	93 MB/s
With 4 kB block size	17 MB/s	19 MB/s	21 MB/s	21 MB/s	21 MB/s
Maximum					
With 128 kB block size	30 MB/s	55 MB/s	100 MB/s	100 MB/s	100 MB/s
With 4 kB block size	20 MB/s	25 MB/s	25 MB/s	25 MB/s	25 MB/s
Certification					
CE	Yes				
Endurance					
SLC Flash	Yes				
Wear leveling	Static				
S.M.A.R.T. Support	Yes				
Support					
Hardware	APC910				
Operating systems					
Windows 7 32-bit	No	No	No	Yes	Yes
Windows 7 64-bit	No	No	No	No	Yes
Windows Embedded Standard 7, 32-bit	No	No	No	Yes	Yes
Windows Embedded Standard 7, 64-bit	No	No	No	Yes	Yes
Windows XP Professional	No	Yes	Yes	Yes	Yes
Windows Embedded Standard 2009			Yes		
Software					
PVI Transfer	≥ V4.0.0.8 (part of PVI Development Setup ≥ V3.0.2.3014)				
B&R Embedded OS Installer	≥ V3.10	≥ V3.10	≥ V3.10	≥ V3.20	≥ V3.21
Environmental conditions					

Table 95: 5CFAST.2048-00, 5CFAST.4096-00, 5CFAST.8192-00, 5CFAST.016G-00, 5CFAST.032G-00 - Technical data

Product ID	5CFAST.2048-00	5CFAST.4096-00	5CFAST.8192-00	5CFAST.016G-00	5CFAST.032G-00
Temperature				0 to 70°C	
Operation			-50 to 100°C		
Storage			-50 to 100°C		
Transport					
Relative humidity			Max. 85% at 70°C		
Operation			Max. 85% at 70°C		
Storage			Max. 85% at 70°C		
Transport					
Vibration			20 g peak, 10 to 2000 Hz		
Operation			20 g peak, 10 to 2000 Hz		
Storage			20 g peak, 10 to 2000 Hz		
Transport					
Shock			1.5 kg peak, 0.5 ms		
Operation			1.5 kg peak, 0.5 ms		
Storage			1.5 kg peak, 0.5 ms		
Transport					
Altitude			TBD		
Operation					
Mechanical characteristics					
Dimensions					
Width			42.8 ±0.10mm		
Length			36.4 ±0.10mm		
Depth			3.6 ±0.10mm		
Weight			10 g		

Table 95: 5CFAST.2048-00, 5CFAST.4096-00, 5CFAST.8192-00, 5CFAST.016G-00, 5CFAST.032G-00 - Technical data

3.1.4 Dimensions

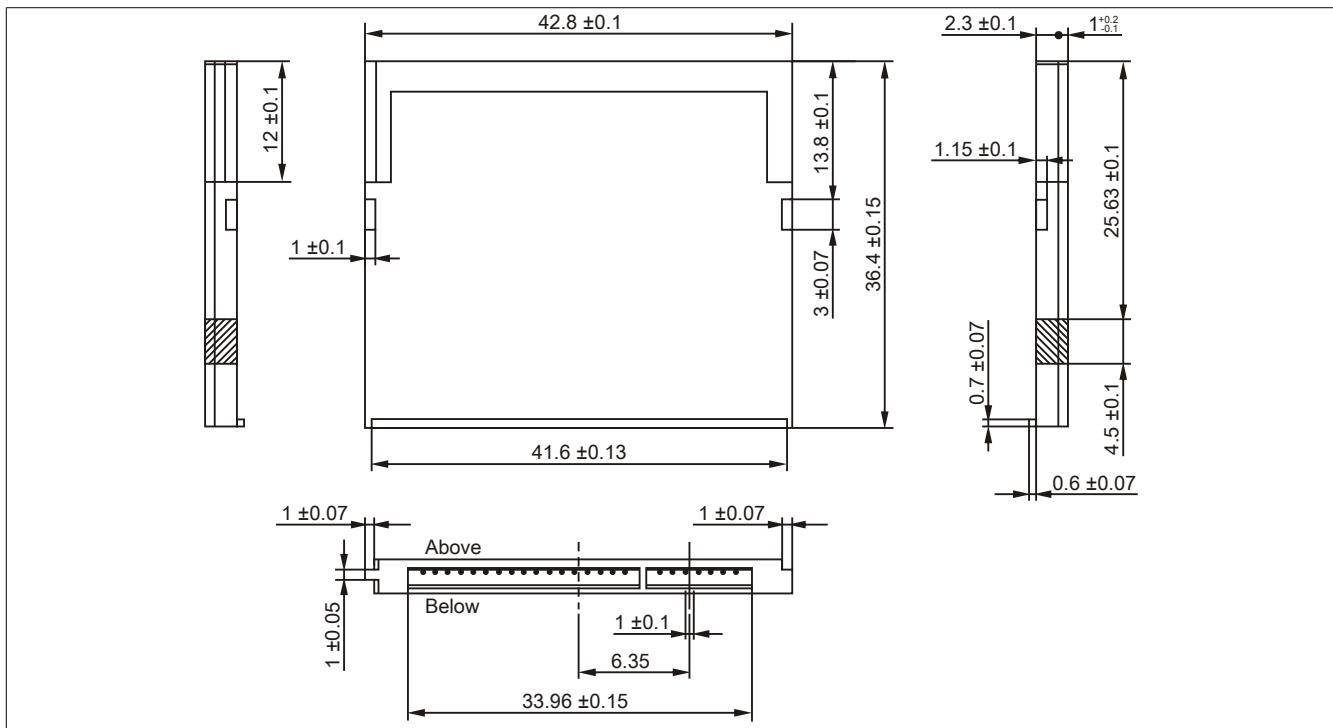


Figure 37: Dimensions – CFast card

3.1.5 Temperature humidity diagram

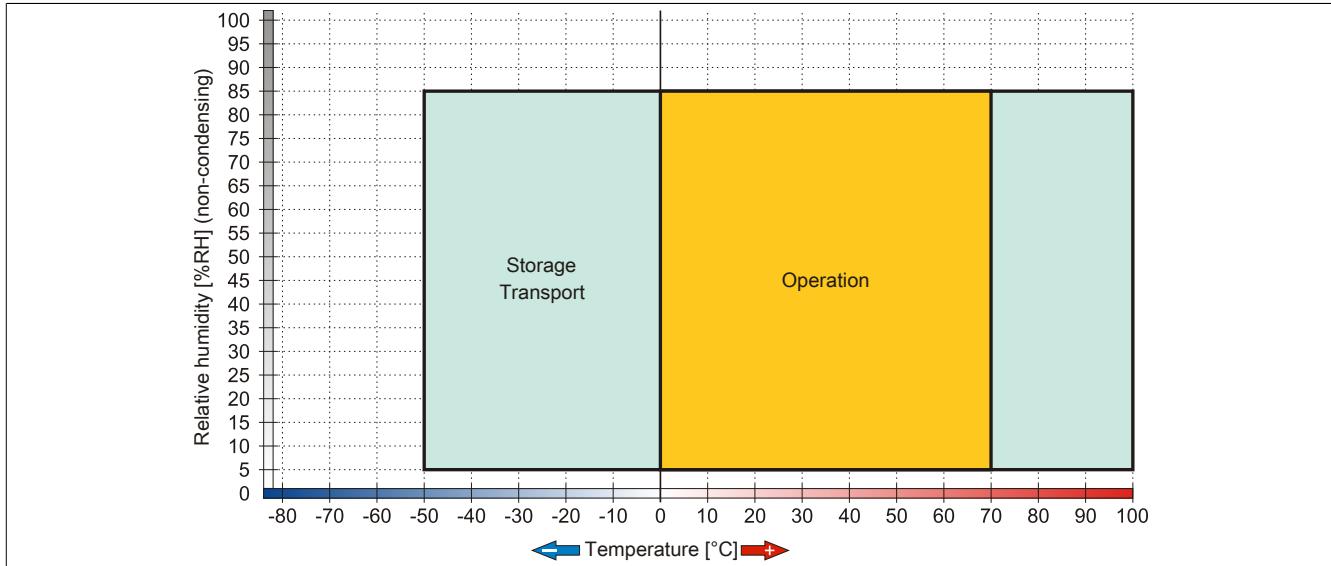


Figure 38: 5CFAST.xxxx-00 - Temperature humidity diagram

4 USB flash drive

4.1 5MMUSB.2048-01

4.1.1 General information

USB flash drives are storage media that are easy to replace. Because of their fast data transfer (USB 2.0), USB flash drives are ideal for use as portable data storage. Without requiring additional drivers ("Hot Plug & Play" - except with Windows 98SE), the USB flash drive can immediately act as an additional drive where data can be read or written.

Information:

We reserve the right to supply alternative products due to the vast quantity of USB flash drives available on the market and their corresponding short product lifecycle. Therefore, the following measures might be necessary in order to boot from these flash drives:

- The flash drive must be reformatted or in some cases even re-partitioned (set active partition).
 - The flash drive must be at the top of the BIOS boot order, or alternatively the IDE controllers can also be deactivated in the BIOS. This can be avoided in most cases if a "fdisk /mbr" command is also executed on the USB flash drive.
- USB 1.1, USB 2.0
 - High transfer rate
 - High data storage
 - Ambient temperature during operation: 0 to 70°C

4.1.2 Order data

Model number	Short description	Figure
	USB accessories	
5MMUSB.2048-01	USB 2.0 flash drive 2048 MB B&R	 Perfection in Automation 

Table 96: 5MMUSB.2048-01 - Order data

4.1.3 Technical data

Product ID	5MMUSB.2048-01
General information	
Data retention	> 10 years
LEDs	1 LED (green), signals data transfer (send and receive) ¹⁾
MTBF	> 3,000,000 hours
Type	USB 1.1, USB 2.0
Maintenance	None
Certification CE	Yes
Interfaces	
USB	Type: USB 1.1, USB 2.0 Connection: To each USB type A interface Transfer rate: Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) Sequential reading: Max. 31 MB/s Sequential writing: Max. 30 MB/s
Support	
Operating systems	
Windows 7	Yes
Windows XP Professional	Yes
Windows XP Embedded	Yes
Windows ME	Yes
Windows 2000	Yes
Windows CE 5.0	Yes
Windows CE 4.2	Yes
Electrical characteristics	
Power consumption	Max. 500 µA sleep mode, max. 120 mA read/write
Environmental conditions	
Temperature	

Table 97: 5MMUSB.2048-01 - Technical data

Product ID	5MMUSB.2048-01
Operation	0 to 70°C
Storage	-50 to 100°C
Transport	-50 to 100°C
Relative humidity	
Operation	85%, non-condensing
Storage	85%, non-condensing
Transport	85%, non-condensing
Vibration	
Operation	20 to 2000 Hz: 20 g (peak)
Storage	20 to 2000 Hz: 20 g (peak)
Transport	20 to 2000 Hz: 20 g (peak)
Shock	
Operation	Max. 1500 g (peak)
Storage	Max. 1500 g (peak)
Transport	Max. 1500 g (peak)
Altitude	
Operation	Max. 3048 m
Storage	Max. 12192 m
Transport	Max. 12192 m
Mechanical characteristics	
Dimensions	
Width	17.97 mm
Length	67.85 mm
Height	8.35 mm

Table 97: 5MMUSB.2048-01 - Technical data

- 1) Signals data transfer (send and receive).

4.1.4 Temperature humidity diagram

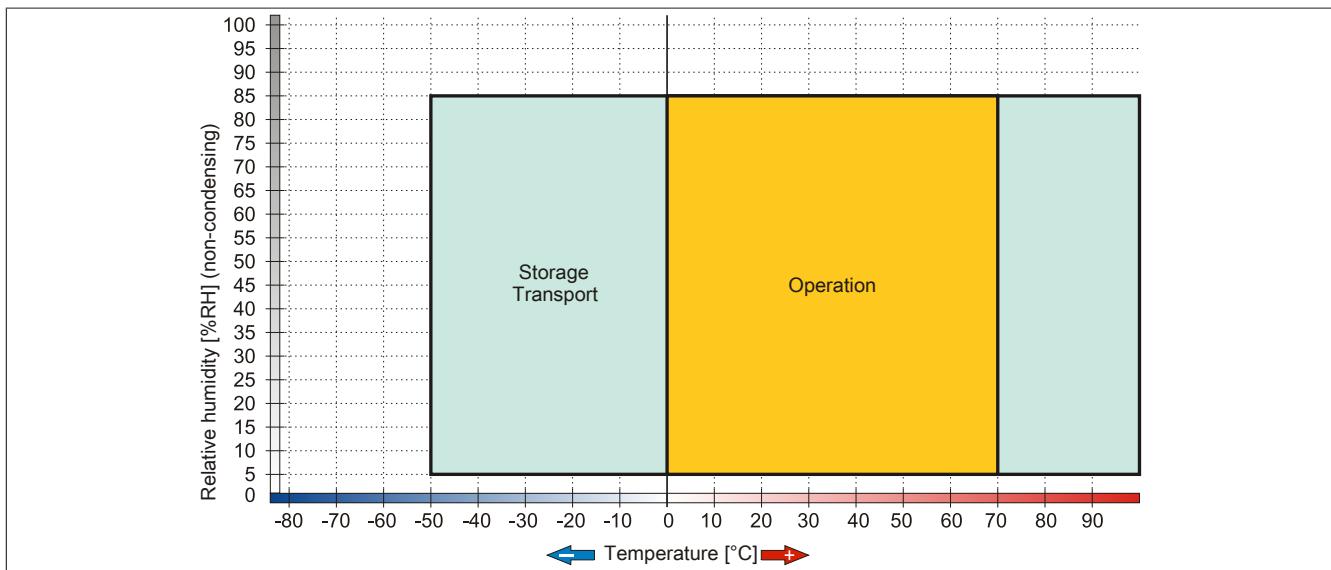


Figure 39: 5MMUSB.2048-01 - Temperature humidity diagram

5 USB Media Drive

5.1 5MD900.USB2-02

5.1.1 General information

The USB Media Drive features a DVD-R/RW DVD+R/RW drive, a CompactFlash slot and a USB port on the front and back sides. It is connected to the USB port on the B&R industrial PC.

- Desk-top or rack-mount operation (mounting rail brackets)
- Integrated DVD-R/RW DVD+R/RW drive
- Integrated CompactFlash slot IDE/ATAPI (Hot Plug capable)
- Integrated USB 2.0 connection
- +24 VDC supply (back side)
- USB 2.0 connection (back side)
- Optional front cover

5.1.2 Order data

Model number	Short description	Figure
	USB accessories	
5MD900.USB2-02	USB 2.0 Drives DVD-R/RW DVD+R/RW, CompactFlash slot (type II), USB connector (type A on front side, type B on back side); 24 VDC; (OTB103.9 screw clamp or OTB103.91 cage clamp must be ordered separately).	
	Required accessories	
	Other	
5SWUTI.0000-00	OEM Nero CD-RW Software, only available with a CD writer.	
	Terminal blocks	
0TB103.9	Connector, 24 VDC, 3-pin female, screw clamps 3.31 mm ² , protected against vibration by the screw flange	
0TB103.91	Connector, 24 VDC, 3-pin female, cage clamps 3.31 mm ² , protected against vibration by the screw flange	
	USB cable	
5CAUSB.0018-00	USB 2.0 connecting cable type A - type B, 1.8 m.	
5CAUSB.0050-00	USB 2.0 connecting cable type A - type B, 5 m.	

Table 98: 5MD900.USB2-02 - Order data

5.1.3 Interfaces

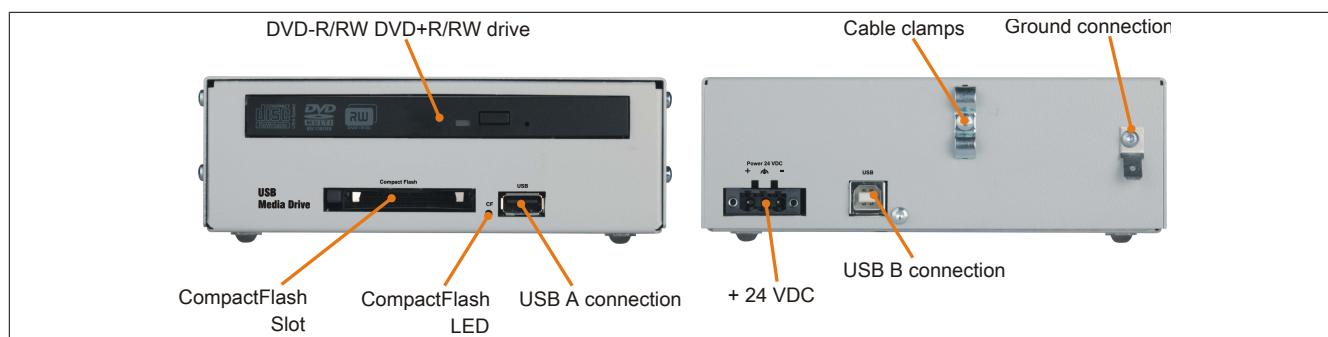


Figure 40: 5MD900.USB2-02 - Interfaces

5.1.4 Technical data

Product ID	5MD900.USB2-02
General information	
Max. cable length	5m (not including hub)
Certification	
CE	Yes
c-UL-us	Yes
Interfaces	
CompactFlash slot 1	
Type	Type I
Connection	IDE/ATAPI
Activity LED	Signals read or write access to an inserted CompactFlash card

Table 99: 5MD900.USB2-02 - Technical data

Product ID		5MD900.USB2-02
USB	Type Design	USB 2.0 Type A front Type B back
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), high speed (480 Mbit/s)	
Current load	Max. 500 mA	
CD / DVD drive		
Data buffer capacity	2 MB	
Data transfer rate	Max. 33.3 MB/s	
Speed	Max. 5090 rpm ±1%	
Noise level	Approx. 45 dBA in a distance of 50 cm (full read access)	
Compatible formats	CD-DA, CD-ROM mode 1 mode 2 CD-ROM XA mode 2 (form 1, form 2) Photo CD (single/multi-session), Enhanced CD, CD text DVD-ROM, DVD-R, DVD-RW, DVD-Video DVD-RAM (4.7GB, 2.6GB) DVD+R, DVD+R (double layer), DVD+RW	
Laser class	Class 1 laser	
Lifespan	60000 POH (Power-On Hours)	
Interface	IDE (ATAPI)	
Startup time		
CD	Max. 14 seconds (0 rpm to read access)	
DVD	Max. 15 seconds (0 rpm to read access)	
Access time		
CD	Typ. 140 ms (24x)	
DVD	Typ. 150 ms (8x)	
Readable media		
CD	CD/CD-ROM (12 cm, 8 cm), CD-R, CD-RW	
DVD	DVD-ROM, DVD-R, DVD-RW, DVD-RAM, DVD+R, DVD+R (double layer), DVD+RW	
Non-write protected media		
CD	CD-R, CD-RW	
DVD	DVD-R/RW, DVD-RAM (4.7 GB), DVD+R/RW, DVD+R (double layer)	
Reading rate		
CD	24x	
DVD	8x	
Write speed		
CD-R	10 to 24x	
CD-RW	10 to 24x	
DVD+R	3.3 to 8x	
DVD+R (Double Layer)	2.4 to 4x	
DVD+RW	3.3 to 8x	
DVD-R	2 to 6x	
DVD-R (Double Layer)	2 to 4x	
DVD-RAM	3 to 5x	
DVD-RW	2 to 6x	
Write-methods		
CD	Disk at once, session at once, packet write, track at once	
DVD	Disk at once, incremental, over-write, sequential	
Electrical characteristics		
Nominal voltage	24 VDC ±25%	
Operating conditions		
EN 60529 protection	IP65 front side (only with optional front cover), IP20 back side	
Environmental conditions		
Temperature ¹⁾		
Operation	5 to 45°C	
Storage	-20 to 60°C	
Transport	-40 to 60°C	
Relative humidity		
Operation	20 to 80%	
Storage	5 to 90%	
Transport	5 to 95%	
Vibration		
Operation	5 to 500 Hz: 0.3 g (2.9 m/s ² 0-peak)	
Storage	10 to 100 Hz: 2 g (19.6 m/s ² 0-peak)	
Transport	10 to 100 Hz: 2 g (19.6 m/s ² 0-peak)	
Shock		
Operation	5 g, 11 ms	
Storage	60 g, 11 ms	
Transport	60 g, 11 ms	
Altitude		
Operation	Max. 3000 m	
Mechanical characteristics		
Dimensions		

Table 99: 5MD900.USB2-02 - Technical data

Product ID	5MD900.USB2-02
Width	156 mm
Height	52 mm
Depth	140 mm
Weight	Approx. 1100 g (without front cover)

Table 99: 5MD900.USB2-02 - Technical data

1) Temperature data is for operation at 500 meters. Derating the max. ambient temperature - typically 1 °C per 1000 meters (from 500 meters above sea level).

5.1.5 Dimensions

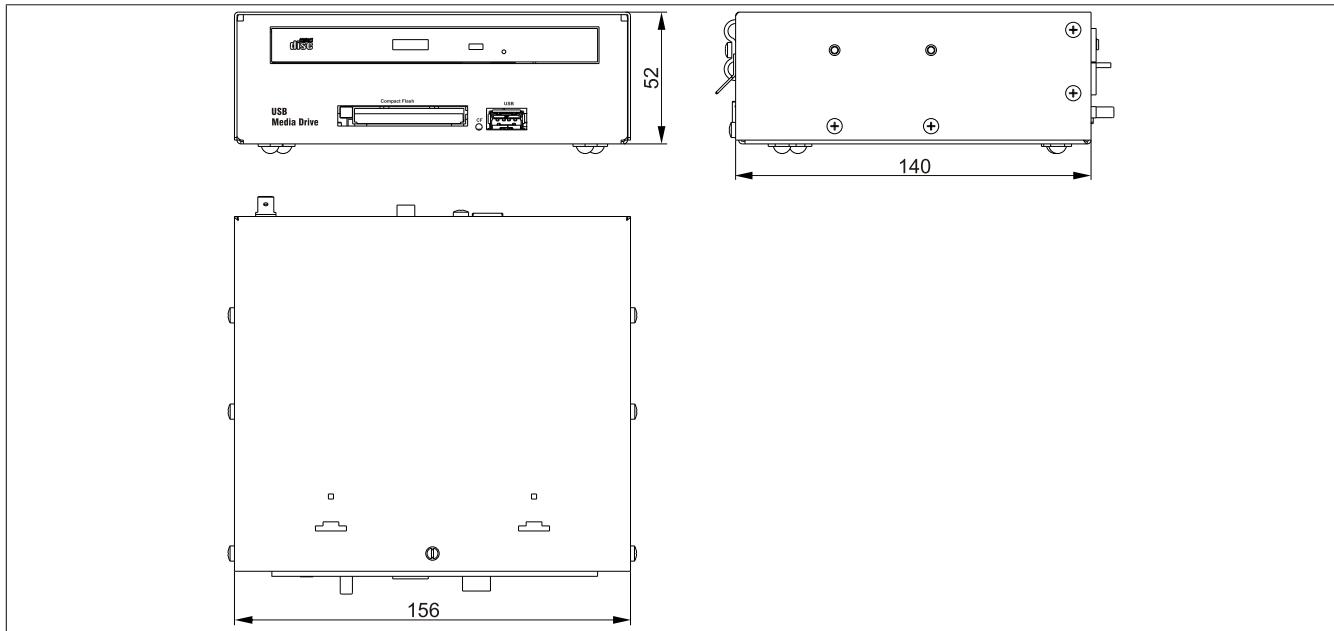


Figure 41: 5MD900.USB2-02 - Dimensions

5.1.6 Dimensions with front cover

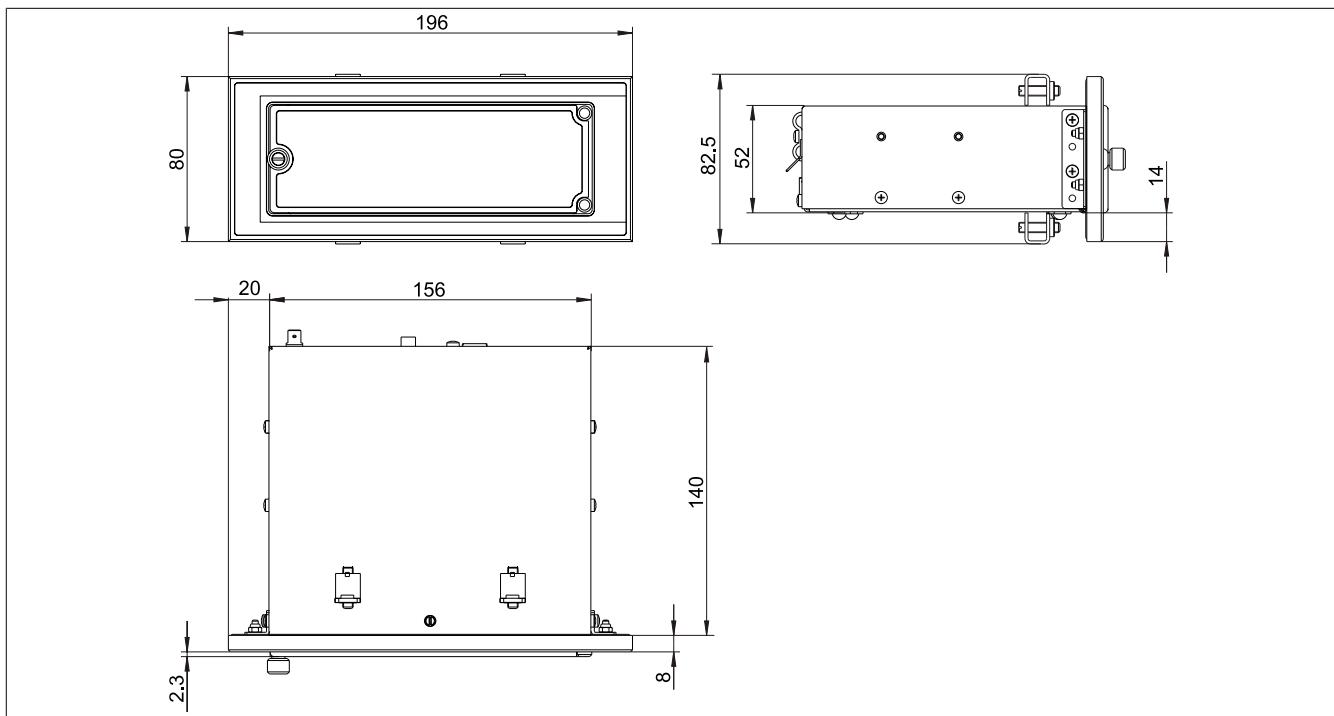


Figure 42: Dimensions - USB Media Drive with front cover

5.1.7 Cutout installation

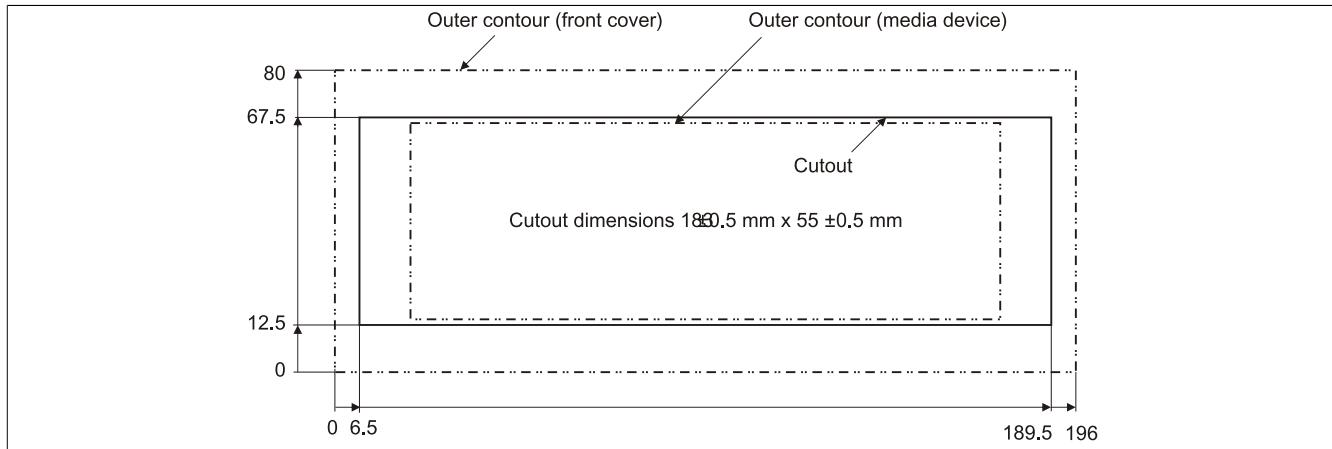


Figure 43: Installation cutout - USB Media Drive with front cover

5.1.8 Contents of delivery

Quantity	Component
1	USB Media Drive complete unit
2	Mounting rail brackets

Table 100: 5MD900.USB2-02 - Contents of delivery

5.1.9 Installation

The USB Media Drive can be operated as a desk-top device (rubber feet) or as a rack-mount device (2 mounting rail brackets included).

Mounting orientation

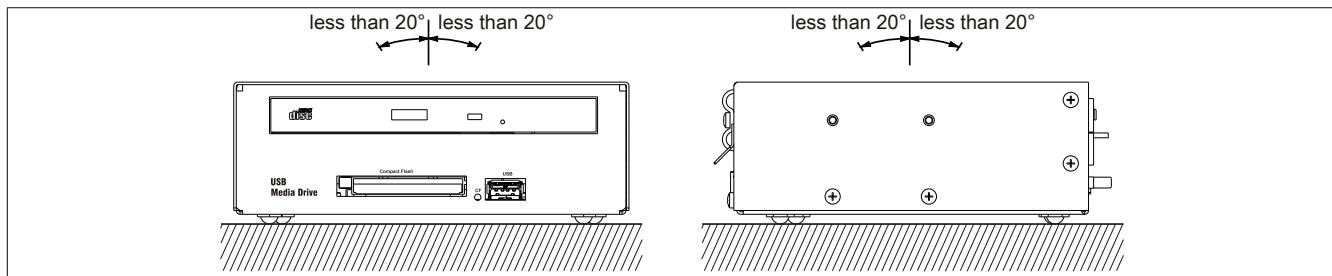


Figure 44: 5MD900.USB2-02 - Mounting orientation

5.2 5A5003.03

5.2.1 General information

This front cover can also be mounted on the front of the USB media drive (model number 5MD900.USB2-00, 5MD900.USB2-01 or 5MD900.USB2-02) to protect the interface.

5.2.2 Order data

Model number	Short description	Figure
	USB accessories	
5A5003.03	Front cover, For Remote CD-ROM Drive 5A5003.02 and USB 2.0 drive combination 5MD900.USB2-00, 5MD900.USB2-01 and 5MD900.USB2-02.	

Table 101: 5A5003.03 - Order data

5.2.3 Technical data

Product ID	5A5003.03
Mechanical characteristics	
Front	
Décor foil	
Light background	Similar to Pantone 427CV
Dimensions	
Width	196 mm
Height	80 mm
Depth	8 mm

Table 102: 5A5003.03 - Technical data

5.2.4 Dimensions

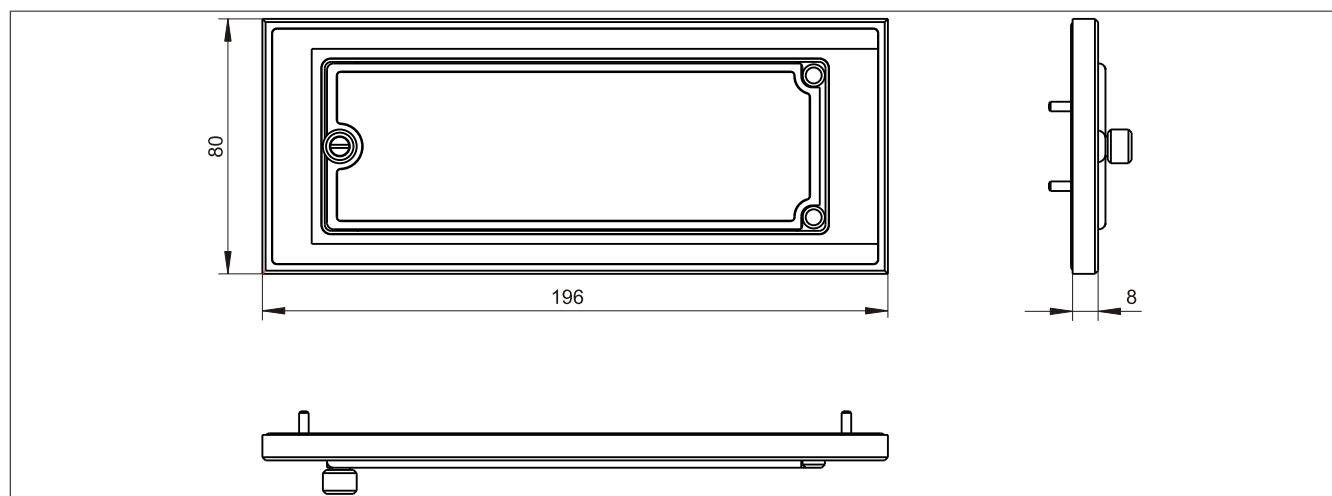


Figure 45: 5A5003.03 - Dimensions

5.2.5 Contents of delivery

Amount	Component
1	Front cover 5A5003.03 for the USB Media Drive
4	M3 locknut
4	Cover retaining clip

Table 103: 5A5003.03 - Contents of delivery

5.2.6 Installation

The front cover is attached with 2 mounting rail brackets (included with USB Media Drive) and 4 M3 locknuts. The USB media drive and front cover can be mounted as a whole in (for example) a switching cabinet door.

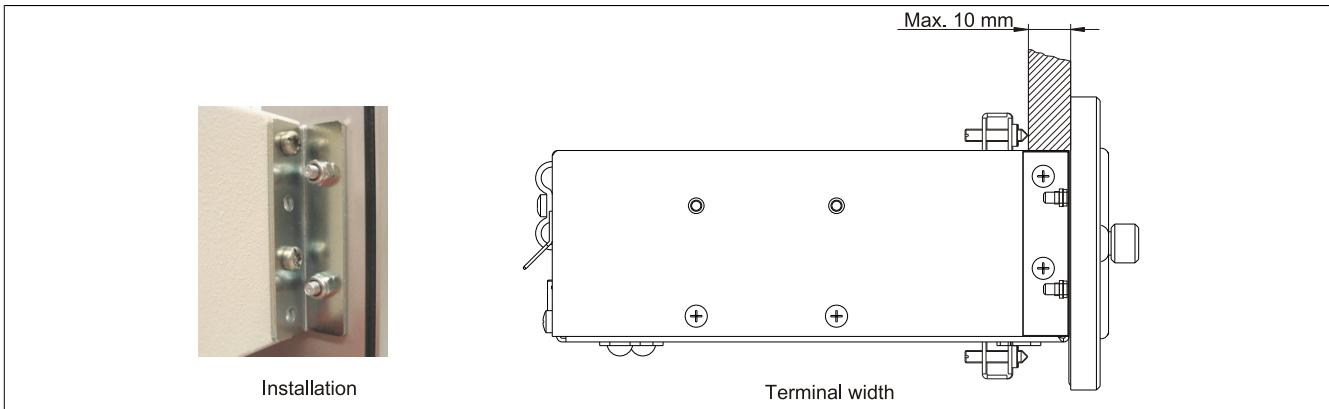


Figure 46: Front cover mounting and installation depth

Cutout installation

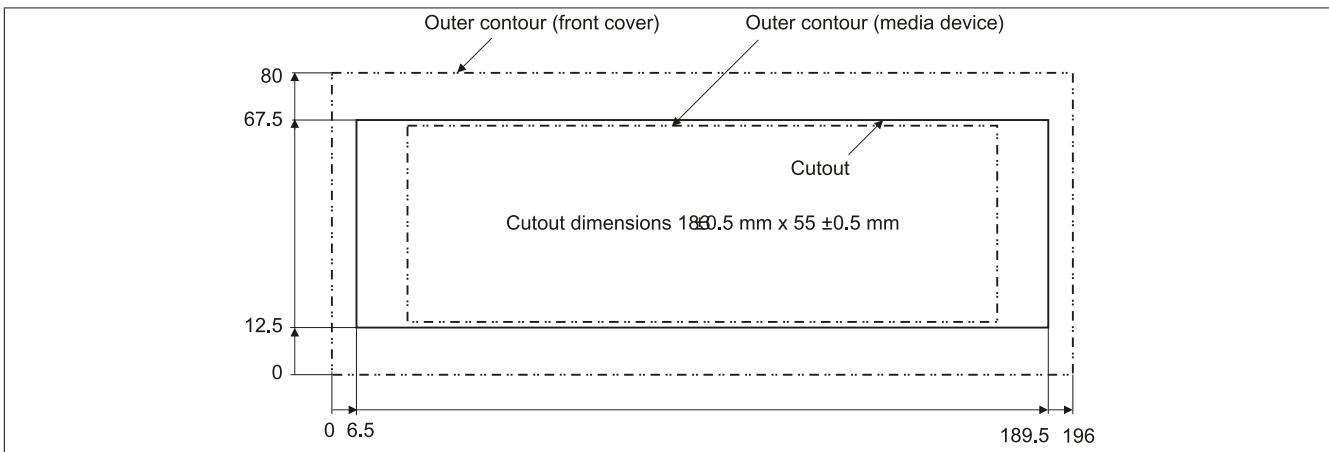


Figure 47: Installation cutout - USB Media Drive with front cover

6 Cables

6.1 DVI cables

6.1.1 5CADVI.0xxx-00

General information

The DVI cables 5CADVI.0xxx-00 are designed for fixed layout.

Caution!

Cable can only be plugged in and unplugged when the device is turned off.

Order data

Model number	Short description	Figure
	DVI cable	
5CADVI.0018-00	DVI-D cable, 1.8 m.	
5CADVI.0050-00	DVI-D cable, 5 m.	
5CADVI.0100-00	DVI-D cable, 10 m.	

Table 104: 5CADVI.0018-00, 5CADVI.0050-00, 5CADVI.0100-00 - Order data

Technical data

Product ID	5CADVI.0018-00	5CADVI.0050-00	5CADVI.0100-00
General information			
Certification			
CE		Yes	
c-UL-us		Yes	
Cable structure			
Wire cross section		AWG 28	
Shield		Individual cable pairs and entire cable	
Cable shielding	Tinned CU mesh, optical coverage >86%		Tinned Cu mesh, optical coverage >86%
Outer sheathing			
Material	PVC		
Color	Beige		
Labeling	AWM STYLE 20276 80°C 30V VW1 DVI DIGITAL SINGLE LINK DER AN		
Connector			
Type	2x DVI-D (18+1), male		
Connection cycles	100		
Electrical characteristics			
Conductor resistance	Max. 237 Ω/km		
Insulation resistance	Min. 100 MΩ/km		
Mechanical characteristics			
Dimensions			
Length	1.8 m ±50 mm	5 m ± 80 mm	10 m ±100 mm
Diameter		Max. 8.5 mm	
Flex radius	≥ 5x cable diameter (plug - ferrite magnet and ferrite magnet - ferrite magnet)		
Weight	Approx. 260 g	Approx. 460 g	Approx. 790 g

Table 105: 5CADVI.0018-00, 5CADVI.0050-00, 5CADVI.0100-00 - Technical data

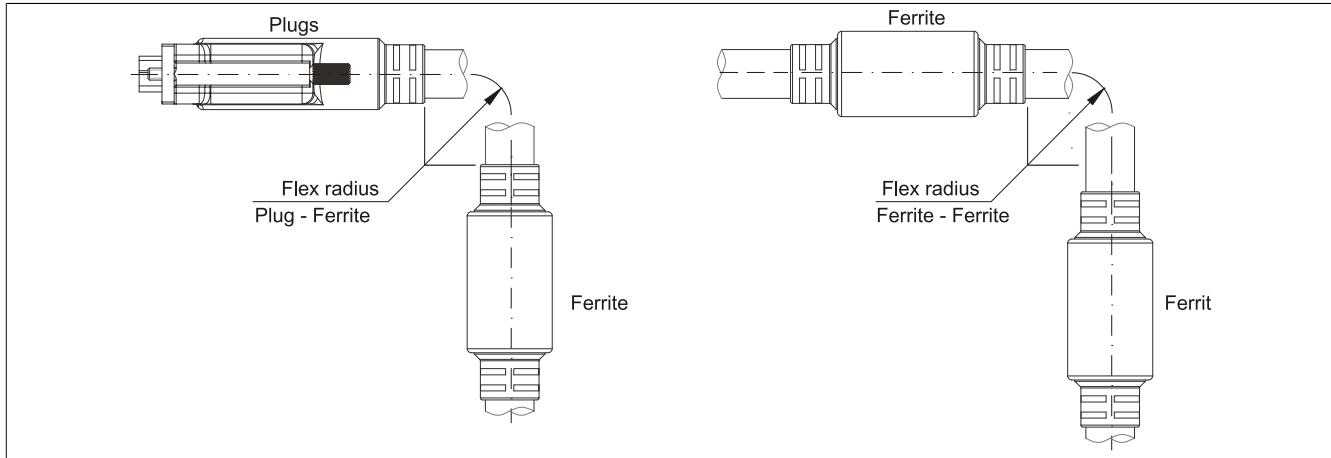
Flex radius specification

Figure 48: Flex radius specification

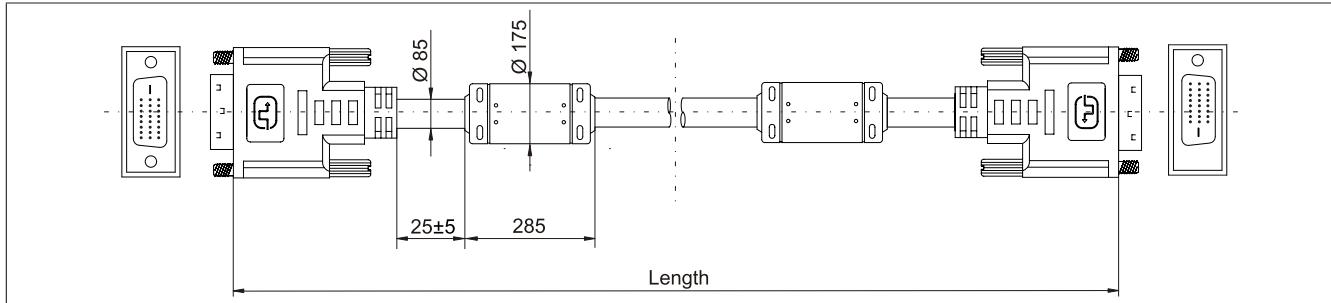
Dimensions

Figure 49: 5CADVI.0xxx-00 - Dimensions

Cable specifications**Warning!**

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

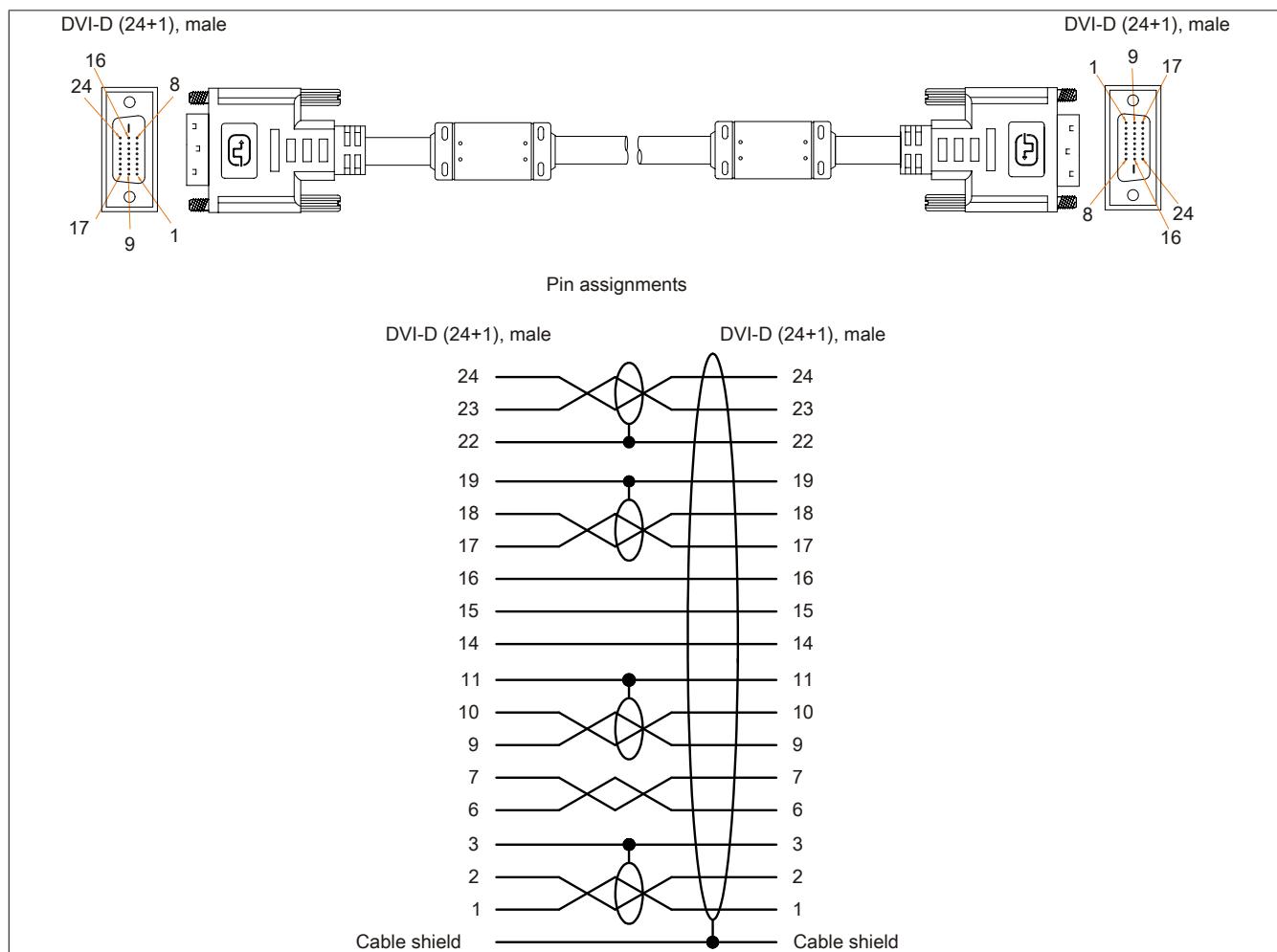


Figure 50: 5CADVI.0xxx-00 - Pinout

6.2 SDL cables

6.2.1 5CASDL.0xxx-00

General information

The SDL cables 5CASDL.0xxx-00 are designed for fixed layout. Use of the SDL flex cable 5CASDL.0xxx-03 is required for a flexible installation (e.g. in swing arm systems).

Caution!

Cable can only be plugged in and unplugged when the device is turned off.

Order data

Model number	Short description	Figure
5CASDL.0018-00	SDL cable, 1.8 m.	
5CASDL.0050-00	SDL cable, 5 m.	
5CASDL.0100-00	SDL cable, 10 m.	
5CASDL.0150-00	SDL cable, 15 m.	
5CASDL.0200-00	SDL cable, 20 m.	
5CASDL.0250-00	SDL cable, 25 m.	
5CASDL.0300-00	SDL cable, 30 m.	

Table 106: 5CASDL.0018-00, 5CASDL.0050-00, 5CASDL.0100-00, 5CASDL.0150-00, 5CASDL.0200-00, 5CASDL.0250-00, 5CASDL.0300-00 - Order data

Technical data

Product ID	5CASDL.0018-00	5CASDL.0050-00	5CASDL.0100-00	5CASDL.0150-00	5CASDL.0200-00	5CASDL.0250-00	5CASDL.0300-00
General information							
Certification CE c-UL-us				Yes	Yes		
Cable structure							
Wire cross section	AWG 28		AWG 24				
Shield			Individual cable pairs and entire cable				
Cable shielding			Tinned Cu mesh, optical coverage >85%				
Outer sheathing Material Color Labeling			PVC Black E74020-C (UL) AWM STYLE 20176 80°C 30V VW-1 DVI DIGITAL LINK				
Connector							
Type			2x DVI-D (24+1), male				
Connection cycles			100				
Contacts			Gold plated				
Mechanical protection			Metal cover with crimped stress relief				
Electrical characteristics							
Conductor resistance AWG 24 AWG 28	-	$\leq 237 \Omega/\text{km}$		$\leq 93 \Omega/\text{km}$	-		
Insulation resistance			Min. 10 MΩ/km				
Mechanical characteristics							
Dimensions Length Diameter	1.8 m ± 30 mm Typ. 8.6 ± 0.2 mm Max. 9 mm	5 m ± 30 mm Typ. 8.6 ± 0.2 mm Max. 9 mm	10 m ± 50 mm Typ. 11 ± 0.2 mm Max. 11.5 mm	15 m ± 100 mm Typ. 11 ± 0.2 mm Max. 11.5 mm	20 m ± 100 mm Typ. 11 ± 0.2 mm Max. 11.5 mm	25 m ± 100 mm Typ. 11 ± 0.2 mm Max. 11.5 mm	30 m ± 100 mm Typ. 11 ± 0.2 mm Max. 11.5 mm
Flex radius	≥ 5 x cable diameter (plug - ferrite magnet and ferrite magnet - ferrite magnet)						
Flexibility	Limited flexibility; valid for ferrite magnet - ferrite magnet (tested 100 cycles with 5x cable diameter, 20 cycles / minute)						
Weight	Approx. 300 g	Approx. 580 g	Approx. 1500 g	Approx. 2250 g	Approx. 2880 g	Approx. 4800 g	Approx. 5520 g

Table 107: 5CASDL.0018-00, 5CASDL.0050-00, 5CASDL.0100-00, 5CASDL.0150-00, 5CASDL.0200-00, 5CASDL.0250-00, 5CASDL.0300-00 - Technical data

Flex radius specification

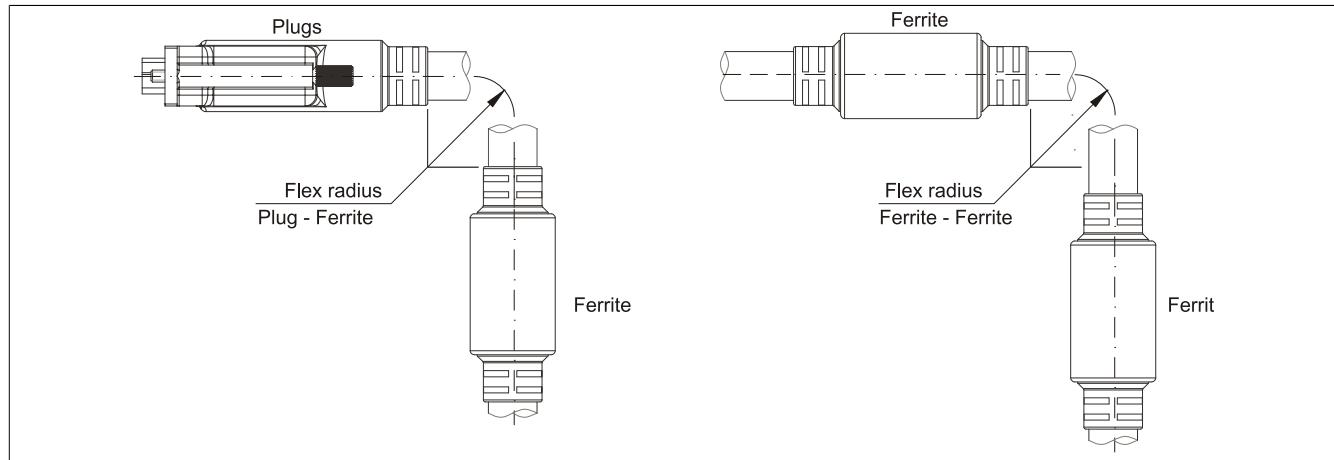


Figure 51: Flex radius specification

Dimensions

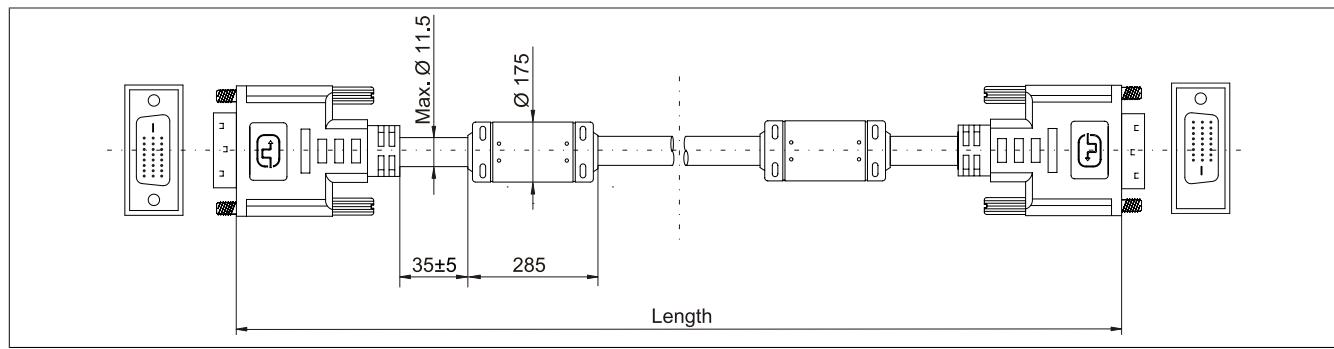


Figure 52: 5CSDL.0xx-00- Dimensions

Cable specifications

Warning!

If you want to build a suitable cable yourself, it should be wired according to these specifications.
If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

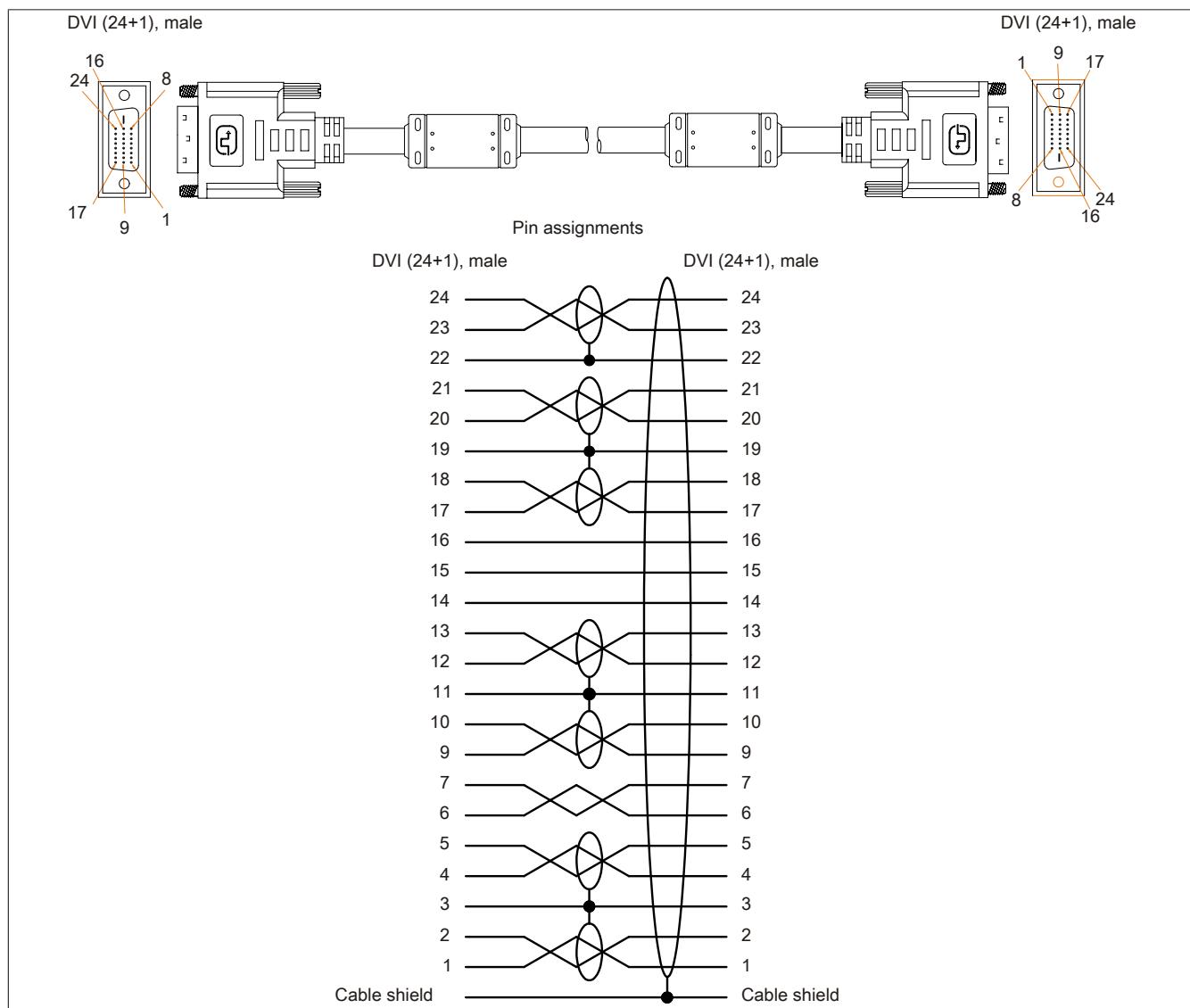


Figure 53: 5CASDL.0xxx-00- Pinout

6.3 SDL cables with 45° plugs

6.3.1 5CSDL.0xxx-01

General information

The 5CSDL.0xxx-01 SDL cables with 45° plug are designed for a fixed layout.

Caution!

Cable can only be plugged in and unplugged when the device is turned off.

Order data

Model number	Short description	Figure
	SDL cable - 45° connector	
5CSDL.0018-01	SDL cable; 45° connector, 1.8 m.	
5CSDL.0050-01	SDL cable; 45° connector, 5 m.	
5CSDL.0100-01	SDL cable; 45° connector, 10 m.	
5CSDL.0150-01	SDL cable; 45° connector, 15 m.	

Table 108: 5CSDL.0018-01, 5CSDL.0050-01, 5CSDL.0100-01, 5CSDL.0150-01 - Order data

Technical data

Product ID	5CSDL.0018-01	5CSDL.0050-01	5CSDL.0100-01	5CSDL.0150-01
General information				
Certification				
CE			Yes	
c-UL-us			Yes	
Cable structure				
Wire cross section	AWG 28		AWG 24	
Shield		Individual cable pairs and entire cable		
Cable shielding		Tinned Cu mesh, optical coverage >85%		
Outer sheathing				
Material		PVC		
Color		Black		
Connector				
Type	2x DVI-D (24+1), male			
Connection cycles		100		
Contacts		Gold plated		
Mechanical protection		Metal cover with crimped stress relief		
Electrical characteristics				
Conductor resistance				
AWG 24	-		≤93 Ω/km	
AWG 28	≤237 Ω/km			-
Insulation resistance		Min. 10 MΩ/km		
Mechanical characteristics				
Dimensions				
Length	1.8 m ±30 mm		5 m ± 50 mm	
Diameter	Max. 9 mm			10 m ±100 mm
				Max. 11.5 mm
Flex radius				
Fixed installation	≥ 5x cable diameter (plug - ferrite magnet and ferrite magnet - ferrite magnet)			
Flexibility	Limited flexibility; valid for ferrite magnet - ferrite magnet (tested 100 cycles with 5x cable diameter, 20 cycles / minute)			
Weight	Approx. 300 g	Approx. 590 g	Approx. 2800 g	Approx. 2860 g

Table 109: 5CSDL.0018-01, 5CSDL.0050-01, 5CSDL.0100-01, 5CSDL.0150-01 - Technical data

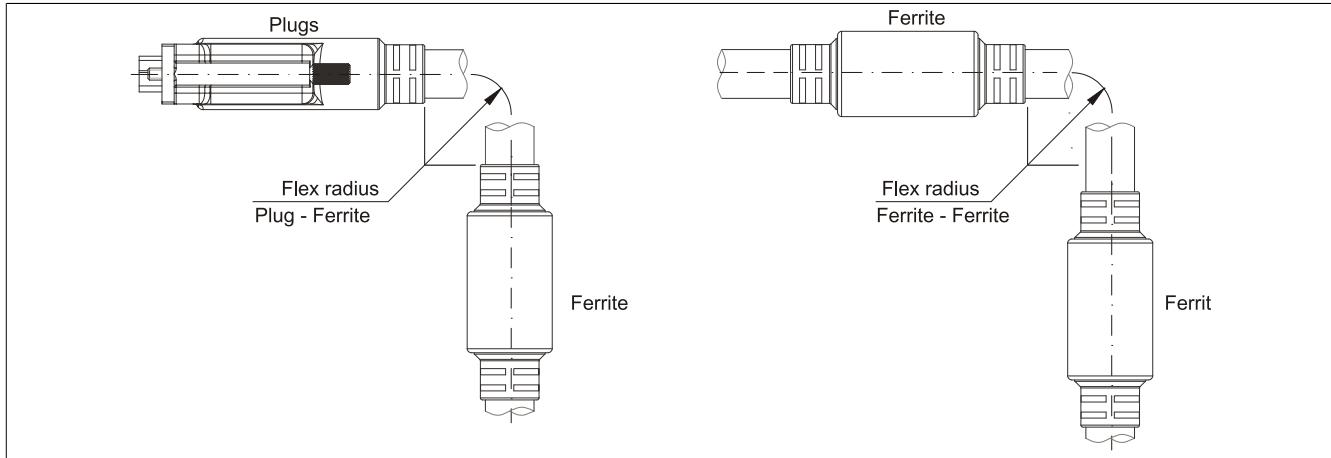
Flex radius specification

Figure 54: Flex radius specification

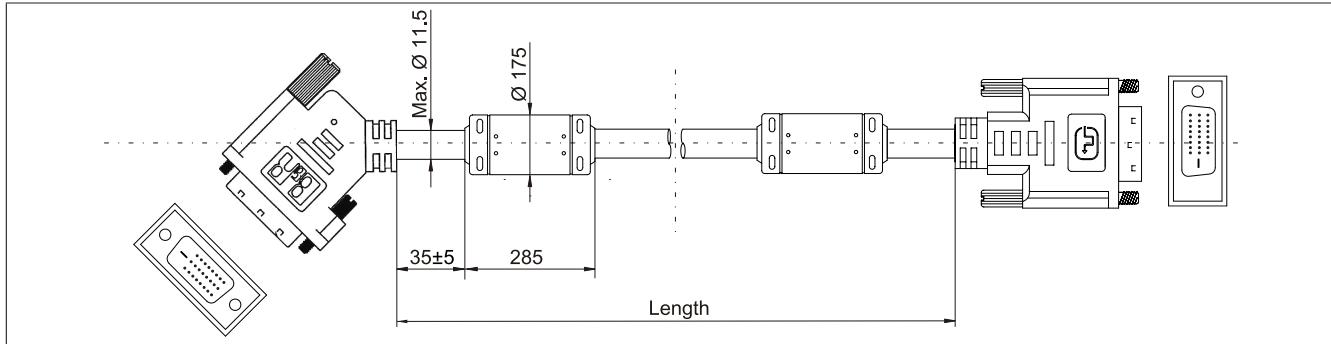
Dimensions

Figure 55: 5CSDL.0xx-01 - Dimensions

Cable specifications**Warning!**

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

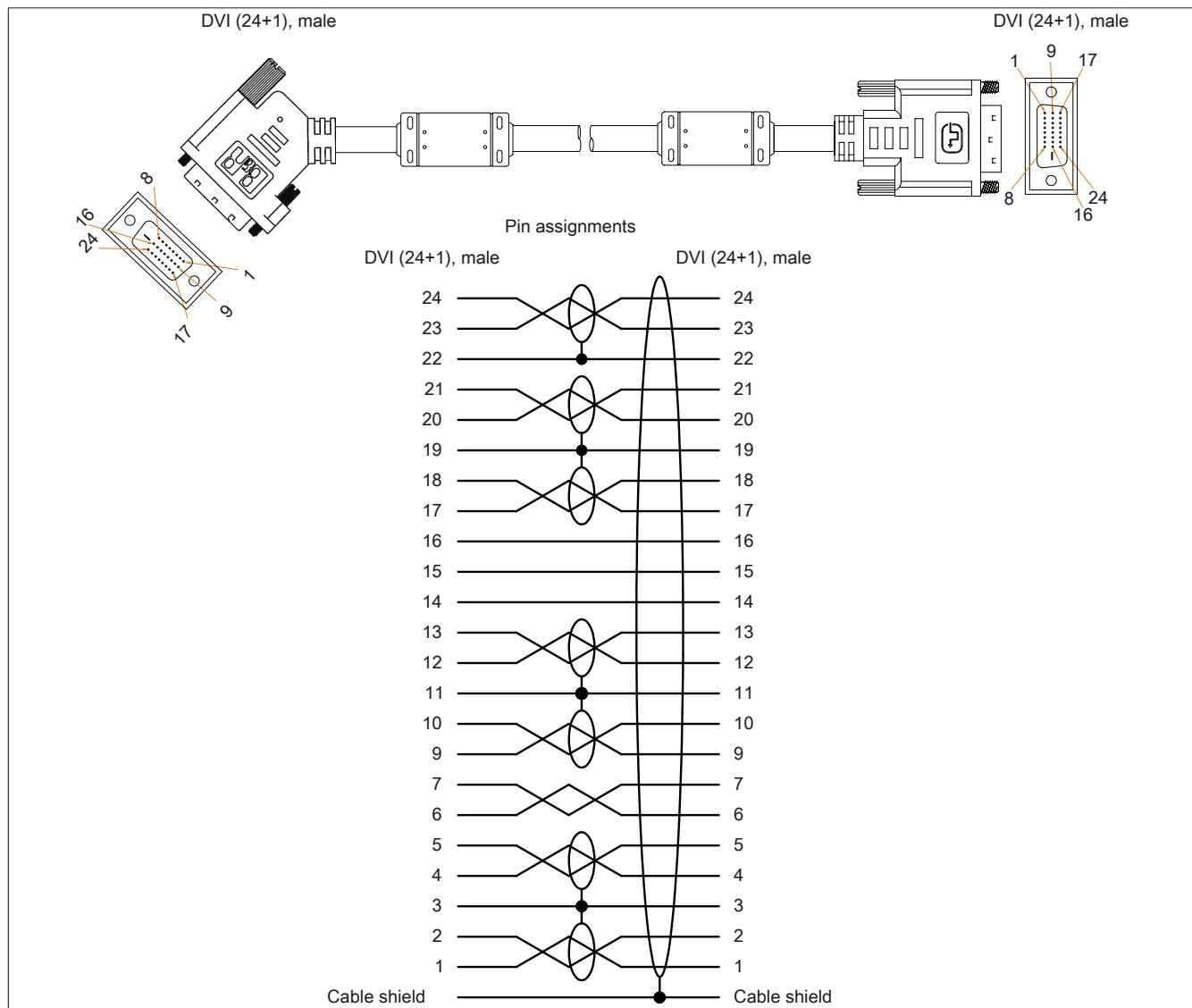


Figure 56: 5CASDL.0xxx-01 - Pinout

6.4 SDL flex cables

6.4.1 5CASDL.0xxx-03

General information

The 5CASDL.0xxx-03 SDL flex cables are designed for use in both fixed and flexible installations (e.g. in swing arm systems).

Caution!

Cable can only be plugged in and unplugged when the device is turned off.

Order data

Model number	Short description	Figure
5CASDL.0018-03	SDL flex cable	
5CASDL.0050-03	SDL cable flex, 1.8 m.	
5CASDL.0100-03	SDL cable flex, 5 m.	
5CASDL.0150-03	SDL cable flex, 10 m.	
5CASDL.0200-03	SDL cable flex, 15 m.	
5CASDL.0250-03	SDL cable flex, 20 m.	
5CASDL.0300-03	SDL cable flex, 25 m.	
5CASDL.0300-03	SDL cable flex, 30 m.	

Table 110: 5CASDL.0018-03, 5CASDL.0050-03, 5CASDL.0100-03, 5CASDL.0150-03, 5CASDL.0200-03, 5CASDL.0250-03, 5CASDL.0300-03 - Order data

Technical data

Product ID	5CASDL.0018-03	5CASDL.0050-03	5CASDL.0100-03	5CASDL.0150-03	5CASDL.0200-03	5CASDL.0250-03	5CASDL.0300-03
General information							
Certification							
CE				Yes			
c-UL-us				Yes			
Cable structure							
Wire cross section				26 AWG (control wires) 26 AWG (DVI, USB, data)			
Features				Free of halogen and silicon			
Shield				Individual cable pairs and entire cable			
Cable shielding				Aluminum foil clad + tinned copper mesh			
Outer sheathing							
Material				Special TMPU - semi gloss			
Color				Black			
Labeling				(B&R) SDL cable (UL) AWM 20236 80°C 30V E 63216			
Connector							
Type				2x DVI-D (24+1), male			
Connection cycles				Min. 200			
Contacts				Gold plated			
Mechanical protection				Metal cover with crimped stress relief			
Electrical characteristics							
Operating voltage				≤30 V			
Test voltage							
Wire/wire				1 kV			
Wire/shield				0.5 kV			
Wave impedance				100 ±10 Ω			
Conductor resistance							
AWG 24				≤95 Ω/km			
AWG 26				≤145 Ω/km			
Insulation resistance				> 200 MΩ/km			
Operating conditions							
Approbation				UL AWM 20236 80°C 30V			
Flame resistant				In accordance with UL758 (cable vertical flame test)			
Oil and hydrolysis resistance				According to VDE 0282-10			
Environmental conditions							
Temperature							
Storage				-20 to 80°C			
Moving				-5 to 60°C			
Fixed installation				-20 to 80°C			

Table 111: 5CASDL.0018-03, 5CASDL.0050-03, 5CASDL.0100-03, 5CASDL.0150-03, 5CASDL.0200-03, 5CASDL.0250-03, 5CASDL.0300-03 - Technical data

Product ID	5CASDL. 0018-03	5CASDL. 0050-03	5CASDL. 0100-03	5CASDL. 0150-03	5CASDL. 0200-03	5CASDL. 0250-03	5CASDL. 0300-03
Mechanical characteristics							
Dimensions Length Diameter	1.8 m ±20 mm 5 m ± 45 mm 10 m ±90 mm 15 m ±135 mm 20 m ± 180 mm 25 m ± 225 mm 30 m ± 270 mm Max. 12 mm						
Flex radius Fixed installation flexible installation	\geq 6x cable diameter (from plug - ferrite magnet) \geq 10x cable diameter (from ferrite magnet - ferrite magnet) \geq 15x cable diameter (from ferrite magnet - ferrite magnet)						
Flexibility	Flexible; valid for ferrite magnet - ferrite magnet (tested 300,000 cycles with 15x cable diameter, 4800 cycles / hour)						
Drag chain data Flex cycles Speed Flex radius Hub	300.000 4800 cycles / hour 180 mm; 15x cable diameter 460 mm						
Weight	Approx. 460 g	Approx. 1020 g	Approx. 1940 g	Approx. 2840 g	Approx. 3740 g	Approx. 4560 g	Approx. 5590 g
Tension In operation During installation	\leq 50 N \leq 400 N						

Table 111: 5CASDL.0018-03, 5CASDL.0050-03, 5CASDL.0100-03, 5CASDL.0150-03,
5CASDL.0200-03, 5CASDL.0250-03, 5CASDL.0300-03 - Technical data

Flex radius specification

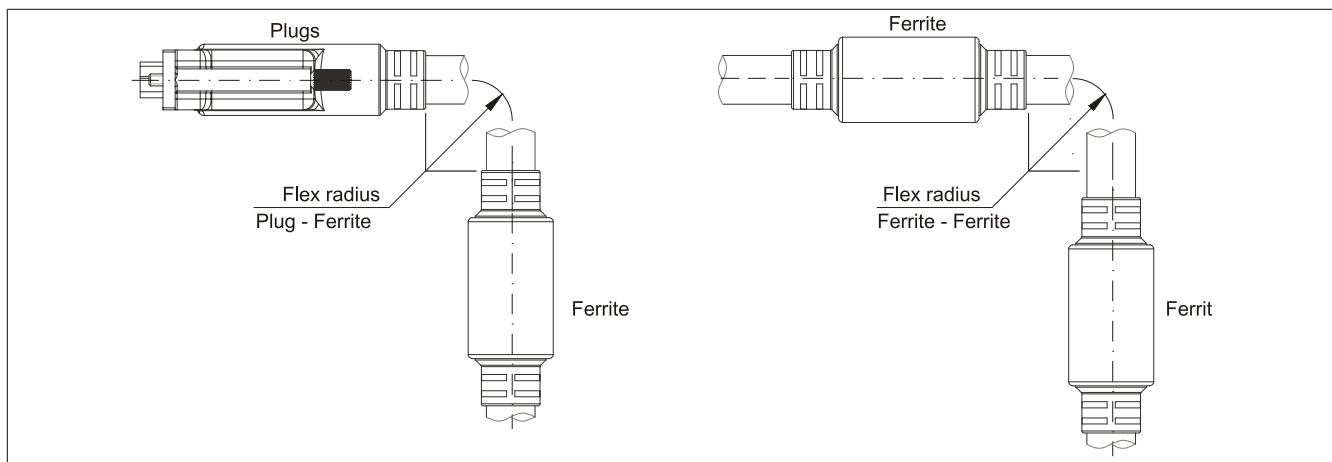


Figure 57: Flex radius specification

Dimensions

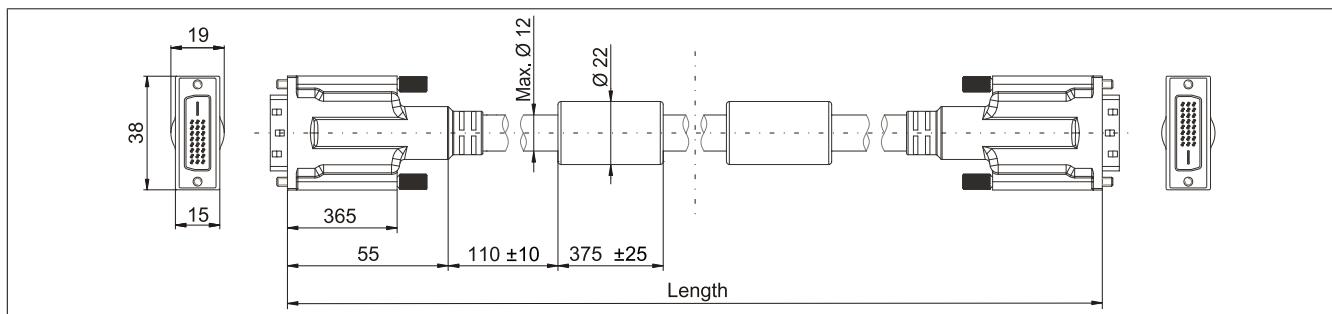


Figure 58: 5CASDL.0xx-03 - Dimensions

Layout

Element	Assignment	Cross section	
DVI	TMDS data 0	26 AWG	TMDS data 1
	TMDS data 1	26 AWG	TMDS data 0
	TMDS data 2	26 AWG	Control wires - DDC clock - DDC data - +5 V - Ground - Hot Plug detect
	TMDS cycle	26 AWG	
USB	XUSB0	26 AWG	
	XUSB1	26 AWG	
Data	SDL	26 AWG	
Control wires	DDC cycle	24 AWG	
	DDC data	24 AWG	
	+5 V	24 AWG	
	Mass	24 AWG	
	Hot Plug detect	24 AWG	

Table 112: Structure - SDL flex cable 5CASDL.0xxx-03

Cable specifications

Warning!

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

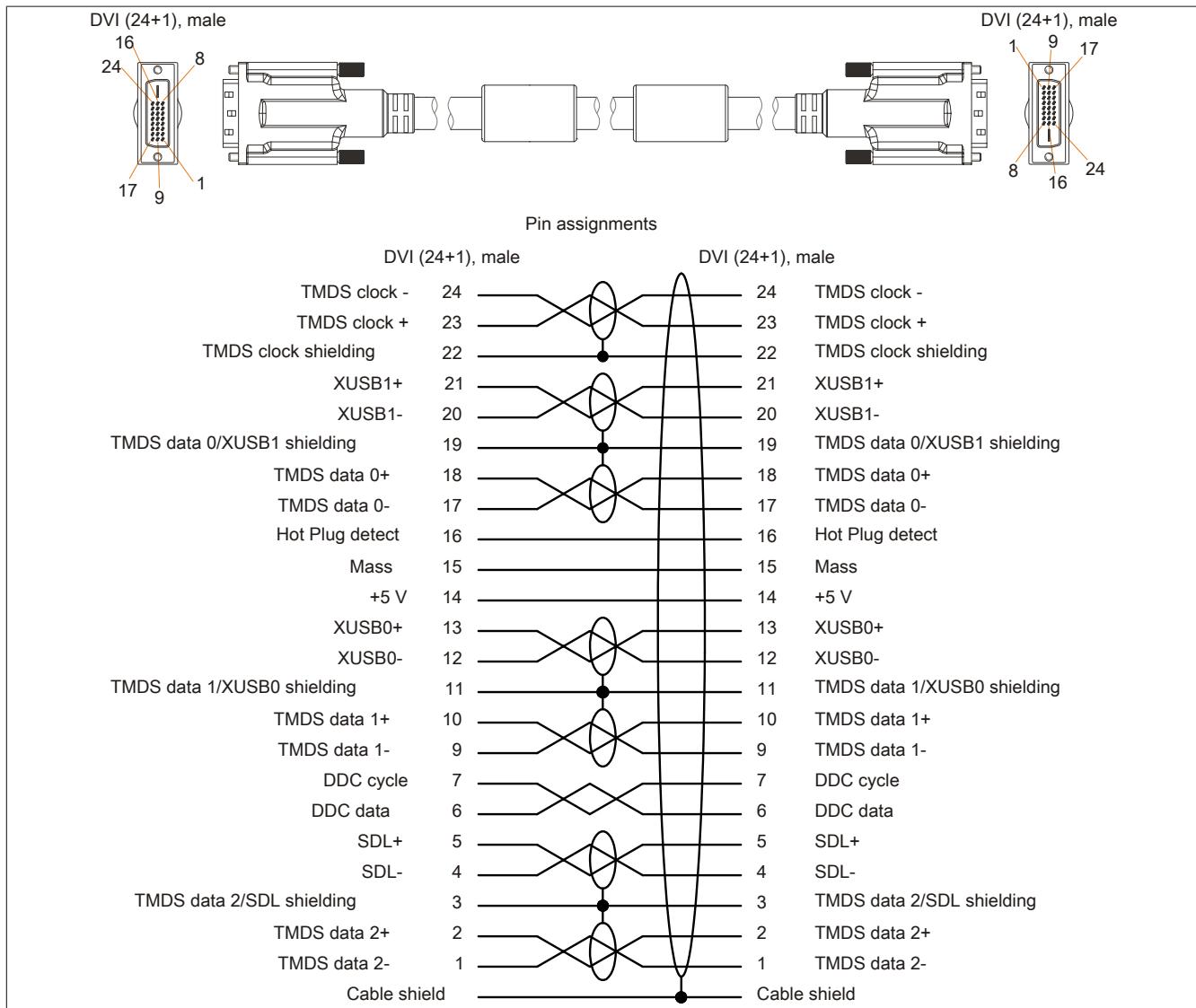


Figure 59: 5CASDL.0xxx-03- Pinout

6.5 SDL flex cables with extender

6.5.1 5CSDL.0xx0-13

General information

The 5CSDL.0xx0-13 SDL flex cables with extender are designed for use in both fixed and flexible installations (e.g. in swing arm systems).

Caution!

Cable can only be plugged in and unplugged when the device is turned off.

Order data

Model number	Short description	Figure
5CSDL.0300-13	SDL flex cable	
5CSDL.0400-13	SDL cable flex with extender, 30 m.	
5CSDL.0430-13	SDL cable flex with extender, 40 m.	

Table 113: 5CSDL.0300-13, 5CSDL.0400-13, 5CSDL.0430-13 - Order data

Technical data

Product ID	5CSDL.0300-13	5CSDL.0400-13	5CSDL.0430-13
General information			
Certification			
CE		Yes	
c-UL-us		Yes	
Cable structure			
Wire cross section		26 AWG (control wires) 26 AWG (DVI, USB, data)	
Features		Free of halogen and silicon	
Shield		Individual cable pairs and entire cable	
Cable shielding		Aluminum foil clad + tinned copper mesh	
Outer sheathing			
Material		Special TMPU - semi gloss	
Color		Black	
Labeling		(B&R) SDL cable (UL) AWM 20236 80°C 30V E63216	
Connector			
Type		2x DVI-D (24+1), male	
Connection cycles		Min. 200	
Contacts		Gold plated	
Mechanical protection		Metal cover with crimped stress relief	
Electrical characteristics			
Operating voltage		≤30 V	
Test voltage			
Wire/wire		1 kV	
Wire/shield		0.5 kV	
Wave impedance		100 ±10 Ω	
Conductor resistance			
AWG 24		≤95 Ω/km	
AWG 26		≤145 Ω/km	
Insulation resistance		> 200 MΩ/km	
Operating conditions			
Approbation		UL AWM 20236 80°C 30V	
Flame resistant		In accordance with UL758 (cable vertical flame test)	
Oil and hydrolysis resistance		According to VDE 0282-10	
Environmental conditions			
Temperature			
Storage		-20 to 60°C	
Moving		-5 to 60°C	
Fixed installation		-20 to 60°C	
Mechanical characteristics			
Dimensions			
Length	30 m ± 280 mm	40 m ± 380 mm	43 m ± 410 mm
Diameter		Max. 12 mm	
Extender box			
Width		35 mm	
Length		125 mm	

Table 114: 5CSDL.0300-13, 5CSDL.0400-13, 5CSDL.0430-13 - Technical data

Product ID	5CASDL.0300-13	5CASDL.0400-13	5CASDL.0430-13
Height		18.5 mm	
Flex radius			
Fixed installation		$\geq 6x$ cable diameter (from plug - ferrite magnet)	
flexible installation		$\geq 10x$ cable diameter (from ferrite magnet - ferrite magnet) $\geq 15x$ cable diameter (from ferrite magnet - ferrite magnet)	
Flexibility		Flexible; valid for ferrite magnet - ferrite magnet (tested 300,000 cycles with 15x cable diameter, 4800 cycles / hour)	
Drag chain data			
Flex cycles		300.000	
Speed		4800 cycles / hour	
Flex radius		180 mm; 15x cable diameter	
Hub		460 mm	
Weight	Approx. 5430 g	Approx. 7200 g	Approx. 7790 g
Tension			
In operation		≤ 50 N	
During installation		≤ 400 N	

Table 114: 5CASDL.0300-13, 5CASDL.0400-13, 5CASDL.0430-13 - Technical data

Flex radius specification

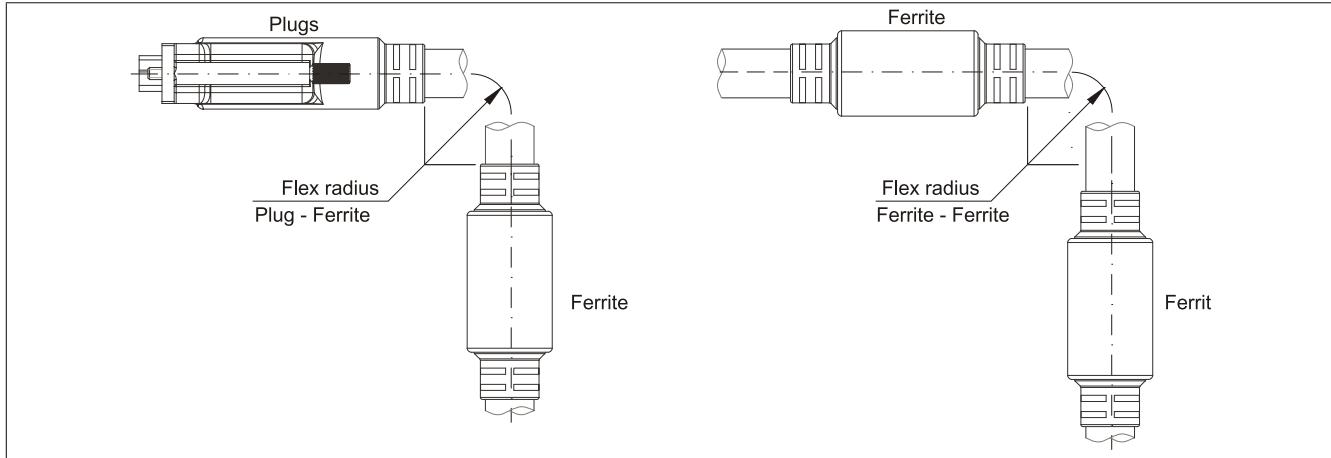


Figure 60: Flex radius specification

Dimensions

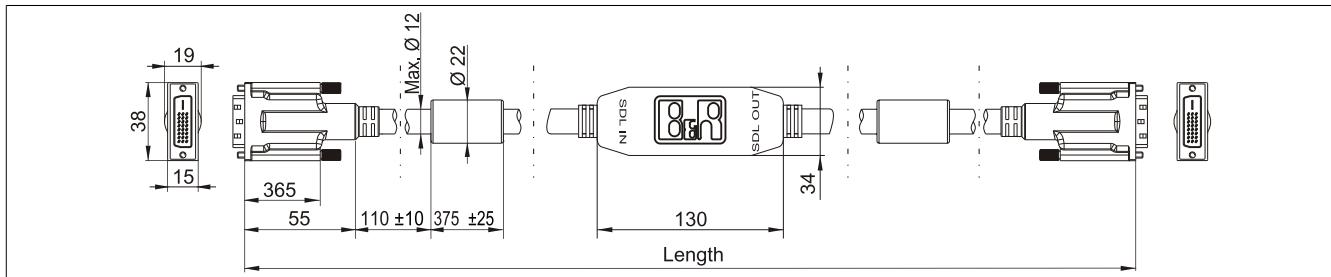


Figure 61: 5CASDL.0xx0-13- Dimensions

Cable specifications**Warning!**

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

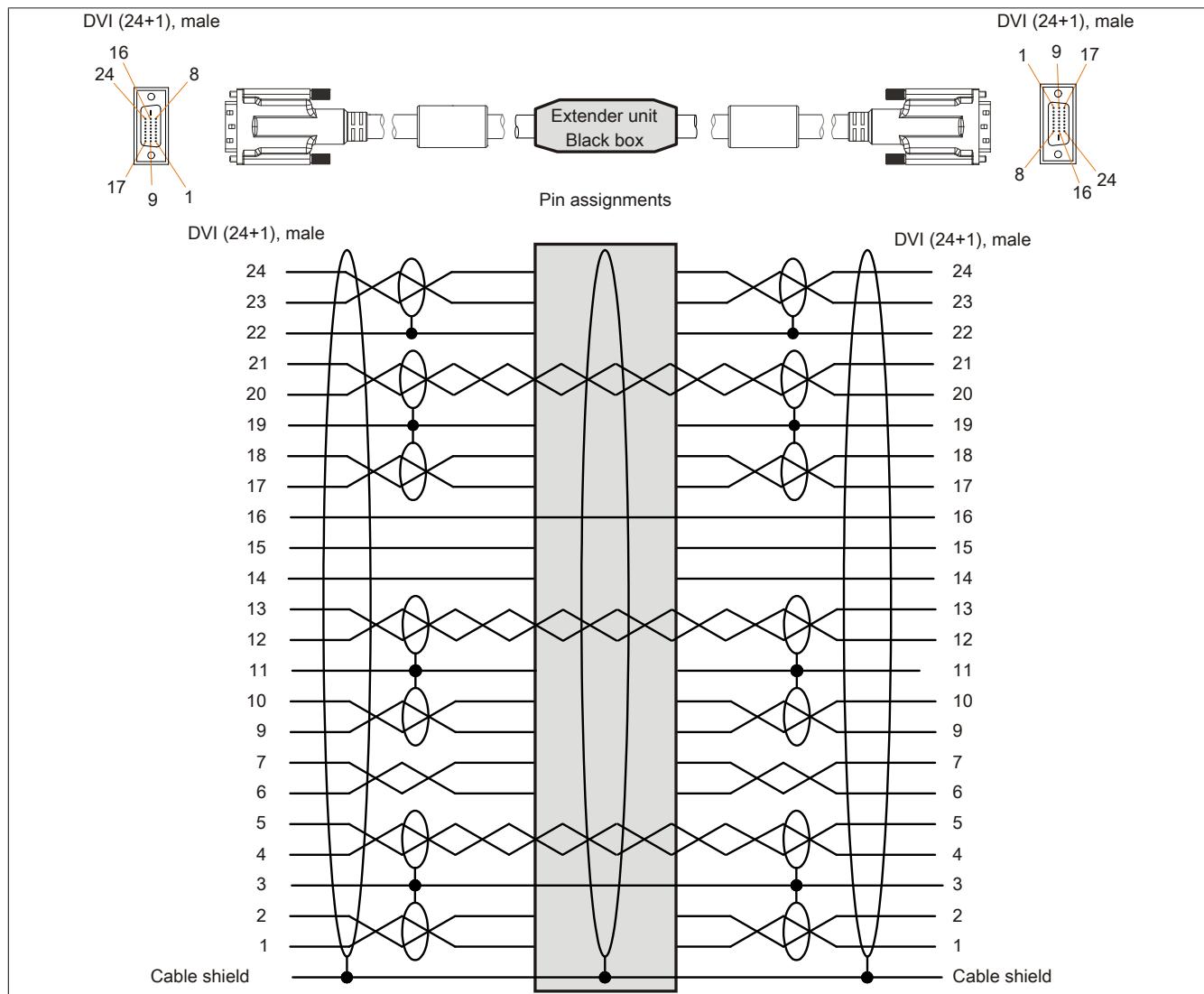


Figure 62: 5CASDL.0xx0-13 - Pinout

Cable connection

SDL flex cables with extenders must be connected between the B&R industrial PC and Automation Panel 900 display unit in the correct direction. The signal direction is indicated on the extender unit for this purpose.

- Connect the end labeled "SDL IN" with the video output of the APC910 (monitor/panel output) or Panel OUT of an AP900 AP Link card.
- The "SDL OUT" end should be connected to the display unit (e.g. Automation Panel 900) via the Automation Panel Link insert card (Panel IN).

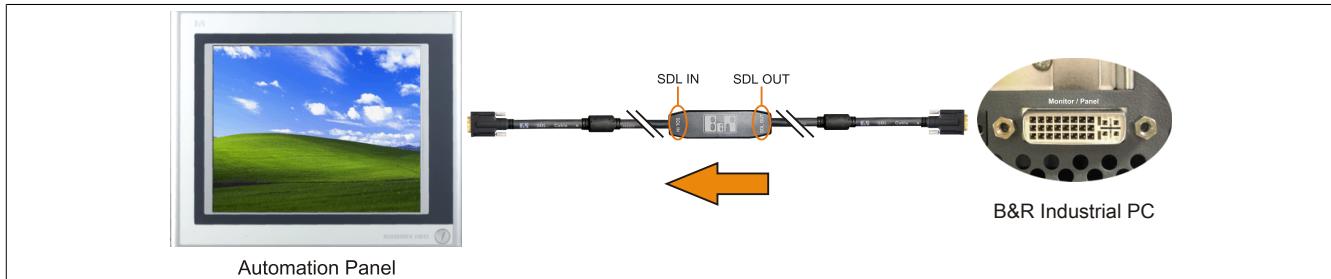


Figure 63: Example of the signal direction for the SDL flex cable with extender



Figure 64: Example of signal direction display - SDL flex cable with extender

6.6 USB cables

6.6.1 5CAUSB.00xx-00

General information

USB cables are designed to achieve USB 2.0 transfer speeds.

Order data

Model number	Short description	Figure
	USB cable	
5CAUSB.0018-00	USB 2.0 connecting cable type A - type B, 1.8 m.	
5CAUSB.0050-00	USB 2.0 connecting cable type A - type B, 5 m.	

Table 115: 5CAUSB.0018-00, 5CAUSB.0050-00 - Order data

Technical data

Product ID	5CAUSB.0018-00	5CAUSB.0050-00
General information		
Certification		
CE	Yes	
c-UL-us	Yes	
Cable structure		
Wire cross section	AWG 24, 28	
Shield	Entire cable	
Outer sheathing		
Color	Beige	
Connector		
Type	USB type A male and USB type B male	
Mechanical characteristics		
Dimensions		
Length	1.8 m ±30 mm	5 m ± 50 mm
Diameter	Max. 5 mm	
Flex radius	Min. 100 mm	

Table 116: 5CAUSB.0018-00, 5CAUSB.0050-00 - Technical data

Cable specifications

Warning!

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

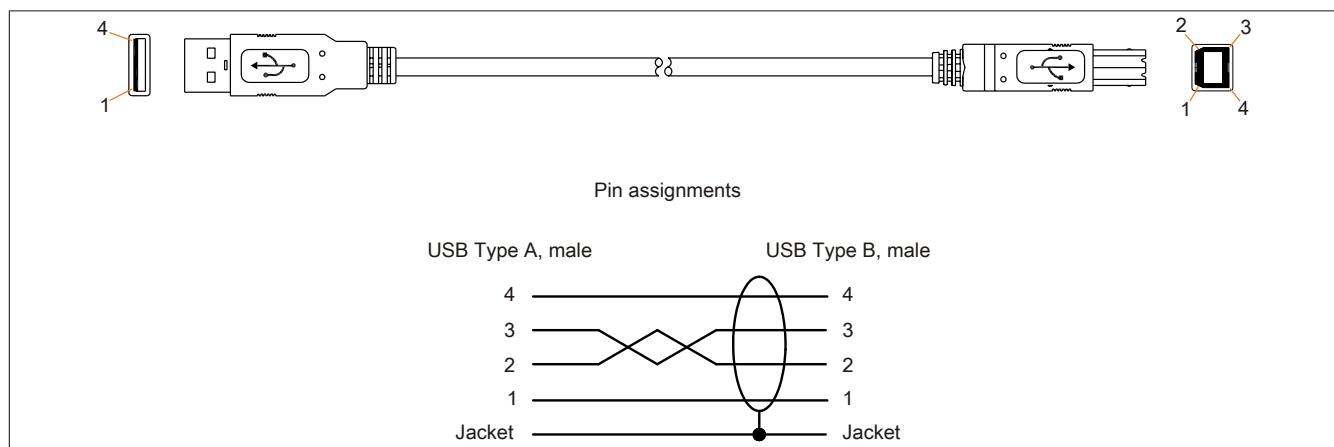


Figure 65: 5CAUSB.00xx-00 - USB cable pinout

6.7 RS232 cables

6.7.1 9A0014.xx

General information

The RS232 cables are used as extension cables between two RS232 interfaces.

Order data

Model number	Short description	Figure
	RS232 cable	
9A0014.02	RS232 extension cable for remote operating of a display unit with touch screen, 1.8 m.	
9A0014.05	RS232 extension cable for remote operating of a display unit with touch screen, 5 m.	
9A0014.10	RS232 extension cable for remote operating of a display unit with touch screen, 10 m.	

Table 117: 9A0014.02, 9A0014.05, 9A0014.10 - Order data

Technical data

Product ID	9A0014.02	9A0014.05	9A0014.10
General information			
Certification CE		Yes	
Cable structure			
Wire cross section	AWG 26		
Shield	Entire cable		
Outer sheathing Color	Beige		
Connector			
Type	9-pin DSUB socket, male / female		
Mechanical characteristics			
Dimensions Length Diameter	1.8 m ±50 mm	5 m ± 80 mm Max. 5 mm	10 m ±100 mm
Flex radius		Min. 70 mm	

Table 118: 9A0014.02, 9A0014.05, 9A0014.10 - Technical data

Cable specifications**Warning!**

If you want to build a suitable cable yourself, it should be wired according to these specifications.

If a self-built cable is used, B&R cannot guarantee that it will function properly. B&R guarantees the performance of all cables that they provide.

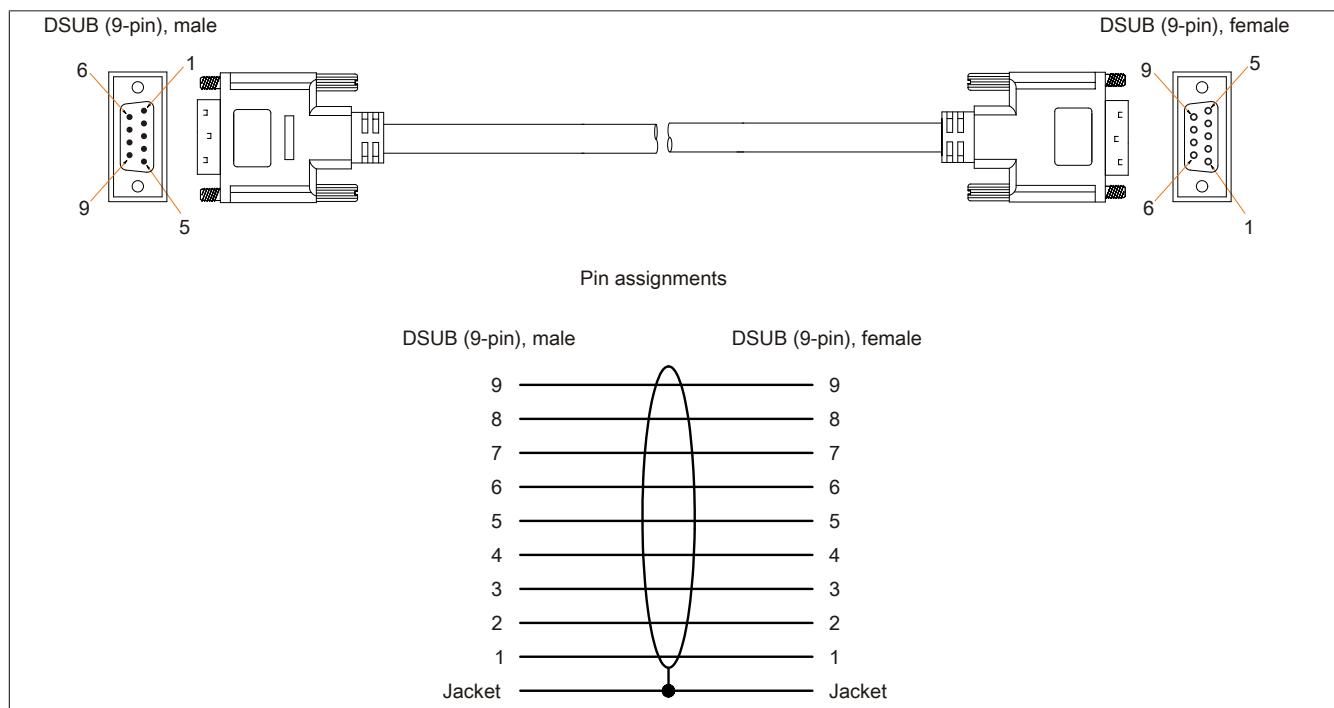


Figure 66: 9A0014.xx - RS232 cable pinout

Chapter 6 • Maintenance / Service

The following chapter describes service/maintenance work that can be carried out by a trained, qualified user.

1 Replacing a CFast card

Caution!

Turn off the power before replacing the CFast card!

The CFast card can be exchanged quickly and easily by pressing the ejector (see image) with a pointed object such as a pen.

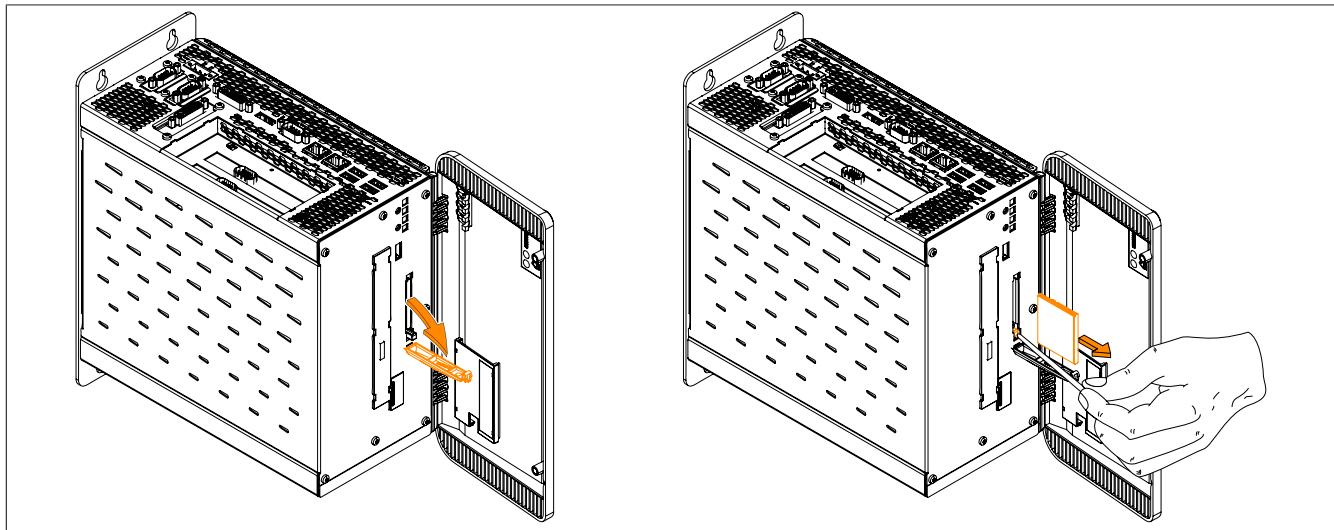


Figure 67: Replacing a CFast card

2 Installation - Interface option

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open the front cover. The torx screws (T10) behind the cover that are marked in the image must be removed. The number of torx screws can vary depending on the system unit.

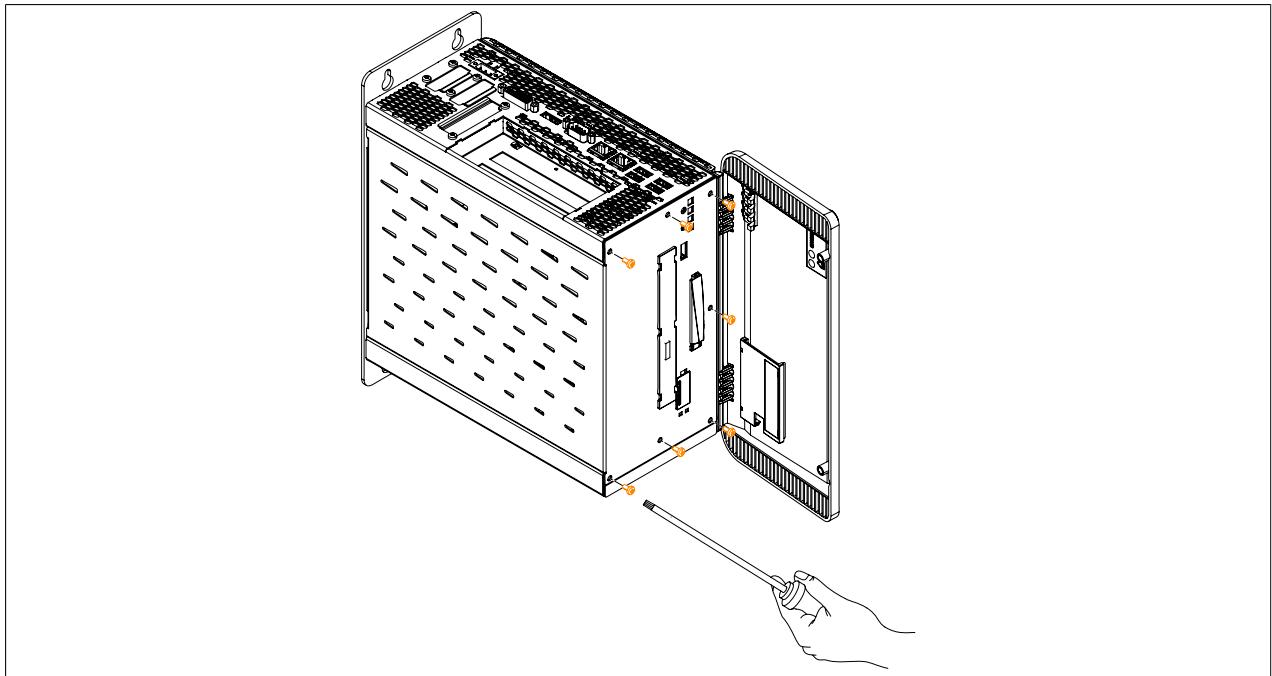


Figure 68: Removing the combi-torx screws for the side cover

4. After the screws have been removed, the side cover can be removed by sliding it toward the front and to the side.

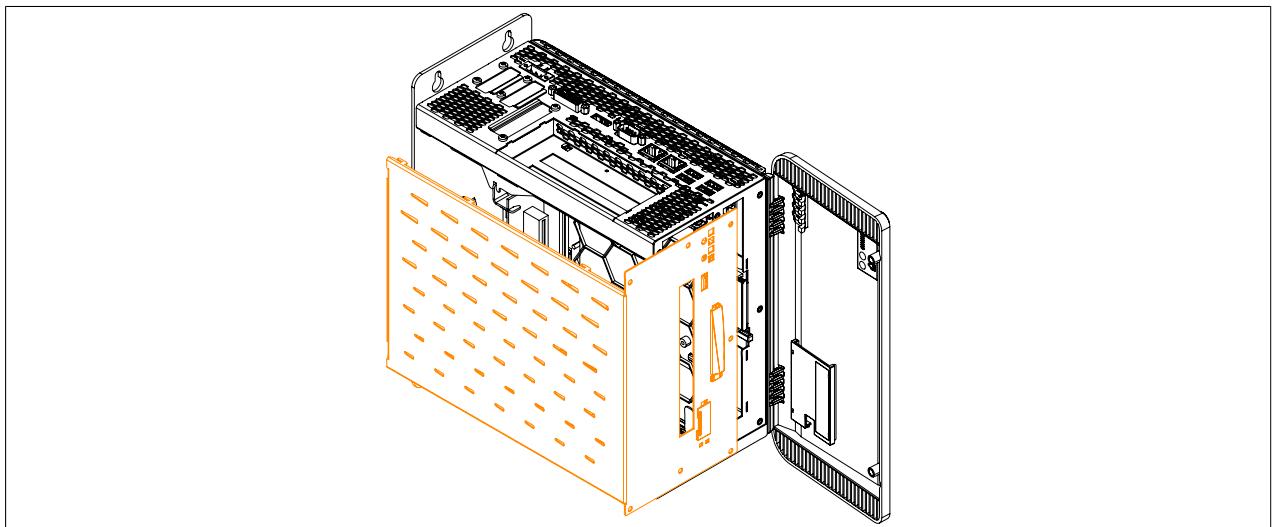


Figure 69: Removing the side cover

5. Remove the marked torx screws (T10) and slot cover.

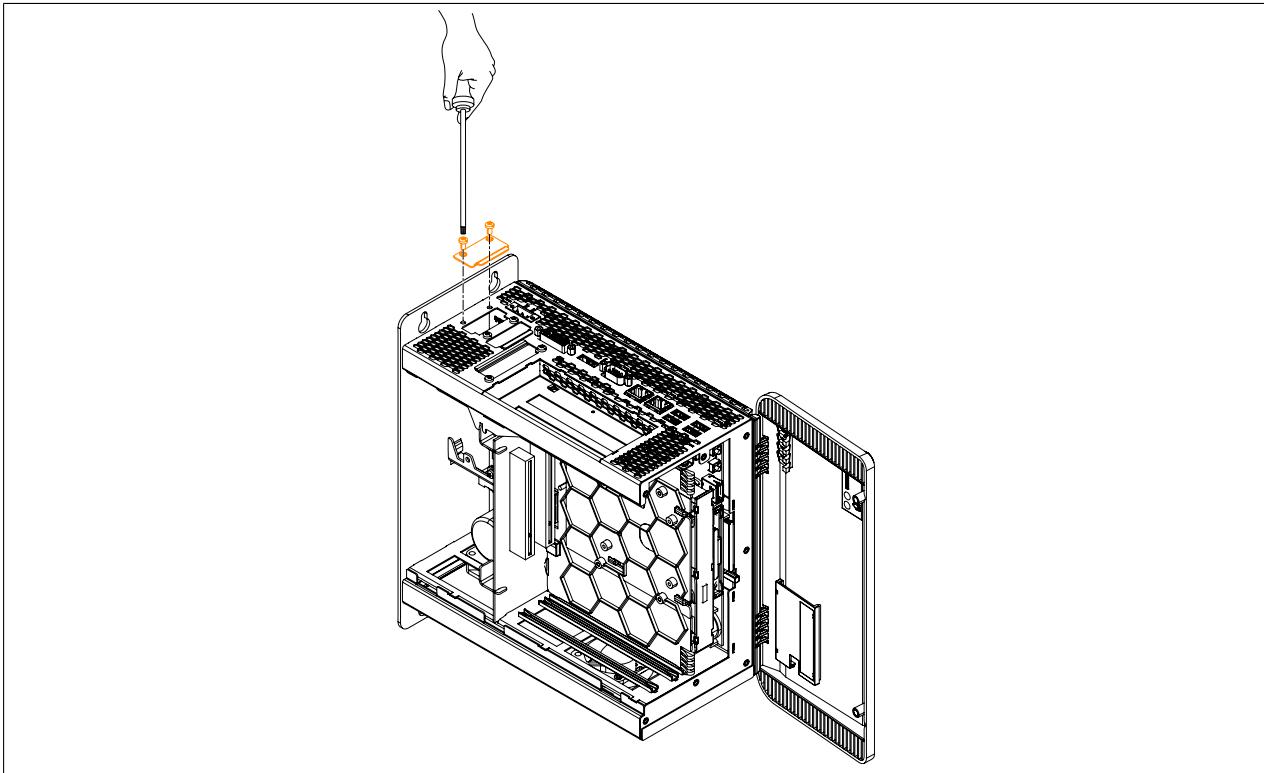


Figure 70: Removing the combi-torx screws and slot cover

6. Place interface option into slot. Please note that not every interface option can be plugged into interface slot 1 and 2. For more information about this, see the section "IF option 1 slot" on page 40 and "IF option 2 slot" on page 40.

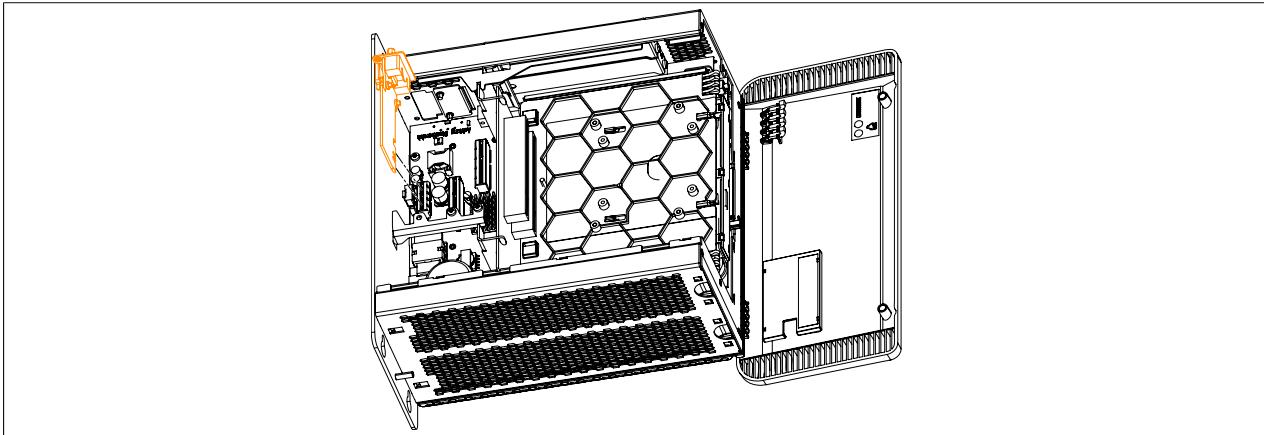


Figure 71: Installing the interface option

7. Secure the interface option to the B&R Industrial PC using torx screws (T10).

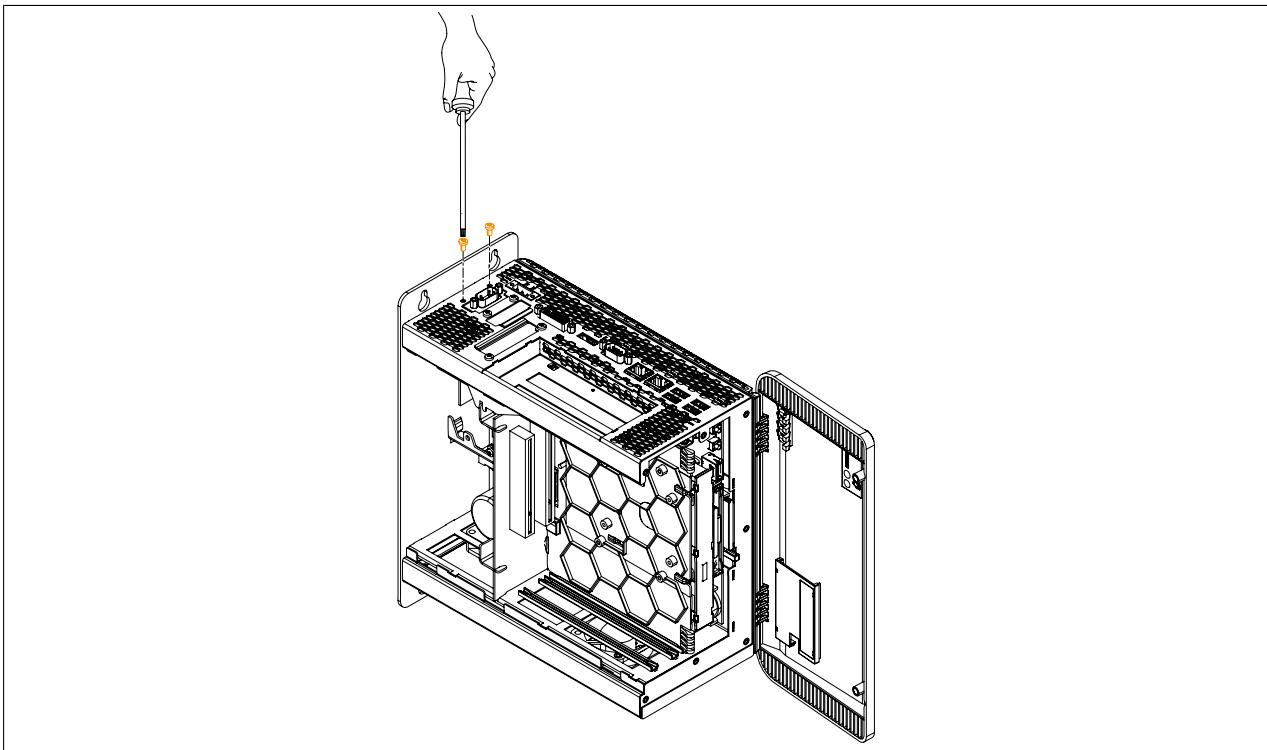


Figure 72: Securing the interface option

8. Attach side cover.

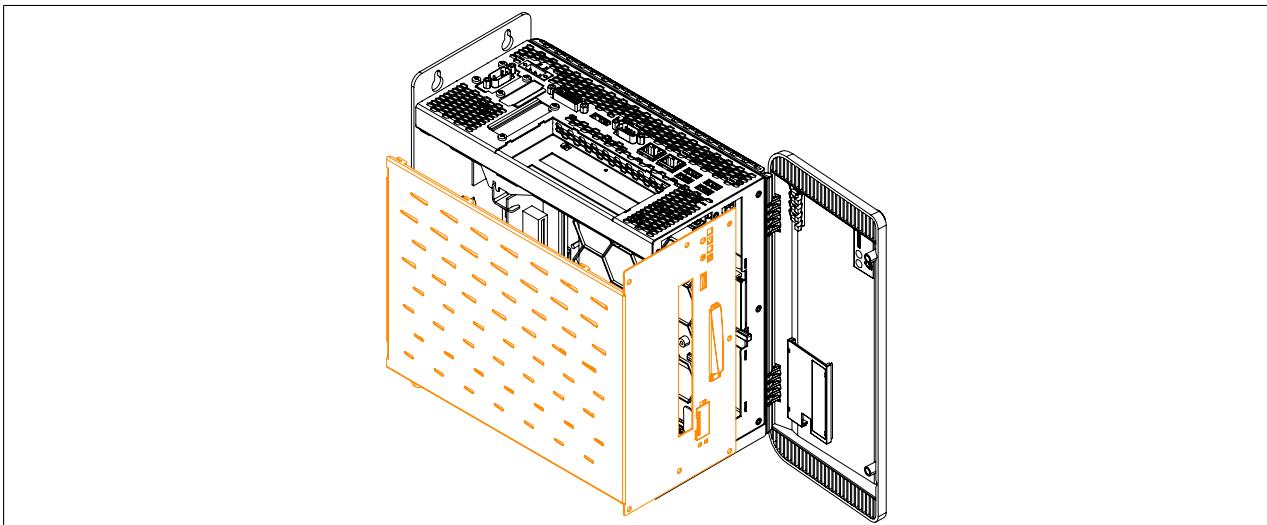


Figure 73: Attaching the side cover

9. Secure the side cover to the B&R Industrial PC using the same torx screws (T10) from before.

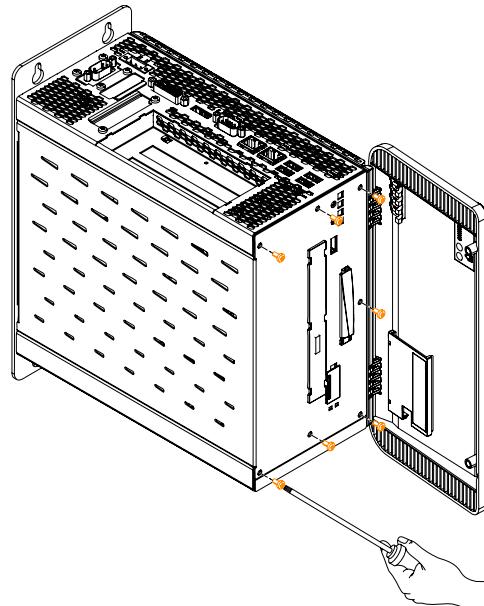


Figure 74: Securing the side cover

3 Installation - Monitor / panel option

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open the front cover. The torx screws (T10) behind the cover that are marked in the image must be removed. The number of torx screws can vary depending on the system unit.

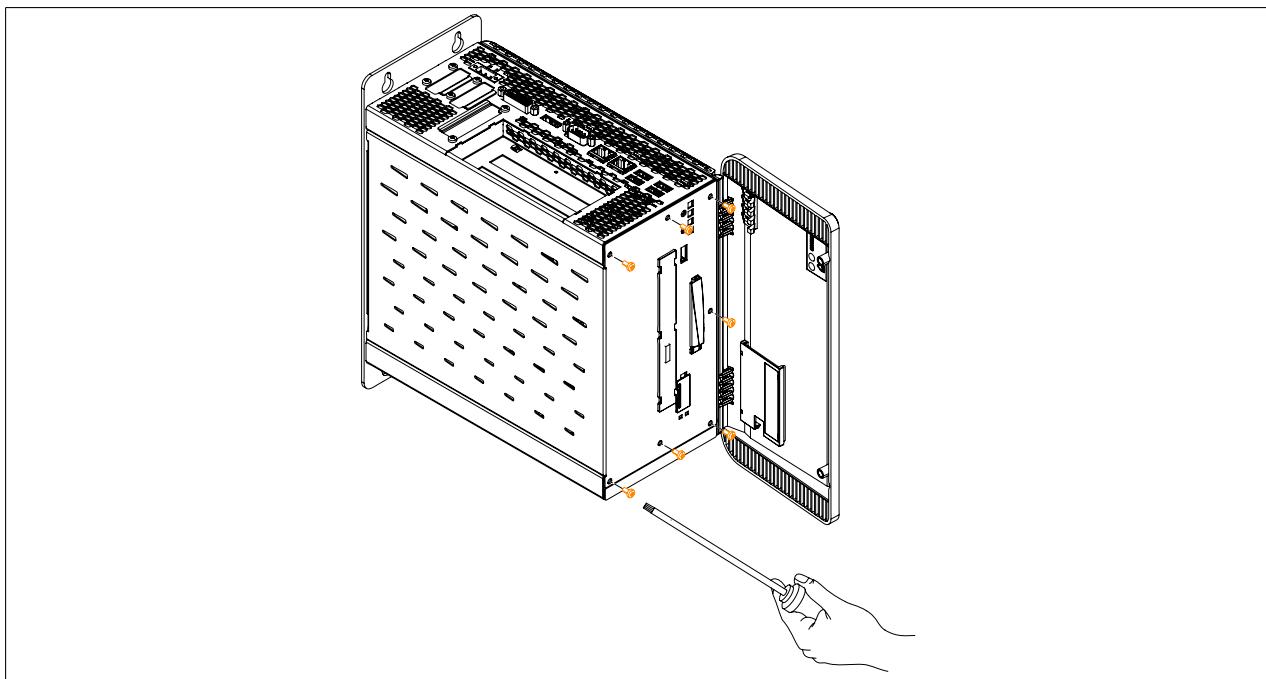


Figure 75: Removing the combi-torx screws for the side cover

4. After the screws have been removed, the side cover can be removed by sliding it toward the front and to the side.

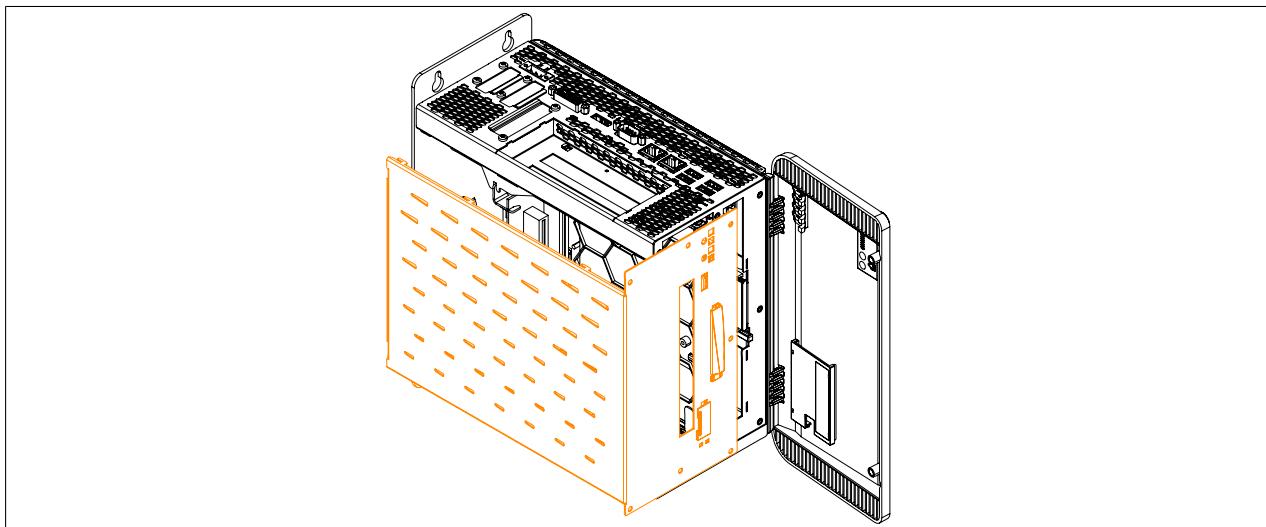


Figure 76: Removing the side cover

5. Remove the marked torx screws (T10) and slot cover.

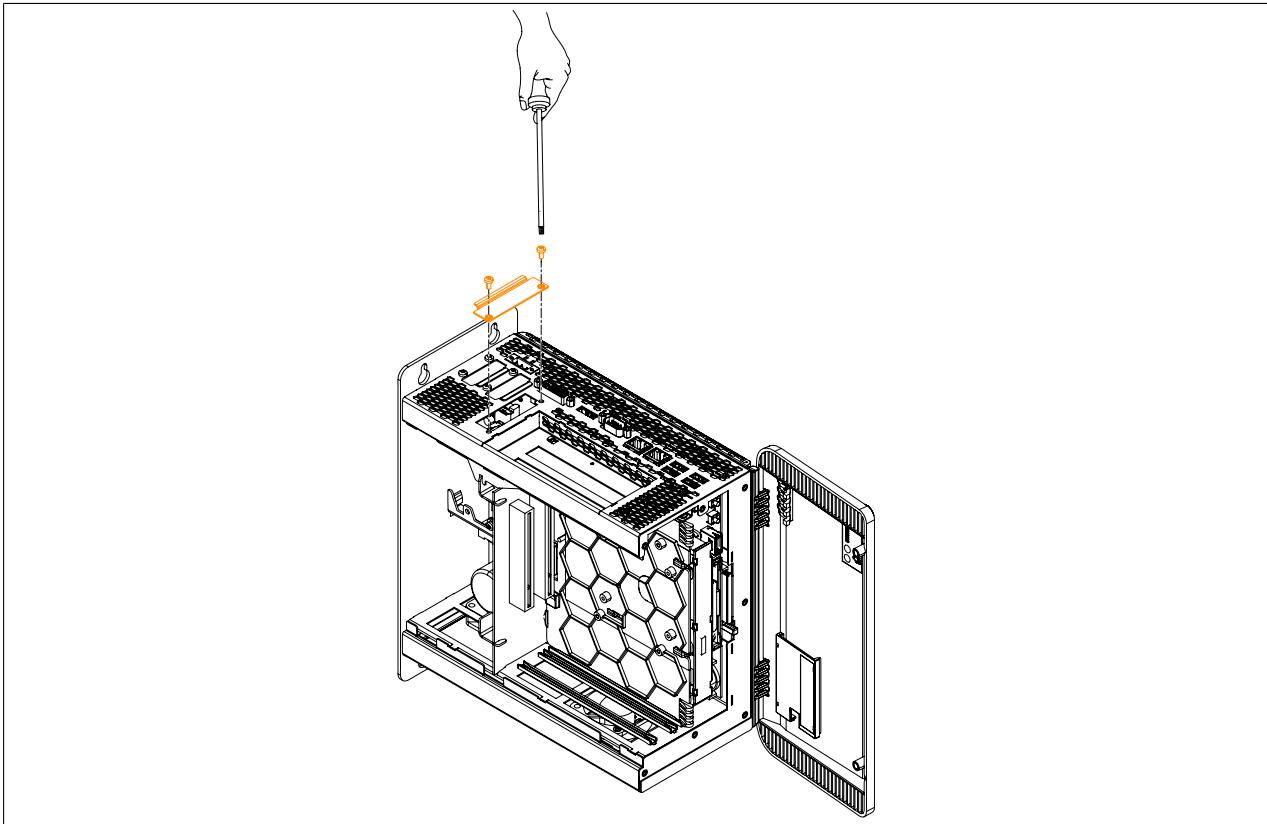


Figure 77: Removing the combi-torx screws and slot cover

6. Place monitor / panel option into slot.

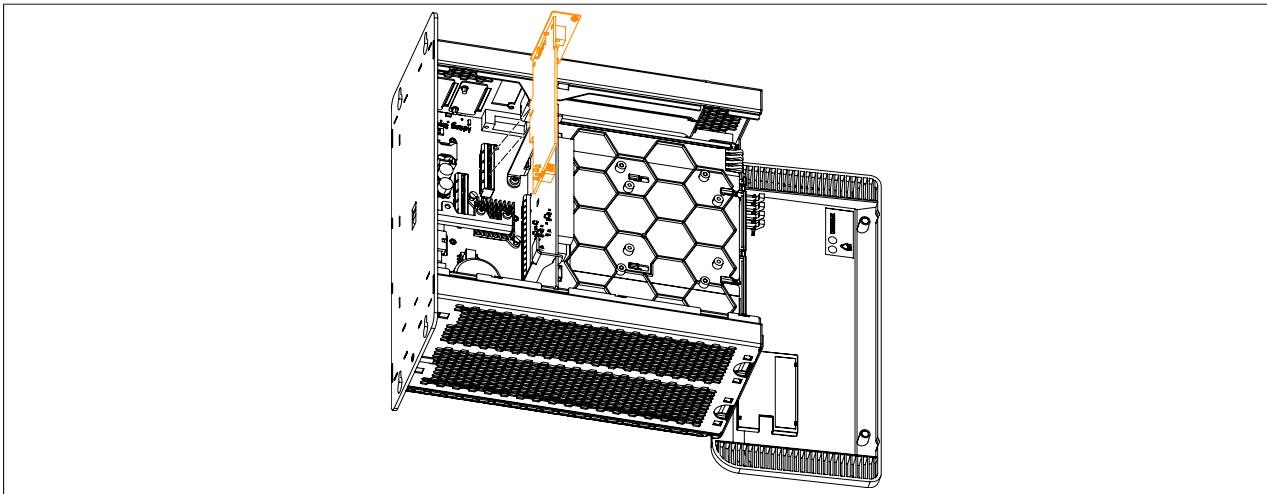


Figure 78: Placing the monitor / panel option into the APC910

7. Secure the monitor / panel option to the B&R Industrial PC using torx screws (T10).

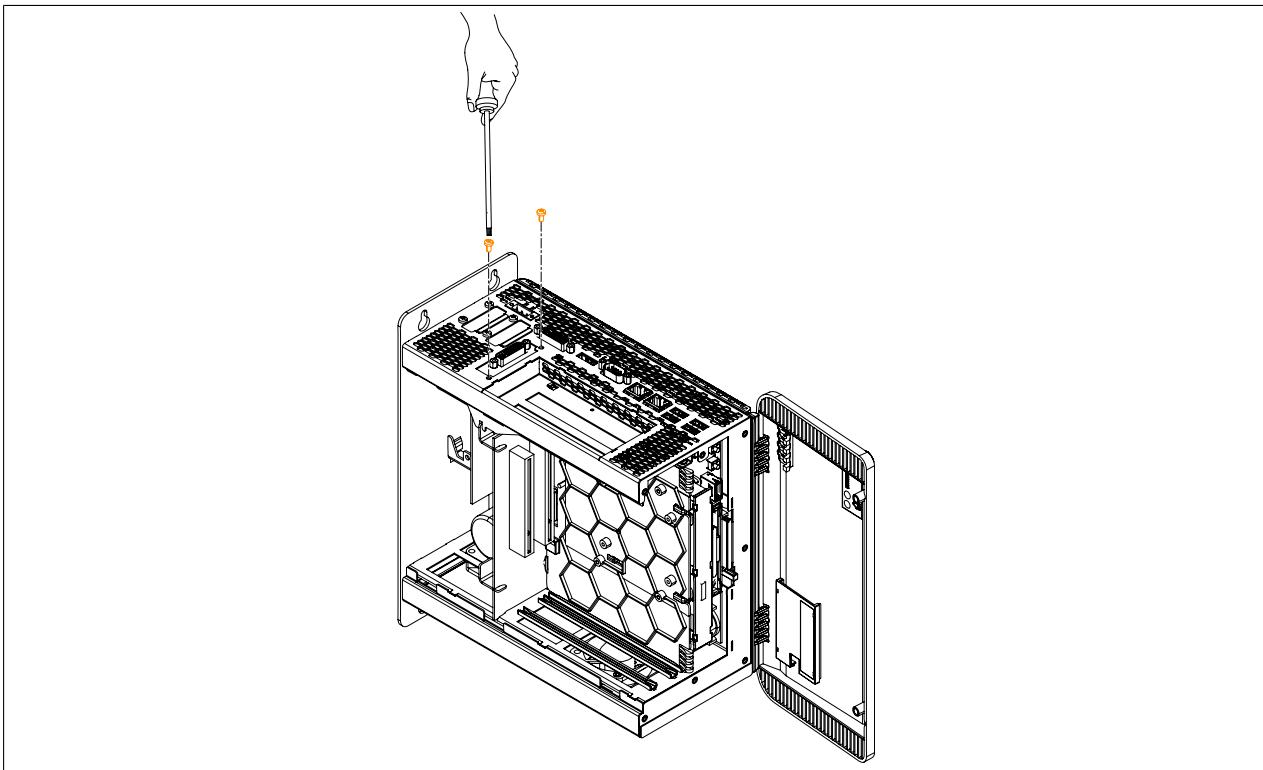


Figure 79: Securing the monitor / panel option using combi-torx screws

8. Attach side cover.

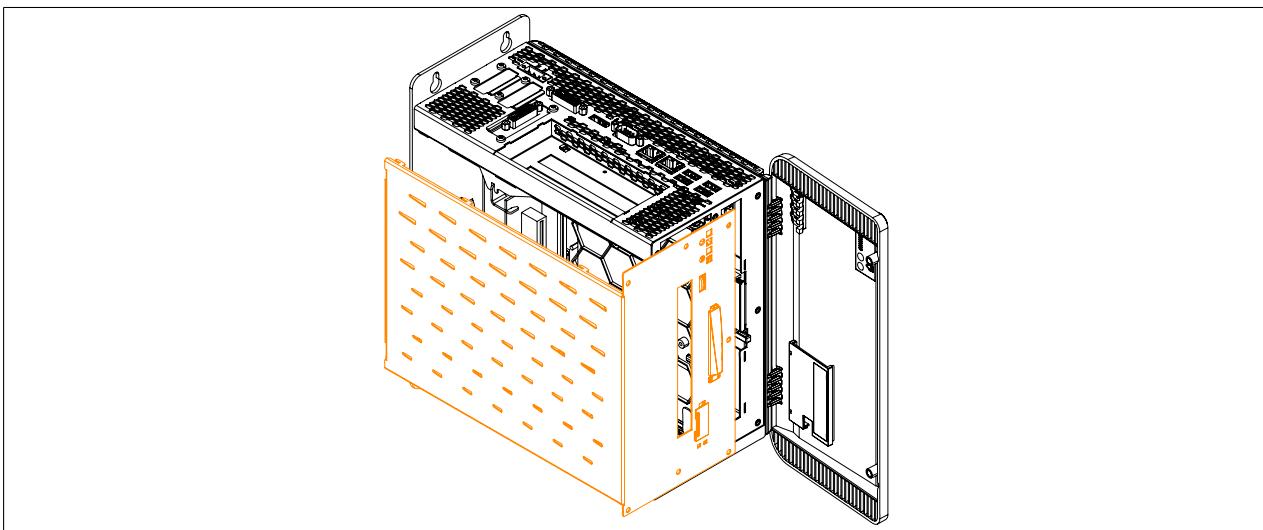


Figure 80: Attaching the side cover

9. Secure the side cover to the B&R Industrial PC using the same torx screws (T10) from before.

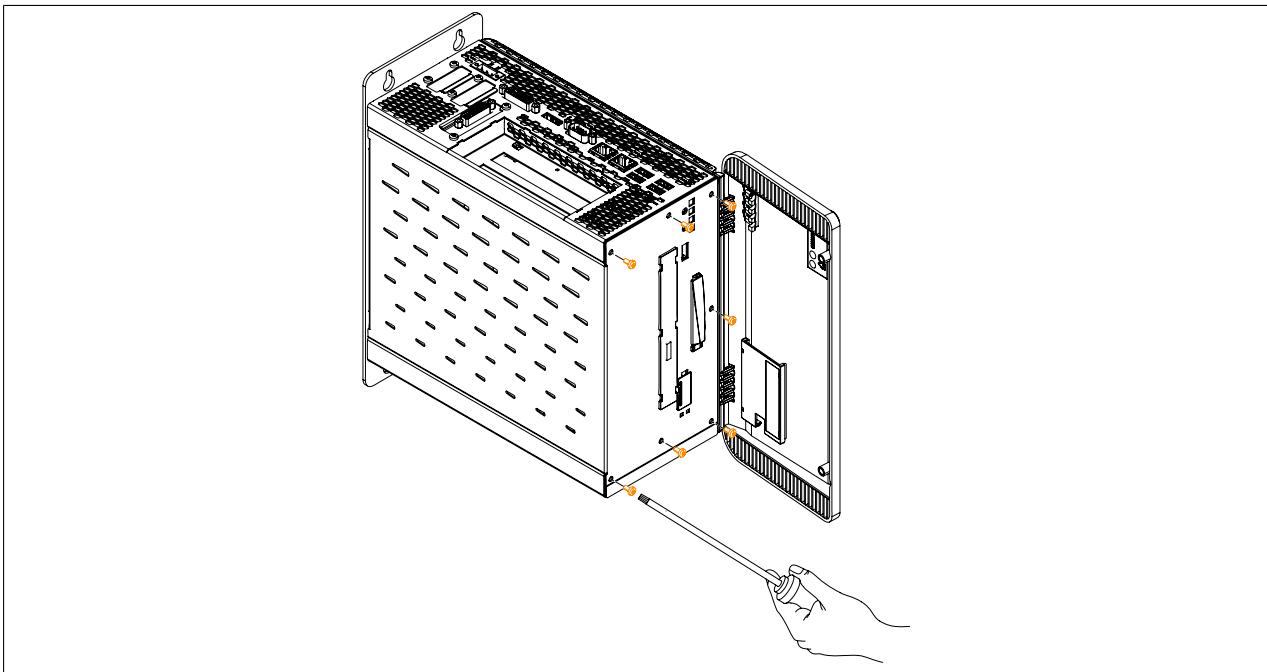


Figure 81: Securing the side cover

4 Slide-in compact drive installation / replacement

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open the front cover. The torx screws (T10) behind the cover that are marked in the image must be removed. The number of torx screws can vary depending on the system unit.

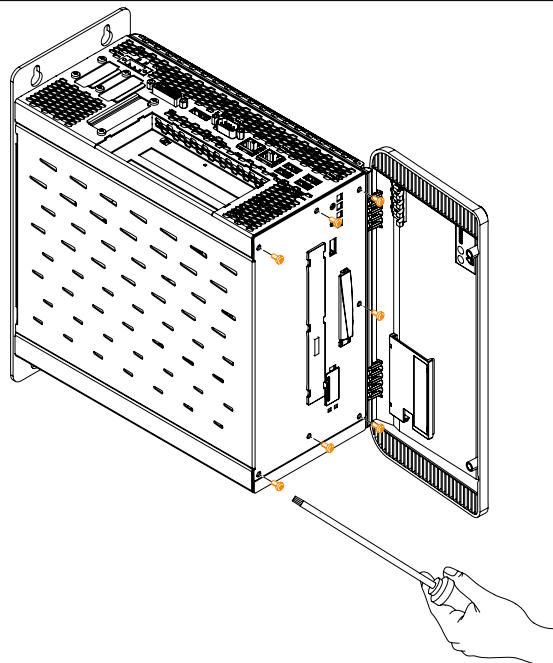


Figure 82: Removing the combi-torx screws for the side cover

4. After the screws have been removed, the side cover can be removed by sliding it toward the front and to the side.

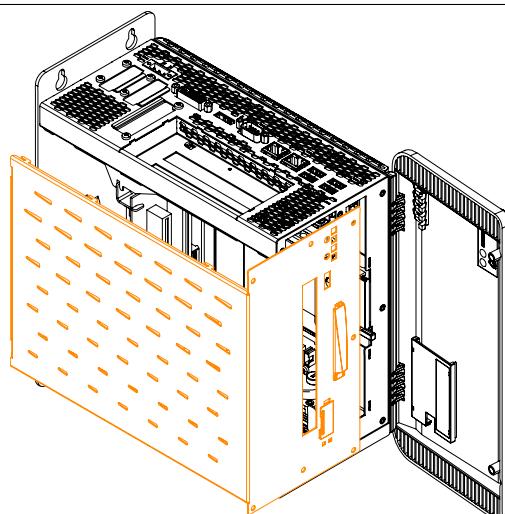


Figure 83: Removing the side cover

5. Remove / replace the slide-in compact drive from the Automation PC 910. The slide-in compact drive must glide into the guide rails and snap into the connector.

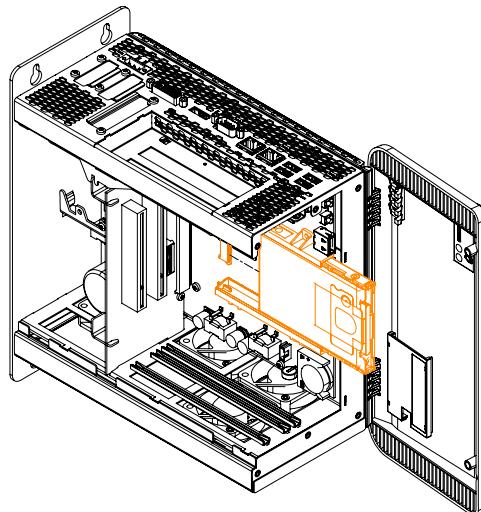


Figure 84: Removing / replacing the slide-in compact drive

6. Attach side cover.

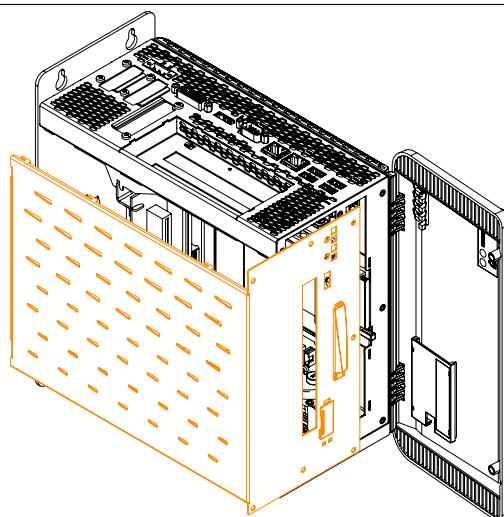


Figure 85: Attaching the side cover

7. Secure the side cover to the B&R Industrial PC using the same torx screws (T10) from before.

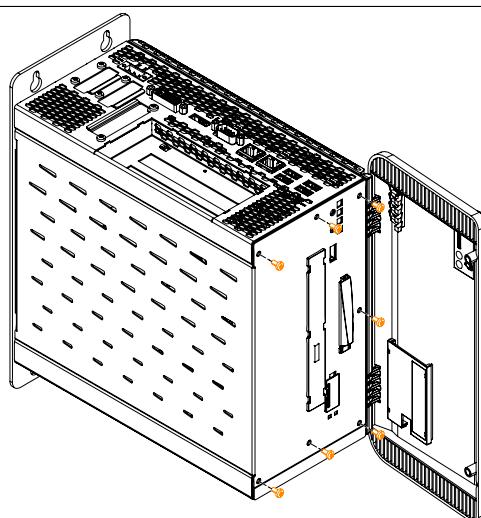


Figure 86: Securing the side cover

5 Slide-in drive installation / replacement

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open the front cover. The torx screws (T10) behind the cover that are marked in the image must be removed. The number of torx screws can vary depending on the system unit.

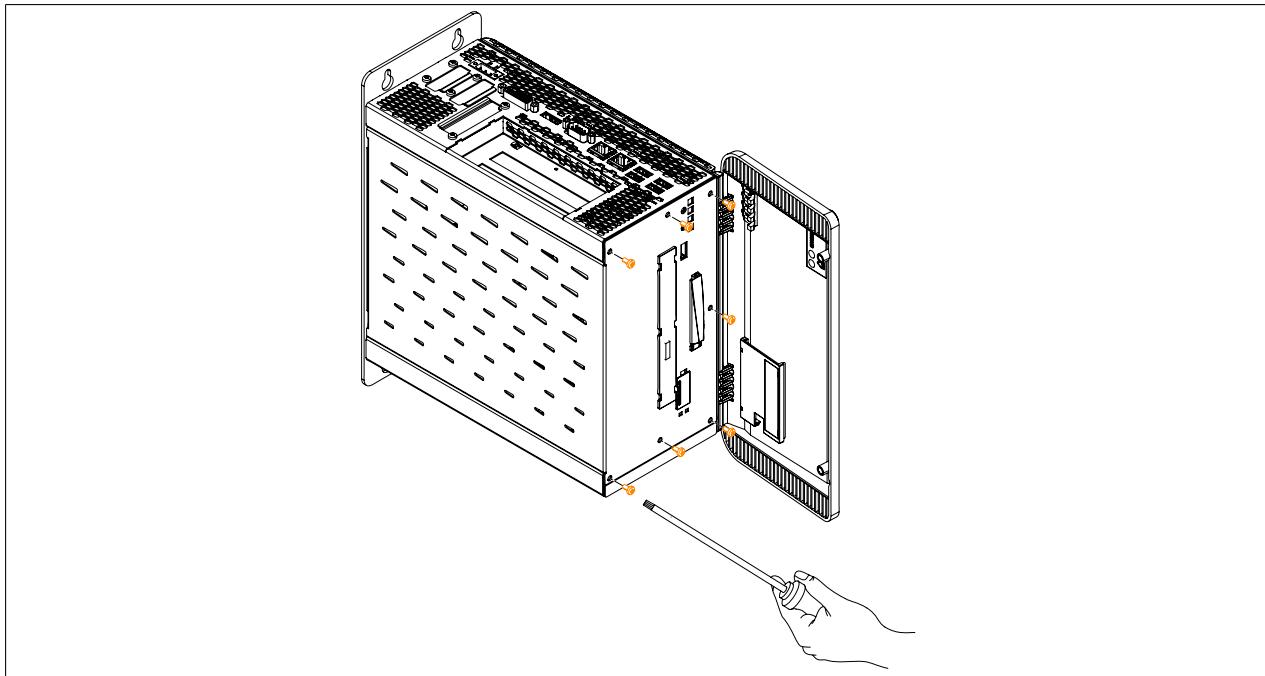


Figure 87: Removing the combi-torx screws for the side cover

4. After the screws have been removed, the side cover can be removed by sliding it toward the front and to the side.

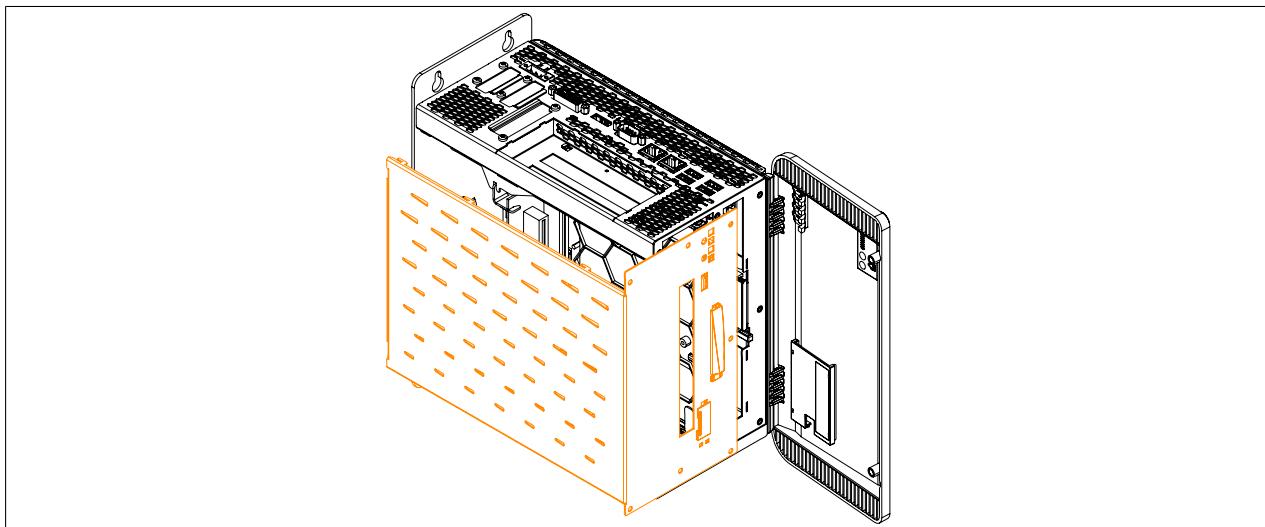


Figure 88: Removing the side cover

5. Remove / replace the slide-in drive from the Automation PC 910. The slide-in drive must glide into the guide rails and snap into the connector.

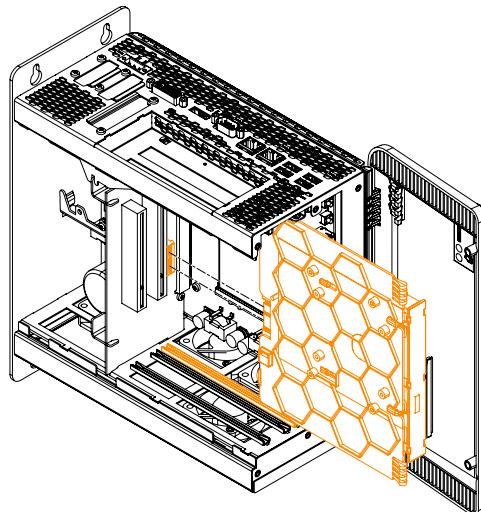


Figure 89: Removing / replacing the slide-in drive

6. Attach side cover.

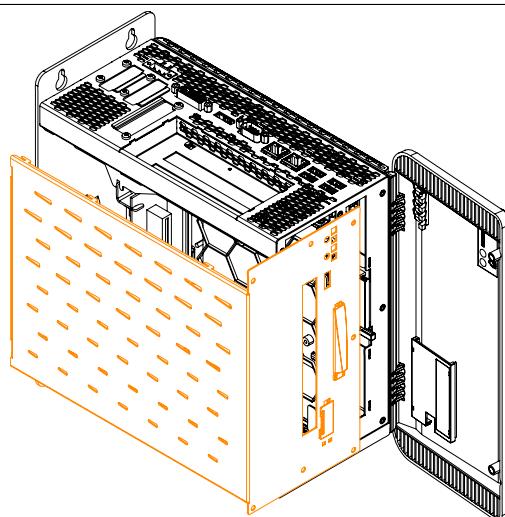


Figure 90: Attaching the side cover

7. Secure the side cover to the B&R Industrial PC using the same torx screws (T10) from before.

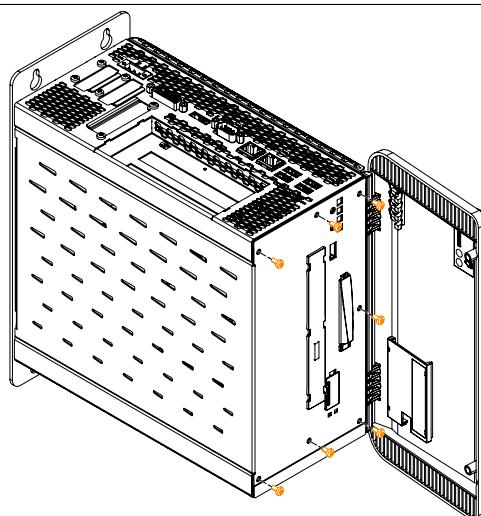


Figure 91: Securing the side cover

6 Fan filter replacement

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open the front cover.
4. To remove the fan filter from the B&R Industrial PC, push up on the locking mechanism while pulling the fan filter outward. The number of locking mechanisms can vary depending on the system unit.

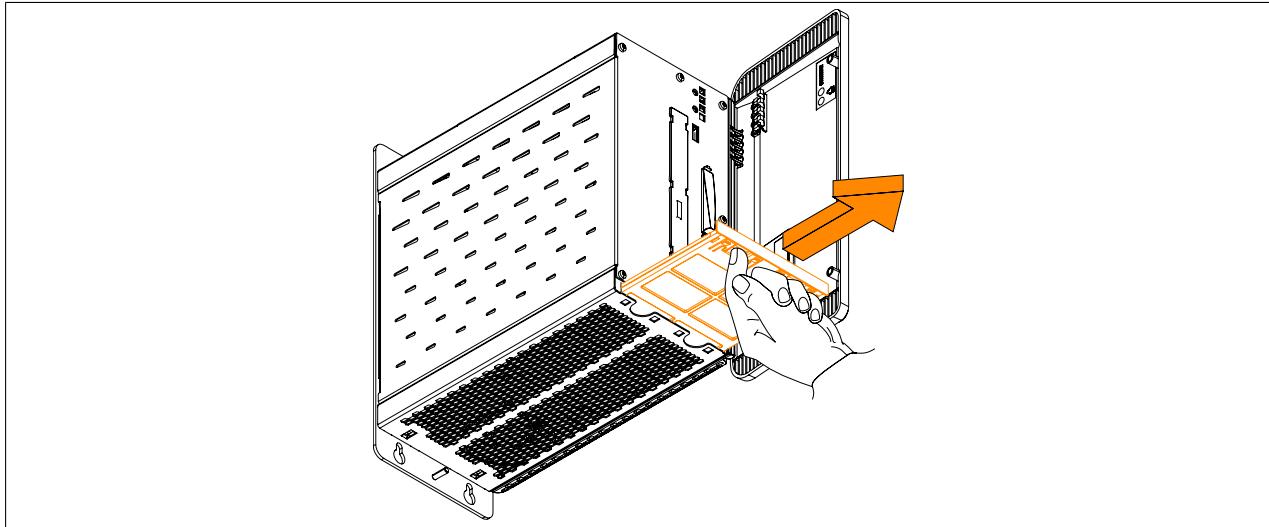


Figure 92: Removing the fan filter from the APC910

Information:

The dust filter must be inspected regularly depending on the amount of dust in the operating environment.

7 Fan kit replacement

1. Disconnect the power supply to the B&R Industrial PC.
2. Touch the housing or ground connection in order to discharge any electrostatic charge from your body.
3. Open and remove the front cover.

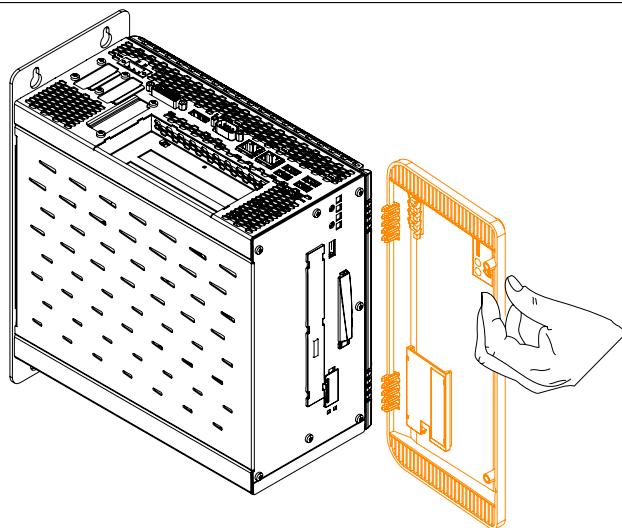


Figure 93: Removing the front cover

4. Remove heat sink cover. The torx screws (T10) that are marked in the image must be removed.

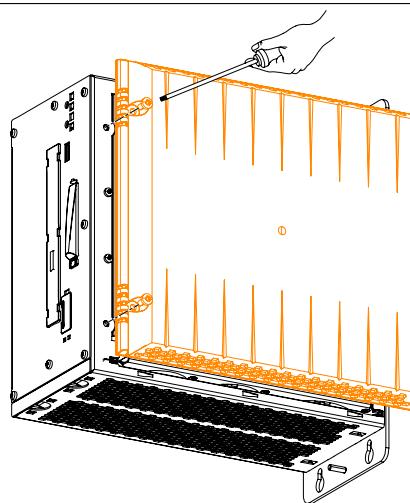


Figure 94: Removing the heat sink cover

5. Remove the torx screws (T10) from the fan kit that are marked in the following image and unplug the fan kit cable from the baseboard.

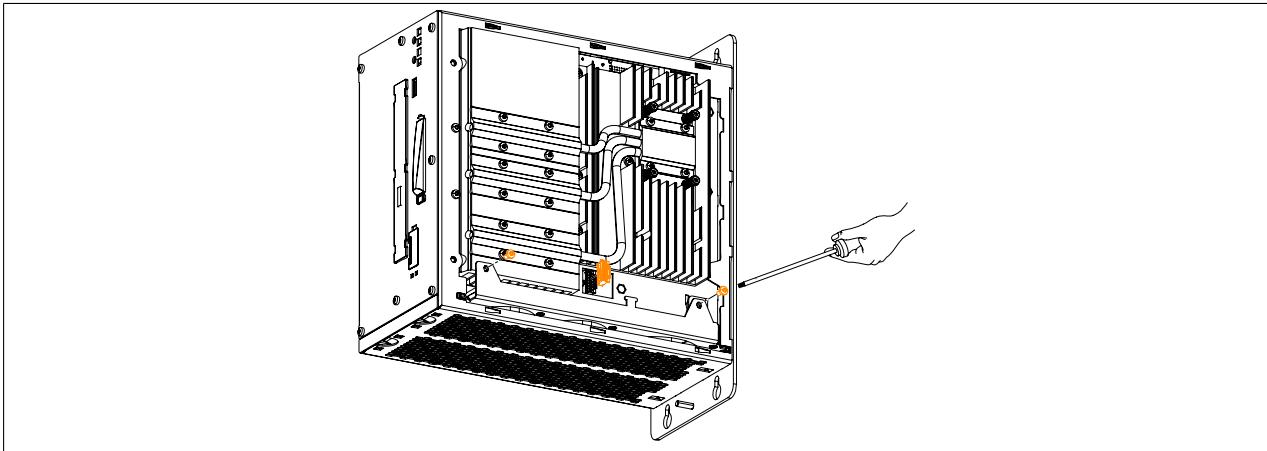


Figure 95: Removing the combi-torx screws and fan cable

6. The fan kit can now be removed from the Automation PC 910.

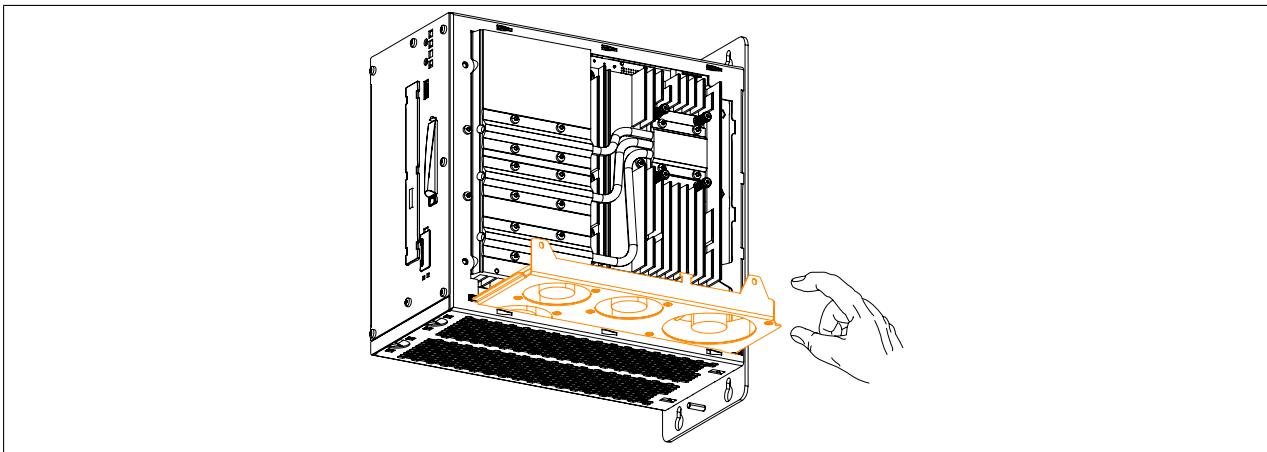


Figure 96: Removing the fan kit from the APC910

7. The Automation PC 910 can now be re-assembled in reverse order of these instructions.

Appendix A

1 Abbreviations

Abbreviation	Stands for	Description
NC	Normally closed	A normally closed (N.C.) relay contact.
	Not connected	Used in the description of pinout if a terminal or pin is not connected to a module.
ND	Not defined	In data tables, this stands for a value that has not been defined. Because a cable manufacturer does not provide certain technical data, for example.
NO	Normally open	A normally open (N.O.) relay contact.
TBD	To be defined	Used in technical data tables when certain information is not yet available. The value will be provided later.

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